# S29NS-P MirrorBit<sup>™</sup> Flash Family

S29NS512P S29NS256P S29NS128P

512/256/128 Mb (32/16/8 M x 16 bit), 1.8 V Burst Simultaneous Read/Write, Multiplexed MirrorBit Flash Memory



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#### Combination

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### Full Production (No Designation on Document)

When a product has been in production for a period of time such that no changes or only nominal changes are expected, the Preliminary designation is removed from the data sheet. Nominal changes may include those affecting the number of ordering part numbers available, such as the addition or deletion of a speed option, temperature range, package type, or  $V_{IO}$  range. Changes may also include those needed to clarify a description or to correct a typographical error or incorrect specification. Spansion Inc. applies the following conditions to documents in this category:

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# S29NS-P MirrorBit<sup>™</sup> Flash Family

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Data Sheet (Advance Information)

## Features

- Single 1.8 V read/program/erase (1.70–1.95 V)
- 90 nm MirrorBit Technology
- Multiplexed Data and Address for reduced I/O count
- Simultaneous Read/Write operation
- Full/Half drive output slew rate control
- 32-word Write Buffer
- Sixteen-bank architecture consisting of 64/32/16 MB for NS512/256/128P, respectively
- Four 32 KB sectors at the top of memory array (NS256/128P)
- 512 128KB sectors (NS512P), 255/127 128KB sectors (NS256/ 128P)
- Programmable linear (8/16/32) with or without wrap around and continuous burst read modes
- Secured Silicon Sector region consisting of 128 words each for factory and customer
- 20-year data retention (typical)
- Cycling Endurance: 100,000 cycles per sector (typical)
- RDY output indicates data available to system
- Command set compatible with JEDEC (42.4) standard

## **Performance Characteristics**

Read Access Times						
Speed Option (MHz)	108					
Max. Synch. Latency, ns (t <sub>IACC</sub> )	80					
Max. Synch. Burst Access, ns (t <sub>BACC</sub> )	7.0					
Max. Asynch. Access Time, ns (t <sub>ACC</sub> )	80					
Max OE# Access Time, ns (t <sub>OE</sub> )	7.0					

- Hardware (WP#) protection of highest two sectors
- Top Boot sector configuration (NS256/128P)
- Handshaking by monitoring RDY
- Offered Packages
  - NS512P: 64-ball FBGA (8 mm x 9.2 mm)
  - NS256P/NS128P: 44-ball FBGA (6.2 mm x 7.7 mm)
- Low V<sub>CC</sub> write inhibit
- Persistent and Password methods of Advanced Sector Protection
- Write operation status bits indicate program and erase operation completion
- Suspend and Resume commands for Program and Erase operations
- Unlock Bypass program command to reduce programming time
- Synchronous or Asynchronous program operation, independent of burst control register settings
- V<sub>PP</sub> input pin to reduce factory programming time
- Support for Common Flash Interface (CFI)

Current Consumption (typical values)						
Continuous Burst Read @ 108 MHz	42 mA					
Simultaneous Operation 108 MHz	60 mA					
Program	30 mA					
Standby Mode	20 µA					

Typical Program & Erase Times						
Single Word Programming	30 µs					
Effective Write Buffer Programming ( $V_{CC}$ ) Per Word	6 µs					
Effective Write Buffer Programming (VPP) Per Word	4 µs					
Sector Erase (16 Kword Sector)	350 ms					
Sector Erase (64 Kword Sector)	600 ms					

## **General Description**

The Spansion S29NS512/256/128P are MirrorBit Flash products fabricated on 90 nm process technology. These burst mode Flash devices are capable of performing simultaneous read and write operations with zero latency on two separate banks using multiplexed data and address pins. These products can operate up to 108 MHz and use a single  $V_{CC}$  of 1.7 V to 1.95 V that makes them ideal for the demanding wireless applications of today that require higher density, better performance, and lowered power consumption.

Publication Number S29NS-P\_00 Revision A Amendment 1 Issue Date February 20, 2007

This document contains information on one or more products under development at Spansion Inc. The information is intended to help you evaluate this product. Do not design in this product without contacting the factory. Spansion Inc. reserves the right to change or discontinue work on this proposed product without notice.



## **Table of Contents**

Fea	tures	
Per	formance	e Characteristics
Ger	neral Des	cription
1.	Orderin	ng Information
2.	Input/C	Dutput Descriptions & Logic Symbol         8
3.	Block [	Diagrams
4.	-	al Dimensions/Connection Diagrams
	4.1 4.2	Related Documents       10         Special Handling Instructions for FBGA Package       10
-		t Overview
5.	5.1	Memory Map
6.	-	Operations
0.	6.1	Device Operation Table
	6.2	Asynchronous Read
	6.3	Synchronous (Burst) Read Operation
	6.4	Autoselect
	6.5 6.6	Program/Erase Operations
	6.7	Writing Commands/Command Sequences
	6.8	Handshaking
	6.9	Hardware Reset
	6.10 6.11	Software Reset
_	-	Programmable Output Slew Rate Control
7.		ced Sector Protection/Unprotection
	7.1 7.2	Lock Register         52           Persistent Protection Bits         53
	7.3	Dynamic Protection Bits
	7.4	Persistent Protection Bit Lock Bit
	7.5	Password Protection Method
	7.6 7.7	Advanced Sector Protection Software Examples       58         Hardware Data Protection Methods       59
8.		Conservation Modes
0.	8.1	Standby Mode
	8.2	Automatic Sleep Mode
	8.3	Hardware RESET# Input Operation
	8.4	Output Disable (OE#) 60
9.		d Silicon Sector Flash Memory Region
	9.1	Factory Secured Silicon Sector
	9.2 9.3	Customer Secured Silicon Sector
10		
10.	10.1	cal Specifications
	10.1	Operating Ranges
	10.3	DC Characteristics
	10.4	Test Conditions
	10.5	Key to Switching Waveforms
	10.6 10.7	Switching Waveforms       66         CLK Characterization       67
	10.8	AC Characteristics
	10.9	Erase and Programming Performance
11.	Append	dix
	11.1	Common Flash Memory Interface
12.	Revisio	on History



## Figures

Figure 3.1	Simultaneous Operation Circuit	. 9
Figure 4.1	64-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS512P Top View, Balls Facing Down	10
Figure 4.2	44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS256P Top View, Balls Facing Down	11
Figure 4.3	44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128P Top View, Balls Facing Down	11
Figure 4.4	VDD064—64-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS512P	12
Figure 4.5	VDE044—44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128/256P	13
Figure 6.1	Synchronous Read Flow Chart	31
Figure 6.2	Single Word Program	36
Figure 6.3	Write Buffer Programming Operation.	39
Figure 6.4	Sector Erase Operation	41
Figure 6.5	Write Operation Status Flowchart	47
Figure 7.1	Advanced Sector Protection/Unprotection	52
Figure 7.2	PPB Program/Erase Algorithm	55
Figure 7.3	Lock Register Program Algorithm	58
Figure 10.1	Maximum Negative Overshoot Waveform	64
Figure 10.2	Maximum Positive Overshoot Waveform	64
Figure 10.3	Test Setup	
Figure 10.4	Input Waveforms and Measurement Levels	66
Figure 10.5	V <sub>CC</sub> Power-Up Diagram	67
Figure 10.6	CLK Characterization	67
Figure 10.7	8-Word Linear Synchronous Single Data Rate Burst with Wrap Around	68
Figure 10.8	8-Word Linear Single Data Read Synchronous Burst without Wrap Around	
Figure 10.9	Asynchronous Mode Read with Latched Addresses	70
Figure 10.10	Asynchronous Mode Read.	70
Figure 10.11	Reset Timings	71
-	Asynchronous Program Operation Timings	
-	Chip/Sector Erase Command Sequence	
	Accelerated Unlock Bypass Programming Timing.	
Figure 10.15	Data# Polling Timings (During Embedded Algorithm)	73
Figure 10.16	Toggle Bit Timings (During Embedded Algorithm).	
Figure 10.17		
Figure 10.18	DQ2 vs. DQ6	74
	Latency with Boundary Crossing	
Figure 10.20	Wait State Configuration Register Setup	75
Figure 10.21	Back-to-Back Read/Write Cycle Timings	76



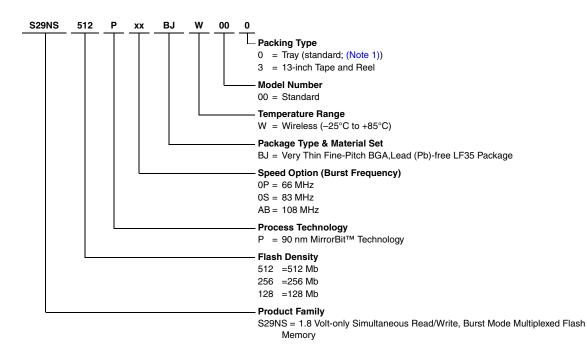
## Tables

Table 2.1	Input/Output Descriptions	8
Table 5.1	S29NS512P Sector & Memory Address Map	.14
Table 5.2	S29NS256P Sector & Memory Address Map	.22
Table 5.3	S29NS128P Sector & Memory Address Map	.25
Table 6.1	Device Operations	.27
Table 6.2	Address Latency for 9 Wait States	
Table 6.3	Address Latency for 8 Wait States	
Table 6.4	Address Latency for 7 Wait States	
Table 6.5	Address Latency for 6 Wait States	
Table 6.6	Address Latency for 5 Wait States	
Table 6.7	Address Latency for 4 Wait States	
Table 6.8	Address Latency for 3 Wait States	
Table 6.9	Address Latency for 2 Wait States	
Table 6.10	Burst Address Groups	
Table 6.11	Configuration Register	
Table 6.12	Autoselect Addresses	
Table 6.13	Autoselect Entry	
Table 6.14	Autoselect Exit	
Table 6.15	Single Word Program	
Table 6.16	Write Buffer Program	
Table 6.17	Sector Erase	
Table 6.18	Chip Erase	
Table 6.19	Erase Suspend	
Table 6.20	Erase Resume	
Table 6.20	Program Suspend	
Table 6.21	Program Resume	
	-	
Table 6.23	Unlock Bypass Entry	
Table 6.24	Unlock Bypass Program	
Table 6.25	Unlock Bypass Reset	
Table 6.26	DQ6 and DQ2 Indications	
Table 6.27	Write Operation Status	
Table 6.28	Reset	
Table 6.29	Programmable Output Slew Rate	
Table 7.1	Sector Protection Schemes	
Table 9.1	Secured Silicon SectorSecure Sector Addresses	
Table 9.2	Secured Silicon Sector Entry (LLD Function = Ild_SecSiSectorEntryCmd)	
Table 9.3	Secured Silicon Sector Program (LLD Function = Ild_ProgramCmd)	
Table 9.4	Secured Silicon Sector Exit (LLD Function = Ild_SecSiSectorExitCmd)	
Table 10.1	DC Characteristics—CMOS Compatible	
Table 10.2	Test Specifications	
Table 10.3	V <sub>CC</sub> Power-Up with No Ramp Rate Restriction	.66
Table 10.4		
	CLK Characterization	.67
Table 10.5	CLK Characterization	.67 .67
Table 10.5 Table 10.6	CLK Characterization	.67 .67 .68
Table 10.5 Table 10.6 Table 10.7	CLK Characterization	.67 .67 .68 .69
Table 10.5 Table 10.6 Table 10.7 Table 10.8	CLK Characterization Synchronous/Burst Read Synchronous Wait State Requirements Asynchronous Mode Read Warm Reset	.67 .67 .68 .69 .70
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9	CLK Characterization	.67 .67 .68 .69 .70 .71
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9 Table 10.10	CLK Characterization Synchronous/Burst Read Synchronous Wait State Requirements Asynchronous Mode Read Warm Reset	.67 .67 .68 .69 .70 .71
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9	CLK Characterization	.67 .67 .68 .69 .70 .71 .75
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9 Table 10.10	CLK Characterization	.67 .68 .69 .70 .71 .75 .77
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9 Table 10.10 Table 10.11	CLK Characterization	.67 .68 .69 .70 .71 .75 .77 .78
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9 Table 10.10 Table 10.11 Table 11.1	CLK Characterization	.67 .68 .69 .70 .71 .75 .77 .78 .80
Table 10.5 Table 10.6 Table 10.7 Table 10.8 Table 10.9 Table 10.10 Table 10.11 Table 11.1 Table 11.2	CLK Characterization Synchronous/Burst Read Synchronous Wait State Requirements Asynchronous Mode Read Warm Reset Erase/Program Timing Example of Programmable Wait States Erase and Programming Performance Memory Array Commands Sector Protection Commands	.67 .67 .68 .69 .70 .71 .75 .77 .78 .80 .82
Table 10.5         Table 10.6         Table 10.7         Table 10.8         Table 10.9         Table 10.10         Table 10.11         Table 11.1         Table 11.2         Table 11.3	CLK Characterization Synchronous/Burst Read Synchronous Wait State Requirements	.67 .68 .69 .70 .71 .75 .77 .78 .80 .82 .82 .82



## 1. Ordering Information

The ordering part number is formed by a valid combination of the following:



		Backers Tyre			
Base Ordering Part Number	Speed Option	Package Type, Material, Pa & Temperature Range 1		Model Number	Package Type
S29NS512P			)-free, LF35) 0, 3 (1) 00		8.0 mm x 9.2 mm, 64-ball
S29NS256P	0P, 0S, AB	BJW (Lead (Pb)-free, LF35)		00	6.0 mm x 7.7 mm .44 holl
S29NS128P					6.2 mm x 7.7 mm, 44-ball

#### Notes

1. Type 0 is standard. Specify other options as required.

2. BGA package marking omits leading S29 and packing type designator from ordering part number.

### **Valid Combinations**

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.



## 2. Input/Output Descriptions & Logic Symbol

Table 2.1 identifies the input and output package connections provided on the device.

Symbol Type		Description			
A24 – A16	Input	Address inputs, S29NS512P			
A23 – A16	Input	Address inputs, S29NS256P			
A22 – A16	Input	Address inputs, S29NS128P			
A/DQ15 – A/DQ0	I/O	Multiplexed Address/Data input/output			
CE#	Input	Chip Enable. Asynchronous relative to CLK for the Burst mode.			
OE#	Input	Output Enable. Asynchronous relative to CLK for the Burst mode			
WE#	Input	Write Enable			
V <sub>CC</sub>	Supply	Device Power Supply			
V <sub>CCQ</sub>	Supply	Input/Output Power Supply (must be ramped simultaneously with V <sub>CC</sub> )			
V <sub>SS</sub>	I/O	Ground			
V <sub>SSQ</sub>	I/O	Input/Output Ground			
NC	No Connect	No Connected internally			
RDY	Output	Ready. Indicates when valid burst data is ready to be read			
CLK	Input	The first rising edge of CLK in conjunction with AVD# low latches address input and activates burst mode operation. After the initial word is output, subsequent rising edges of CLK increment the internal address counter. CLK should remain low during asynchronous access			
AVD#	Input	Address Valid input. Indicates to device that the valid address is present on the address inputs (address bits A15 – A0 are multiplexed, address bits Amax – A16 are address only). $V_{IL}$ = for asynchronous mode, indicates valid address; for burst mode, cause staring address to be latched on rising edge of CLK. $V_{IH}$ = device ignores address inputs			
RESET#	Input	Hardware Reset. Low = device resets and returns to reading array data.			
WP#	Input	Write Protect. At $V_{\text{IL}}$ disables program and erase functions in the four top sectors. Should be at $V_{\text{IH}}$ for all other conditions.			
V <sub>PP</sub>	Input	Accelerated input. At $V_{HH}$ , accelerates programming; automatically places device in unlock bypass mode. At $V_{IL}$ ,disables all program and erase functions. Should be at $V_{IH}$ for all other conditions.			
RFU	Reserved	Reserved for future use			

#### Table 2.1 Input/Output Descriptions



## 3. Block Diagrams

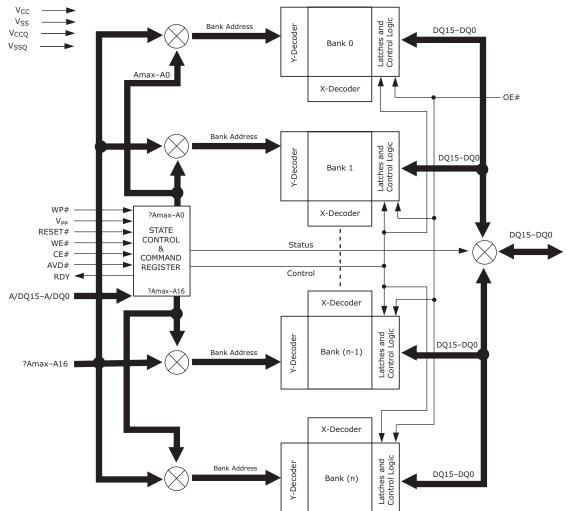


Figure 3.1 Simultaneous Operation Circuit

#### Notes

- 1. Amax = A24 for NS512P, A23 for NS256P, A22 for NS128P.
- 2. Bank (n) = 15 for NS512P/ NS256P/ NS128P.



## 4. Physical Dimensions/Connection Diagrams

This section shows the I/O designations and package specifications for the OPN.

### 4.1 Related Documents

К

The following documents contain information relating to the S29NS-P devices. Click on the title or go to www.spansion.com, or request a copy from your sales office.

Considerations for X-ray Inspection of Surface-Mounted Flash Integrated Circuits

### 4.2 Special Handling Instructions for FBGA Package

Special handling is required for Flash Memory products in FBGA packages.

Flash memory devices in FBGA packages may be damaged if exposed to ultrasonic cleaning methods. The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

### 64-Ball Fine-Pitch Grid Array, S29NS5I2P

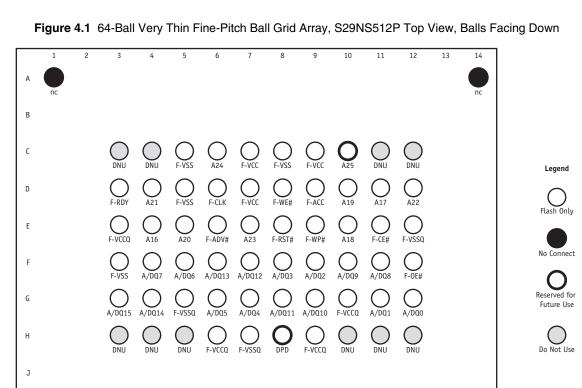


Figure 2.I.



### 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS256P

Figure 4.2 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS256P Top View, Balls Facing Down

NC		NC
	$ \begin{array}{c} (A1) & (A2) & (A3) & (A4) & (A5) & (A6) & (A7) & (A8) & (A9) & (A10) \\ \hline RDY & A21 & V_{SS} & CLK & V_{OC} & WE\# & V_{PP} & A19 & A17 & A22 \\ \hline (B1) & (B2) & (B3) & (B4) & (B5) & (B6) & (B7) & (B8) & (B9) & (B10) \\ \hline V_{CCQ} & A16 & A20 & AVD\# & A23 & RESET\# & WP\# & A18 & CE\# & V_{SSQ} \\ \hline (C1) & (C2) & (C3) & (C4) & (C5) & (C6) & (C7) & (C8) & (C9) & (C10) \\ \hline V_{SS} & ADQ7 & ADQ6 & ADQ13 & ADQ12 & A/DQ3 & ADQ2 & A/DQ9 & A/DQ8 & OE\# \\ \hline (D1) & (D2) & (D3) & (D4) & (D5) & (D6) & (D7) & (D8) & (D9) & (D10) \\ \hline AJDQ15 & A/DQ14 & V_{SSQ} & A/DQ5 & A/DQ4 & A/DQ11 & A/DQ10 & V_{CCQ} & A/DQ1 & A/DQ0 \\ \hline \end{array} $	
NC		NC

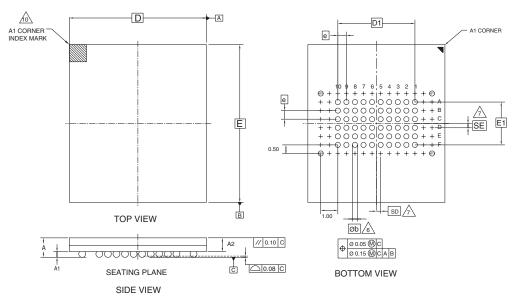
### 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128P

,-  NC											NC
11	(A1) RDY (B1) V <sub>CC0</sub> (C1) V <sub>SS</sub> (D1) A/DQ15	A21 (B2) (C2) (C2) (C2) (C2) (C2) (C2) (C2) (C	(A3) V <sub>SS</sub> (B3) (C3) V <sub>SSQ</sub>	, A4 , CLK , B4 , CLK ,	A5 V <sub>CC</sub> NC V <sub>CC</sub> ADQ12 ADQ4	1-1	A/DQ2	A19 ( B8) ( B8) ( C8) ( C8) ( D8) ( D8) Vccq	A17 B9 CE# C9 A/DQ8 A/DQ1	A10 A22 (B10) Vsso (C10) OE# (D10) A/DQ0	
, - NC											NC

Figure 4.3 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128P Top View, Balls Facing Down



### VDD064—64-Ball Very Thin Fine-Pitch Ball Grid Array



#### Figure 4.4 VDD064—64-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS512P

PACKAGE		VDD 064		
JEDEC	N/A			
	8.00 n	nm x 9.20 mr PACKAGE	n NOM	
SYMBOL	MIN	NOM	MAX	NOTE
А	0.86		1.00	OVERALL THICKNESS
A1	0.20			BALL HEIGHT
A2	0.66	0.71	0.76	BODY THICKNESS
D	7.90	8.00	8.10	BODY SIZE
Е	9.10	9.20	9.30	BODY SIZE
D1		4.50		BALL FOOTPRINT
E1		2.50		BALL FOOTPRINT
MD		10		ROW MATRIX SIZE D DIRECTION
ME		6		ROW MATRIX SIZE E DIRECTION
Ν		64		TOTAL BALL COUNT
Øb	0.25	0.30	0.35	BALL DIAMETER
е		0.50		BALL PITCH
SD / SE		0.25		SOLDER BALL PLACEMENT
				DEPOPULATED SOLDER BALLS

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
- 4. e REPRESENTS THE SOLDER BALL GRID PITCH.
- 5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.
  - SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION.
- N IS THE TOTAL NUMBER OF SOLDER BALLS.
- DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C. A SD AND SE ARE MEASURED WITH RESPECT TO DATUMS
- A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN

THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000.

WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = 0/2

- 8. NOT USED.
- "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED 9. BALLS.
- A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK, METALLIZED MARK INDENTATION OR OTHER MEANS.

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### VDE44-44-Ball Very Thin Fine-Pitch Ball Grid Array, 6.2mm x 7.7 mm

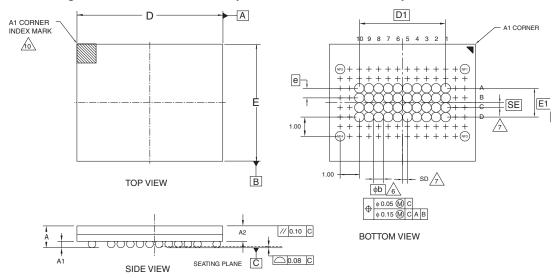


Figure 4.5 VDE044—44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128/256P

PACKAGE	VDE 044			
JEDEC	N/A			
	7.70 n	nm x 6.20 mr PACKAGE	n NOM	
SYMBOL	MIN	NOM	MAX	NOTE
A	0.86		1.00	OVERALL THICKNESS
A1	0.20			BALL HEIGHT
A2	0.66	0.66 0.71 0.76		BODY THICKNESS
D	7.6	6 7.7 7.8		BODY SIZE
E	6.1	6.2	6.3	BODY SIZE
D1		4.50		BALL FOOTPRINT
E1		1.50		BALL FOOTPRINT
MD		10		ROW MATRIX SIZE D DIRECTION
ME		4		ROW MATRIX SIZE E DIRECTION
N		44		TOTAL BALL COUNT
φb	0.25	0.30	0.35	BALL DIAMETER
е		0.50 BSC.		BALL PITCH
SD / SE		0.25 BSC.		SOLDER BALL PLACEMENT
?				DEPOPULATED SOLDER BALLS

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.
- 3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
- 4. e REPRESENTS THE SOLDER BALL GRID PITCH.
- 5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.
  - SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION.
  - N IS THE TOTAL NUMBER OF SOLDER BALLS.
- 6 DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
- A AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.

WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN ? THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000.

- WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE =  $\boxed{0/2}$
- 8. NOT USED.
- 9. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.
- A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK, METALLIZED MARK INDENTATION OR OTHER MEANS.

3308.2 \ 16-038.9L



## 5. Product Overview

The S29NS-P family consists of 512, 256, and 128 Mb, 1.8 volts-only, simultaneous read/write burst mode, multiplexed Flash device optimized for today's wireless designs that demand a large storage array, rich functionality, and low power consumption.

These devices are organized in 32, 16, or 8 Mwords of 16 bits each and are capable of continuous, synchronous (burst) read or linear read (8-word, 16-word, or 32-word aligned group) with or without wrap around. These flash devices multiplex the data and addresses for reduced I/O count. These products also offer single word programming or a 32-word buffer for programming with program/erase and suspend functionality. Additional features include:

- Advanced Sector Protection methods for protecting sectors as required
- 256 words of Secured Silicon area for storing customer and factory secured information. The Secured Silicon Sector is One Time Programmable.

### 5.1 Memory Map

The S29NS512/256/128P Mb devices consist of 16 banks organized as shown in Tables 5.1 - 5.3.

Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA0	64 Kwords	000000h-00FFFFh		SA32	64 Kwords	200000h-20FFFFh
	SA1	64 Kwords	010000h-01FFFFh		SA33	64 Kwords	210000h-21FFFFh
	SA2	64 Kwords	020000h-02FFFFh		SA34	64 Kwords	220000h-22FFFFh
	SA3	64 Kwords	030000h-03FFFFh		SA35	64 Kwords	230000h-23FFFFh
	SA4	64 Kwords	040000h-04FFFFh		SA36	64 Kwords	240000h-24FFFFh
	SA5	64 Kwords	050000h-05FFFFh		SA37	64 Kwords	250000h-25FFFFh
	SA6	64 Kwords	060000h-06FFFFh		SA38	64 Kwords	260000h-26FFFFh
	SA7	64 Kwords	070000h-07FFFFh		SA39	64 Kwords	270000h-27FFFFh
	SA8	64 Kwords	080000h-08FFFFh		SA40	64 Kwords	280000h-28FFFFh
	SA9	64 Kwords	090000h-09FFFFh		SA41	64 Kwords	290000h-29FFFFh
	SA10	64 Kwords	0A0000h-0AFFFFh		SA42	64 Kwords	2A0000h-2AFFFFh
	SA11	64 Kwords	0B0000h-0BFFFFh		SA43	64 Kwords	2B0000h-2BFFFFh
	SA12	64 Kwords	0C0000h-0CFFFFh		SA44	64 Kwords	2C0000h-2CFFFFh
	SA13	64 Kwords	0D0000h-0DFFFFh		SA45	64 Kwords	2D0000h-2DFFFFh
	SA14	64 Kwords	0E0000h-0EFFFFh	Bank 1	SA46	64 Kwords	2E0000h-2EFFFFh
Bank 0	SA15	64 Kwords	0F0000h-0FFFFFh		SA47	64 Kwords	2F0000h-2FFFFFh
Bar	SA16	64 Kwords	100000h-10FFFFh		SA48	64 Kwords	300000h-30FFFFh
	SA17	64 Kwords	110000h-11FFFFh		SA49	64 Kwords	310000h-31FFFFh
	SA18	64 Kwords	120000h-12FFFFh		SA50	64 Kwords	320000h-32FFFFh
	SA19	64 Kwords	130000h-13FFFFh		SA51	64 Kwords	330000h-33FFFFh
	SA20	64 Kwords	140000h-14FFFFh		SA52	64 Kwords	340000h-34FFFFh
	SA21	64 Kwords	150000h-15FFFFh		SA53	64 Kwords	350000h-35FFFFh
	SA22	64 Kwords	160000h-16FFFFh		SA54	64 Kwords	360000h-36FFFFh
	SA23	64 Kwords	170000h-17FFFFh		SA55	64 Kwords	370000h-37FFFFh
	SA24	64 Kwords	180000h-18FFFFh		SA56	64 Kwords	380000h-38FFFFh
	SA25	64 Kwords	190000h-19FFFFh		SA57	64 Kwords	390000h-39FFFFh
	SA26	64 Kwords	1A0000h-1AFFFFh		SA58	64 Kwords	3A0000h-3AFFFFh
	SA27	64 Kwords	1B0000h-1BFFFFh		SA59	64 Kwords	3B0000h-3BFFFFh
	SA28	64 Kwords	1C0000h-1CFFFFh		SA60	64 Kwords	3C0000h-3CFFFFh
	SA29	64 Kwords	1D0000h-1DFFFFh		SA61	64 Kwords	3D0000h-3DFFFFh
	SA30	64 Kwords	1E0000h-1EFFFFh		SA62	64 Kwords	3E0000h-3EFFFFh
	SA31	64 Kwords	1F0000h-1FFFFFh		SA63	64 Kwords	3F0000h-3FFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 1 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA64	64 Kwords	400000h-40FFFFh		SA96	64 K words	600000h-60FFFFh
	SA65	64 Kwords	410000h-41FFFFh		SA97	64 K words	610000h-61FFFFh
	SA66	64 Kwords	420000h-42FFFFh		SA98	64 K words	620000h-62FFFFh
	SA67	64 Kwords	430000h-43FFFFh		SA99	64 K words	630000h-63FFFFh
	SA68	64 Kwords	440000h-44FFFFh		SA100	64 K words	640000h-64FFFFh
	SA69	64 Kwords	450000h-45FFFFh		SA101	64 K words	650000h-65FFFFh
	SA70	64 Kwords	460000h-46FFFFh		SA102	64 K words	660000h-66FFFFh
	SA71	64 Kwords	470000h-47FFFFh		SA103	64 K words	670000h-67FFFh
	SA72	64 Kwords	480000h-48FFFFh		SA104	64 K words	680000h-68FFFFh
	SA73	64 Kwords	490000h-49FFFFh		SA105	64 K words	690000h-69FFFFh
	SA74	64 Kwords	4A0000h-4AFFFFh		SA106	64 K words	6A0000h-6AFFFFh
	SA75	64 Kwords	4B0000h-4BFFFFh		SA107	64 K words	6B0000h-6BFFFFh
	SA76	64 Kwords	4C0000h-4CFFFFh	Bank 3	SA108	64 K words	6C0000h-6CFFFFh
	SA77	64 Kwords	4D0000h-4DFFFFh		SA109	64 K words	6D0000h-6DFFFFh
	SA78	64 Kwords	4E0000h-4EFFFFh		SA110	64 K words	6E0000h-6EFFFFh
Bank 2	SA79	64 Kwords	4F0000h-4FFFFFh		SA111	64 K words	6F0000h-6FFFFh
Ban	SA80	64 Kwords	500000h-50FFFFh	Bar	SA112	64 K words	700000h-70FFFFh
	SA81	64 Kwords	510000h-51FFFFh		SA113	64 K words	710000h-71FFFFh
	SA82	64 Kwords	520000h-52FFFFh		SA114	64 K words	720000h-72FFFFh
	SA83	64 Kwords	530000h-53FFFFh		SA115	64 K words	730000h-73FFFFh
	SA84	64 Kwords	540000h-54FFFFh		SA116	64 K words	740000h-74FFFFh
	SA85	64 Kwords	550000h-55FFFFh		SA117	64 K words	750000h-75FFFFh
	SA86	64 Kwords	560000h-56FFFFh		SA118	64 K words	760000h-76FFFh
	SA87	64 Kwords	570000h-57FFFFh		SA119	64 K words	770000h-77FFFFh
	SA88	64 Kwords	580000h-58FFFFh		SA120	64 K words	780000h-78FFFFh
	SA89	64 Kwords	590000h-59FFFFh		SA121	64 K words	790000h-79FFFh
	SA90	64 Kwords	5A0000h-5AFFFFh		SA122	64 K words	7A0000h–7AFFFFh
ſ	SA91	64 Kwords	5B0000h-5BFFFFh		SA123	64 K words	7B0000h–7BFFFFh
ſ	SA92	64 Kwords	5C0000h-5CFFFFh		SA124	64 K words	7C0000h-7CFFFh
ſ	SA93	64 Kwords	5D0000h-5DFFFFh		SA125	64 K words	7D0000h-7DFFFFh
Ī	SA94	64 Kwords	5E0000h-5EFFFFh		SA126	64 K words	7E0000h-7EFFFh
-	SA95	64 Kwords	5F0000h-5FFFFFh		SA127	64 K words	7F0000h-7FFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 2 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA128	64 Kwords	800000h-80FFFFh		SA160	64 Kwords	A00000h-A0FFFFh
	SA129	64 Kwords	810000h-81FFFFh		SA161	64 Kwords	A10000h-A1FFFFh
	SA130	64 Kwords	820000h-82FFFFh		SA162	64 Kwords	A20000h-A2FFFFh
	SA131	64 Kwords	830000h-83FFFFh		SA163	64 Kwords	A30000h-A3FFFFh
	SA132	64 Kwords	840000h-84FFFFh		SA164	64 Kwords	A40000h-A4FFFFh
	SA133	64 Kwords	850000h-85FFFFh		SA165	64 Kwords	A50000h-A5FFFFh
	SA134	64 Kwords	860000h-86FFFFh		SA166	64 Kwords	A60000h-A6FFFFh
	SA135	64 Kwords	870000h-87FFFFh		SA167	64 Kwords	A70000h-A7FFFFh
	SA136	64 Kwords	880000h-88FFFFh		SA168	64 Kwords	A80000h-A8FFFFh
	SA137	64 Kwords	890000h-89FFFFh		SA169	64 Kwords	A90000h-A9FFFFh
	SA138	64 Kwords	8A0000h-8AFFFFh		SA170	64 Kwords	AA0000h-AAFFFFh
	SA139	64 Kwords	8B0000h-8BFFFFh		SA171	64 Kwords	AB0000h-ABFFFFh
ľ	SA140	64 Kwords	8C0000h-8CFFFFh		SA172	64 Kwords	AC0000h-ACFFFh
	SA141	64 Kwords	8D0000h-8DFFFFh	Bank 5	SA173	64 Kwords	AD0000h-ADFFFFh
	SA142	64 Kwords	8E0000h-8EFFFFh		SA174	64 Kwords	AE0000h-AEFFFh
Bank 4	SA143	64 Kwords	8F0000h-8FFFFFh		SA175	64 Kwords	AF0000h-AFFFFh
Ban	SA144	64 Kwords	900000h-90FFFFh	Bar	SA176	64 Kwords	B00000h-B0FFFFh
	SA145	64 Kwords	910000h-91FFFFh		SA177	64 Kwords	B10000h-B1FFFFh
	SA146	64 Kwords	920000h-92FFFFh		SA178	64 Kwords	B20000h-B2FFFFh
	SA147	64 Kwords	930000h-93FFFFh		SA179	64 Kwords	B30000h-B3FFFFh
	SA148	64 Kwords	940000h-94FFFFh		SA180	64 Kwords	B40000h-B4FFFFh
	SA149	64 Kwords	950000h-95FFFFh		SA181	64 Kwords	B50000h-B5FFFFh
	SA150	64 Kwords	960000h-96FFFFh		SA182	64 Kwords	B60000h-B6FFFFh
	SA151	64 Kwords	970000h-97FFFFh		SA183	64 Kwords	B70000h-B7FFFFh
	SA152	64 Kwords	980000h-98FFFFh		SA184	64 Kwords	B80000h-B8FFFFh
	SA153	64 Kwords	990000h-99FFFFh		SA185	64 Kwords	B90000h-B9FFFFh
	SA154	64 Kwords	9A0000h-9AFFFFh		SA186	64 Kwords	BA0000h-BAFFFFh
ľ	SA155	64 Kwords	9B0000h–9BFFFFh	1	SA187	64 Kwords	BB0000h-BBFFFFh
	SA156	64 Kwords	9C0000h-9CFFFFh		SA188	64 Kwords	BC0000h-BCFFFFh
F	SA157	64 Kwords	9D0000h-9DFFFFh		SA189	64 Kwords	BD0000h-BDFFFFh
F	SA158	64 Kwords	9E0000h-9EFFFFh	1	SA190	64 Kwords	BE0000h-BEFFFFh
ľ	SA159	64 Kwords	9F0000h-9FFFFFh	1	SA191	64 Kwords	BF0000h-BFFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 3 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA192	64 Kwords	C00000h-C0FFFFh		SA224	64 K words	E00000h-E0FFFh
	SA193	64 Kwords	C10000h-C1FFFFh		SA225	64 K words	E10000h-E1FFFFh
	SA194	64 Kwords	C20000h-C2FFFFh		SA226	64 K words	E20000h-E2FFFFh
-	SA195	64 Kwords	C30000h-C3FFFFh		SA227	64 K words	E30000h-E3FFFFh
	SA196	64 Kwords	C40000h-C4FFFFh		SA228	64 K words	E40000h-E4FFFFh
	SA197	64 Kwords	C50000h-C5FFFFh		SA229	64 K words	E50000h-E5FFFFh
	SA198	64 Kwords	C60000h-C6FFFFh		SA230	64 K words	E60000h-E6FFFFh
	SA199	64 Kwords	C70000h-C7FFFFh		SA231	64 K words	E70000h-E7FFFh
	SA200	64 Kwords	C80000h-C8FFFFh		SA232	64 K words	E80000h-E8FFFFh
-	SA201	64 Kwords	C90000h-C9FFFFh		SA233	64 K words	E90000h-E9FFFFh
	SA202	64 Kwords	CA0000h-CAFFFFh		SA234	64 K words	EA0000h-EAFFFh
	SA203	64 Kwords	CB0000h-CBFFFFh		SA235	64 K words	EB0000h-EBFFFFh
	SA204	64 Kwords	CC0000h-CCFFFFh	Bank 7	SA236	64 K words	EC0000h-ECFFFh
	SA205	64 Kwords	CD0000h-CDFFFFh		SA237	64 K words	ED0000h-EDFFFFh
	SA206	64 Kwords	CE0000h-CEFFFFh		SA238	64 K words	EE0000h-EEFFFFh
Bank 6	SA207	64 Kwords	CF0000h-CFFFFh		SA239	64 K words	EF0000h-EFFFFh
Ban	SA208	64 Kwords	D00000h-D0FFFFh	Bar	SA240	64 K words	F00000h-F0FFFh
	SA209	64 Kwords	D10000h-D1FFFFh		SA241	64 K words	F10000h-F1FFFFh
	SA210	64 Kwords	D20000h-D2FFFFh		SA242	64 K words	F20000h-F2FFFFh
	SA211	64 Kwords	D30000h-D3FFFFh		SA243	64 K words	F30000h-F3FFFFh
	SA212	64 Kwords	D40000h-D4FFFFh		SA244	64 K words	F40000h-F4FFFFh
	SA213	64 Kwords	D50000h-D5FFFFh		SA245	64 K words	F50000h-F5FFFFh
	SA214	64 Kwords	D60000h-D6FFFFh		SA246	64 K words	F60000h-F6FFFFh
	SA215	64 Kwords	D70000h-D7FFFFh		SA247	64 K words	F70000h-F7FFFFh
	SA216	64 Kwords	D80000h-D8FFFFh		SA248	64 K words	F80000h-F8FFFFh
	SA217	64 Kwords	D90000h-D9FFFFh		SA249	64 K words	F90000h-F9FFFFh
Ī	SA218	64 Kwords	DA0000h-DAFFFFh		SA250	64 K words	FA0000h-FAFFFFh
Ī	SA219	64 Kwords	DB0000h-DBFFFFh		SA251	64 K words	FB0000h-FBFFFFh
	SA220	64 Kwords	DC0000h-DCFFFFh		SA252	64 K words	FC0000h-FCFFFFh
Ī	SA221	64 Kwords	DD0000h-DDFFFFh		SA253	64 K words	FD0000h-FDFFFFh
ľ	SA222	64 Kwords	DE0000h-DEFFFFh		SA254	64 K words	FE0000h-FEFFFFh
	SA223	64 Kwords	DF0000h-DFFFFFh		SA255	64 K words	FF0000h-FFFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 4 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA256	64 Kwords	1000000h-100FFFFh		SA288	64 Kwords	1200000h-120FFFFh
	SA257	64 Kwords	1010000h-101FFFFh		SA289	64 Kwords	1210000h-121FFFFh
	SA258	64 Kwords	1020000h-102FFFFh		SA290	64 Kwords	1220000h-122FFFFh
	SA259	64 Kwords	1030000h-103FFFFh		SA291	64 Kwords	1230000h-123FFFFh
	SA260	64 Kwords	1040000h-104FFFFh		SA292	64 Kwords	1240000h-124FFFFh
	SA261	64 Kwords	1050000h-105FFFFh		SA293	64 Kwords	1250000h-125FFFFh
	SA262	64 Kwords	1060000h-106FFFFh		SA294	64 Kwords	1260000h-126FFFFh
	SA263	64 Kwords	1070000h-107FFFFh		SA295	64 Kwords	1270000h-127FFFFh
	SA264	64 Kwords	1030000h-108FFFFh		SA296	64 Kwords	1230000h-128FFFFh
	SA265	64 Kwords	1090000h-109FFFFh		SA297	64 Kwords	1290000h-129FFFFh
	SA266	64 Kwords	10A0000h-10AFFFFh		SA298	64 Kwords	12A0000h-12AFFFFh
	SA267	64 Kwords	10B0000h-10BFFFFh		SA299	64 Kwords	12B0000h-12BFFFFh
	SA268	64 Kwords	10C0000h-10CFFFFh		SA300	64 Kwords	12C0000h-12CFFFFh
	SA269	64 Kwords	10D0000h-10DFFFFh	Bank 9	SA301	64 Kwords	12D0000h-12DFFFFh
	SA270	64 Kwords	10E0000h-10EFFFFh		SA302	64 Kwords	12E0000h-12EFFFFh
Bank 8	SA271	64 Kwords	10F0000h-10FFFFFh		SA303	64 Kwords	12F0000h-12FFFFFh
Bar	SA272	64 Kwords	1100000h-110FFFFh		SA304	64 Kwords	1300000h-130FFFFh
	SA273	64 Kwords	1110000h-111FFFFh		SA305	64 Kwords	1310000h-131FFFFh
	SA274	64 Kwords	1120000h-112FFFFh		SA306	64 Kwords	1320000h-132FFFFh
	SA275	64 Kwords	1130000h-113FFFFh		SA307	64 Kwords	1330000h-133FFFFh
	SA276	64 Kwords	1140000h-114FFFFh		SA308	64 Kwords	1340000h-134FFFFh
	SA277	64 Kwords	1150000h-115FFFFh		SA309	64 Kwords	1350000h-135FFFFh
	SA278	64 Kwords	1160000h-116FFFFh		SA310	64 Kwords	1360000h-136FFFFh
	SA279	64 Kwords	1170000h-117FFFFh		SA311	64 Kwords	1370000h-137FFFFh
	SA280	64 Kwords	1180000h-118FFFFh		SA312	64 Kwords	1380000h-138FFFFh
	SA281	64 Kwords	1190000h-119FFFFh		SA313	64 Kwords	1390000h-139FFFFh
	SA282	64 Kwords	11A0000h-11AFFFFh		SA314	64 Kwords	13A0000h-13AFFFFh
	SA283	64 Kwords	11B0000h-11BFFFFh		SA315	64 Kwords	13B0000h-13BFFFFh
	SA284	64 Kwords	11C0000h-11CFFFFh		SA316	64 Kwords	13C0000h-13CFFFFh
	SA285	64 Kwords	11D0000h-11DFFFFh		SA317	64 Kwords	13D0000h-13DFFFFh
	SA286	64 Kwords	11E0000h-11EFFFFh		SA318	64 Kwords	13E0000h-13EFFFFh
	SA287	64 Kwords	11F0000h-11FFFFFh		SA319	64 Kwords	13F0000h-13FFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 5 of 8)



		1	1			,	
Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA320	64 Kwords	1400000h-140FFFFh		SA352         64 K           SA353         64 K           SA353         64 K           SA354         64 K           SA355         64 K           SA356         64 K           SA357         64 K           SA358         64 K           SA357         64 K           SA358         64 K           SA359         64 K           SA360         64 K           SA361         64 K           SA362         64 K           SA363         64 K           SA364         64 K           SA365         64 K           SA366         64 K           SA366         64 K           SA366         64 K           SA366         64 K           SA367         64 K           SA368         64 K           SA370         64 K           SA371         64 K           SA372         64 K           SA375         64 K           SA376         64 K           SA376         64 K           SA379         64 K           SA380         64 K      SA381         64 K <td>64 K words</td> <td>1600000h-160FFFFh</td>	64 K words	1600000h-160FFFFh
	SA321	64 Kwords	1410000h-141FFFFh		SA353	64 K words         1610000h-161FFFF           64 K words         1620000h-162FFFF           64 K words         1630000h-163FFFF           64 K words         1640000h-164FFFF           64 K words         1650000h-165FFFF           64 K words         1650000h-165FFFF           64 K words         1660000h-165FFFF           64 K words         1670000h-167FFFF           64 K words         1630000h-168FFFF           64 K words         1630000h-168FFFF           64 K words         1690000h-168FFFF           64 K words         1660000h-168FFFF           64 K words         1660000h-16FFFFF           64 K words         16E0000h-16FFFFF           64 K words         16E0000h-16FFFFF           64 K words         16E0000h-16FFFFF           64 K words         170000h-170FFFF           64 K words         170000h-170FFFF           64 K words         172000h-172FFFF           64 K words         1730000h-173FFFF           64 K words         1750000h-174FFFF           64 K words         1770000h-174FFFF           64 K words         1770000h-178FFFF           64 K words         1780000h-178FFFF           64 K words         1780000h-178FFFF           6	1610000h-161FFFFh
	SA322	64 Kwords	1420000h-142FFFFh		SA354	64 K words	Address Range           K words         160000h-160FFFFh           K words         161000h-161FFFFh           K words         162000h-162FFFh           K words         163000h-163FFFFh           K words         164000h-164FFFFh           K words         165000h-163FFFFh           K words         165000h-163FFFFh           K words         166000h-163FFFFh           K words         167000h-163FFFFh           K words         163000h-163FFFFh           K words         163000h-163FFFFh           K words         163000h-163FFFFh           K words         166000h-163FFFFh           K words         168000h-163FFFFh           K words         168000h-163FFFFh           K words         166000h-163FFFFh           K words         166000h-160FFFFh           K words         166000h-160FFFFh           K words         166000h-160FFFFh           K words         170000h-170FFFFh           K words         171000h-171FFFFh           K words         172000h-172FFFFh           K words         175000h-173FFFFh           K words         175000h-173FFFFh           K words         176000h-174FFFFh           K words <th< td=""></th<>
	SA323	64 Kwords	1430000h-143FFFFh		SA355	64 K words	
	SA324	64 Kwords	1440000h-144FFFFh		SA356	64 K words	1640000h-164FFFFh
	SA325	64 Kwords	1450000h-145FFFFh		SA357	64 K words	1650000h-165FFFFh
	SA326	64 Kwords	1460000h-146FFFFh		SA358	64 K words	1660000h-166FFFFh
	SA327	64 Kwords	1470000h-147FFFFh		SA359	64 K words	1670000h-167FFFFh
	SA328	64 Kwords	1430000h-148FFFFh		SA360	64 K words	1630000h-168FFFFh
	SA329	64 Kwords	1490000h-149FFFFh		SA361	64 K words	1690000h-169FFFFh
	SA330	64 Kwords	14A0000h-14AFFFFh		SA362	64 K words	16A0000h-16AFFFFh
	SA331	64 Kwords	14B0000h-14BFFFFh		SA363	64 K words	16B0000h-16BFFFFh
	SA332	64 Kwords	14C0000h-14CFFFFh		SA364	64 K words	16C0000h-16CFFFFh
	SA333	64 Kwords	14D0000h-14DFFFFh		SA365	64 K words	16D0000h-16DFFFFh
	SA334	64 Kwords	14E0000h-14EFFFFh		SA366	64 K words	16E0000h-16EFFFFh
Bank 10	SA335	64 Kwords	14F0000h-14FFFFFh	k 1	SA367	64 K words	16F0000h-16FFFFFh
Banl	SA336	64 Kwords	1500000h-150FFFFh	Ban	SA368	64 K words	1700000h-170FFFFh
-	SA337	64 Kwords	1510000h-151FFFFh		SA369	64 K words	1710000h-171FFFFh
	SA338	64 Kwords	1520000h-152FFFFh		SA370	64 K words	1720000h-172FFFFh
	SA339	64 Kwords	1530000h-153FFFFh		SA371	64 K words	1730000h-173FFFFh
	SA340	64 Kwords	1540000h-154FFFFh		SA372	64 K words	1740000h-174FFFFh
	SA341	64 Kwords	1550000h-155FFFFh		SA373	64 K words	1750000h-175FFFFh
	SA342	64 Kwords	1560000h-156FFFFh		SA374	64 K words	1760000h-176FFFFh
	SA343	64 Kwords	1570000h-157FFFFh		SA375	64 K words	1770000h-177FFFFh
	SA344	64 Kwords	1580000h-158FFFFh		SA376	64 K words	1780000h-178FFFFh
	SA345	64 Kwords	1590000h-159FFFFh		SA377	64 K words	1790000h-179FFFFh
	SA346	64 Kwords	15A0000h-15AFFFFh		SA378	64 K words	17A0000h-17AFFFFh
	SA347	64 Kwords	15B0000h-15BFFFFh		SA379	64 K words	17B0000h-17BFFFFh
	SA348	64 Kwords	15C0000h-15CFFFFh		SA380	64 K words	15C0000h-17CFFFFh
	SA349	64 Kwords	15D0000h-15DFFFFh		SA381	64 K words	17D0000h-17DFFFFh
	SA350	64 Kwords	15E0000h-15EFFFFh		SA382	64 K words	17E0000h-17EFFFFh
	SA351	64 Kwords	15F0000h-15FFFFFh		SA383	64 K words	17F0000h-17FFFFFh
		1		· •			

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 6 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA384	64 Kwords	1800000h-180FFFFh		SA416	64 Kwords	1A00000h-1A0FFFFh
	SA385	64 Kwords	1810000h-181FFFFh		SA417	64 Kwords	1A10000h-1A1FFFFh
	SA386	64 Kwords	1820000h-182FFFFh		SA418	64 Kwords	1A20000h-1A2FFFFh
	SA387	64 Kwords	1830000h-183FFFFh		SA419	64 Kwords	1A30000h-1A3FFFFh
	SA388	64 Kwords	1840000h-184FFFFh		SA420	64 Kwords	1A40000h-1A4FFFFh
	SA389	64 Kwords	1850000h-185FFFFh		SA421	64 Kwords	1A50000h-1A5FFFFh
	SA390	64 Kwords	1860000h-186FFFFh		SA422	64 Kwords	1A60000h-1A6FFFFh
	SA391	64 Kwords	1870000h-187FFFFh		SA423	64 Kwords	1A70000h-1A7FFFFh
	SA392	64 Kwords	1830000h-188FFFFh		SA424	64 Kwords	1A30000h-1A8FFFFh
	SA393	64 Kwords	1890000h-189FFFFh		SA425	64 Kwords	1A90000h-1A9FFFFh
	SA394	64 Kwords	18A0000h-18AFFFFh		SA426	64 Kwords	1AA0000h-1AAFFFFh
ſ	SA395	64 Kwords	18B0000h-18BFFFFh		SA427	64 Kwords	1AB0000h-1ABFFFFh
	SA396	64 Kwords	18C0000h-18CFFFFh		SA428	64 Kwords	1AC0000h-1ACFFFFh
ſ	SA397	64 Kwords	18D0000h-18DFFFFh		SA429	64 Kwords	1AD0000h-1ADFFFFh
ſ	SA398	64 Kwords	18E0000h-18EFFFFh		SA430	64 Kwords	1AE0000h-1AEFFFFh
< 12	SA399	64 Kwords	18F0000h-18FFFFFh	Bank 13	SA431	64 Kwords	1AF0000h-1AFFFFFh
Bank 12	SA400	64 Kwords	1900000h-190FFFFh	Ban	SA432	64 Kwords	1B00000h-1B0FFFFh
	SA401	64 Kwords	1910000h-191FFFFh		SA433	64 Kwords	1B10000h-1B1FFFFh
	SA402	64 Kwords	1920000h-192FFFFh		SA434	64 Kwords	1B20000h-1B2FFFFh
	SA403	64 Kwords	1930000h-193FFFFh		SA435	64 Kwords	1B30000h-1B3FFFFh
	SA404	64 Kwords	1940000h-194FFFFh		SA436	64 Kwords	1B40000h-1B4FFFFh
	SA405	64 Kwords	1950000h-195FFFFh		SA437	64 Kwords	1B50000h-1B5FFFFh
	SA406	64 Kwords	1960000h-196FFFFh		SA438	64 Kwords	1B60000h-1B6FFFFh
	SA407	64 Kwords	1970000h-197FFFFh		SA439	64 Kwords	1B70000h-1B7FFFFh
ſ	SA408	64 Kwords	1980000h-198FFFFh		SA440	64 Kwords	1B80000h-1B8FFFFh
	SA409	64 Kwords	1990000h-199FFFFh		SA441	64 Kwords	1B90000h-1B9FFFFh
	SA410	64 Kwords	19A0000h-19AFFFFh		SA442	64 Kwords	1BA0000h-1BAFFFFh
	SA411	64 Kwords	19B0000h-19BFFFFh		SA443	64 Kwords	1BB0000h-1BBFFFFh
ſ	SA412	64 Kwords	19C0000h-19CFFFFh		SA444	64 Kwords	1BC0000h-1BCFFFFh
ľ	SA413	64 Kwords	19D0000h-19DFFFFh		SA445	64 Kwords	1BD0000h-1BDFFFFh
ľ	SA414	64 Kwords	19E0000h-19EFFFFh		SA446	64 Kwords	1BE0000h-1BEFFFFh
Ē	SA415	64 Kwords	19F0000h-19FFFFFh		SA447	64 Kwords	1BF0000h-1BFFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 7 of 8)



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
-	SA448	64 Kwords	Ŭ		SA480	64 K words	1E00000h-1E0FFFFh
-	SA449	64 Kwords	1C10000h-1C1FFFFh		SA481	64 K words	1E10000h-1E1FFFFh
-	SA450	64 Kwords	1C00000h-1C0FFFFh         SA480         64 K words           1C10000h-1C1FFFFh         SA481         64 K words           1C20000h-1C2FFFFh         SA482         64 K words           1C30000h-1C3FFFFh         SA483         64 K words           1C40000h-1C4FFFFh         SA483         64 K words           1C50000h-1C3FFFFh         SA485         64 K words           1C50000h-1C6FFFFh         SA486         64 K words           1C70000h-1C7FFFFh         SA486         64 K words           1C30000h-1C8FFFFh         SA488         64 K words           1C30000h-1C8FFFFh         SA489         64 K words           1C30000h-1C8FFFFh         SA489         64 K words           1C20000h-1C8FFFFh         SA490         64 K words           1C20000h-1CFFFFh         SA491         64 K words           1C20000h-1CFFFFh         SA492         64 K words           1C20000h-1CFFFFh         SA493         64 K words           1C20000h-1CFFFFh         SA496         64 K words           1D10000h-1D1FFFFh         SA496         64 K words           1D20000h-1D2FFFFh         SA498         64 K words           1D30000h-1D3FFFFh         SA499         64 K words           1D40000h-1D4FFFFh         <	64 K words	1E20000h-1E2FFFFh		
-	SA451	64 Kwords			SA483	64 K words	1E30000h-1E3FFFFh
-	SA452	64 Kwords				64 K words	1E40000h-1E4FFFFh
-	SA453	64 Kwords	1C50000h-1C5FFFFh		SA485	64 K words	1E50000h-1E5FFFFh
-	SA454	64 Kwords					1E60000h-1E6FFFFh
-	SA455	64 Kwords				64 K words	1E70000h-1E7FFFFh
-	SA456	64 Kwords	1C30000h-1C8FFFFh		SA488	64 K words	1E30000h-1E8FFFFh
-	SA457	64 Kwords					1E90000h-1E9FFFFh
	SA458	64 Kwords				64 K words	1EA0000h-1EAFFFFh
-	SA459	64 Kwords	1CB0000h-1CBFFFFh		SA491	64 K words	1EB0000h-1EBFFFFh
-	SA460	64 Kwords	1CC0000h-1CCFFFFh		SA492	64 K words	1EC0000h-1ECFFFFh
-	SA461	64 Kwords	1CD0000h-1CDFFFFh	3ank 15	SA493	64 K words	1ED0000h-1EDFFFFh
-	SA462	64 Kwords	1CE0000h-1CEFFFFh		SA494	64 K words	1EE0000h-1EEFFFFh
14	SA463	64 Kwords	1CF0000h-1CFFFFFh		SA495	64 K words	1EF0000h-1EFFFFh
Bank 14	SA464	64 Kwords	1D00000h-1D0FFFFh		SA496	64 K words	1F00000h-1F0FFFFh
	SA465	64 Kwords	1D10000h-1D1FFFFh		SA497	64 K words	1F10000h-1F1FFFFh
-	SA466	64 Kwords	1D20000h-1D2FFFFh		SA498	64 K words	1F20000h-1F2FFFFh
-	SA467	64 Kwords	1D30000h-1D3FFFFh		SA499	64 K words	1F30000h-1F3FFFFh
-	SA468	64 Kwords	1D40000h-1D4FFFFh		SA500	64 K words	1F40000h-1F4FFFFh
-	SA469	64 Kwords	1D50000h-1D5FFFFh		SA501	64 K words	1F50000h-1F5FFFFh
ľ	SA470	64 Kwords	1D60000h-1D6FFFFh		SA502	64 K words	1F60000h-1F6FFFFh
-	SA471	64 Kwords	1D70000h-1D7FFFFh		SA503	64 K words	1F70000h-1F7FFFFh
-	SA472	64 Kwords	1D80000h-1D8FFFFh		SA504	64 K words	1F80000h-1F8FFFFh
ľ	SA473	64 Kwords	1D90000h-1D9FFFFh		SA505	64 K words	1F90000h-1F9FFFFh
ľ	SA474	64 Kwords	1DA0000h-1DAFFFFh		SA506	64 K words	1FA0000h-1FAFFFFh
ŀ	SA475	64 Kwords	1DB0000h-1DBFFFFh		SA507	64 K words	1FB0000h-1FBFFFFh
ľ	SA476	64 Kwords	1DC0000h-1DCFFFFh		SA508	64 K words	1FC0000h-1FCFFFFh
ſ	SA477	64 Kwords	1DD0000h-1DDFFFFh		SA509	64 K words	1FD0000h-1FDFFFFh
ľ	SA478	64 Kwords	1DE0000h-1DEFFFFh		SA510	64 K words	1FE0000h-1FEFFFFh
ſ	SA479	64 Kwords	1DF0000h-1DFFFFFh		SA511	64 K words	1FF0000h-1FFFFFFh

Table 5.1 S29NS512P Sector & Memory Address Map (Sheet 8 of 8)



Table 5.2 S29NS256P Sector & Memory Address Map (Sheet 1 of 3)

Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA0	64 Kwords	000000h-00FFFFh		SA32	64 Kwords	200000h-20FFFFh
	SA1	64 Kwords	010000h-01FFFFh		SA33	64 Kwords	210000h-21FFFFh
	SA2	64 Kwords	020000h-02FFFFh		SA34	64 Kwords	220000h-22FFFFh
	SA3	64 Kwords	030000h-03FFFFh		SA35	64 Kwords	230000h-23FFFFh
	SA4	64 Kwords	040000h-04FFFFh		SA36	64 Kwords	240000h-24FFFFh
	SA5	64 Kwords	050000h-05FFFFh		SA37	64 Kwords	250000h-25FFFFh
	SA6	64 Kwords	060000h-06FFFFh		SA38	64 Kwords	260000h-26FFFFh
Bank 0	SA7	64 Kwords	070000h-07FFFFh	Bank 2	SA39	64 Kwords	270000h-27FFFFh
Bar	SA8	64 Kwords	080000h-08FFFFh	Bar	SA40	64 Kwords	280000h-28FFFFh
	SA9	64 Kwords	090000h-09FFFFh		SA41	64 Kwords	290000h-29FFFFh
	SA10	64 Kwords	0A0000h-0AFFFFh		SA42	64 Kwords	2A0000h-2AFFFFh
·	SA11	64 Kwords	0B0000h-0BFFFFh		SA43	64 Kwords	2B0000h-2BFFFFh
	SA12	64 Kwords	0C0000h-0CFFFFh		SA44	64 Kwords	2C0000h-2CFFFFh
	SA13	64 Kwords	0D0000h-0DFFFFh		SA45	64 Kwords	2D0000h-2DFFFFh
•	SA14	64 Kwords	0E0000h-0EFFFFh		SA46	64 Kwords	2E0000h-2EFFFFh
	SA15	64 Kwords	0F0000h-0FFFFh			64 Kwords	2F0000h-2FFFFh
	SA16	64 Kwords	100000h-10FFFFh		SA48	64 Kwords	300000h-30FFFFh
	SA17	64 Kwords	110000h-11FFFFh		SA49	64 Kwords	310000h-31FFFFh
	SA18	64 Kwords	120000h-12FFFFh		SA50	64 Kwords	320000h-32FFFFh
-	SA19	64 Kwords	130000h-13FFFFh	-	SA51	64 Kwords	330000h-33FFFFh
-	SA20	64 Kwords	140000h-14FFFFh		SA52	64 Kwords	340000h-34FFFFh
-	SA21	64 Kwords	150000h-15FFFFh		SA53	64 Kwords	350000h-35FFFFh
-	SA22	64 Kwords	160000h-16FFFFh		SA54	64 Kwords	360000h-36FFFFh
х Т	SA23	64 Kwords	170000h-17FFFFh	k 3	SA55	64 Kwords	370000h-37FFFFh
Bank 1	SA24	64 Kwords	180000h-18FFFFh	Bank 3	SA56	64 Kwords	380000h-38FFFFh
	SA25	64 Kwords	190000h-19FFFFh		SA57	64 Kwords	390000h-39FFFFh
-	SA26	64 Kwords	1A0000h-1AFFFFh		SA58	64 Kwords	3A0000h-3AFFFFh
•	SA27	64 Kwords	1B0000h-1BFFFFh		SA59	64 Kwords	3B0000h-3BFFFFh
•	SA28	64 Kwords	1C0000h-1CFFFFh		SA60	64 Kwords	3C0000h-3CFFFFh
•	SA29	64 Kwords	1D0000h-1DFFFFh		SA61	64 Kwords	3D0000h-3DFFFFh
	SA30	64 Kwords	1E0000h-1EFFFFh		SA62	64 Kwords	3E0000h-3EFFFFh
	SA31	64 Kwords	1F0000h-1FFFFFh		SA63	64 Kwords	3F0000h-3FFFFh
	SA64	64 Kwords	400000h-40FFFFh		SA96	64 K words	600000h-60FFFFh
	SA65	64 Kwords	410000h-41FFFFh		SA97	64 K words	610000h-61FFFFh
	SA66	64 Kwords	420000h-42FFFFh		SA98	64 K words	620000h-62FFFFh
•	SA67	64 Kwords	430000h-43FFFFh		SA99	64 K words	630000h-63FFFFh
	SA68	64 Kwords	440000h-44FFFFh		SA100	64 K words	640000h-64FFFFh
-	SA69	64 Kwords	450000h-45FFFFh		SA101	64 K words	650000h-65FFFFh
-	SA70	64 Kwords	460000h-46FFFFh		SA102	64 K words	660000h-66FFFFh
k 4	SA71	64 Kwords	470000h-47FFFFh	9 ×	SA103	64 K words	670000h-67FFFFh
Bank 4	SA72	64 Kwords	480000h-48FFFFh	Bank 6	SA104	64 K words	680000h-68FFFFh
_	SA73	64 Kwords	490000h-49FFFFh		SA105	64 K words	690000h-69FFFFh
-	SA74	64 Kwords	4A0000h-4AFFFFh		SA106	64 K words	6A0000h-6AFFFh
ŀ	SA75	64 Kwords	4B0000h-4BFFFFh		SA107	64 K words	6B0000h-6BFFFFh
	SA76	64 Kwords	4C0000h-4CFFFFh		SA108	64 K words	6C0000h-6CFFFFh
	SA77	64 Kwords	4D0000h-4DFFFFh		SA109	64 K words	6D0000h-6DFFFFh
-	SA78	64 Kwords	4E0000h-4EFFFFh		SA110	64 K words	6E0000h-6EFFFFh
	SA79	64 Kwords	4F0000h-4FFFFFh		SA111	64 K words	6F0000h-6FFFFFh



Table 5.2 S29NS256P Sector & Memory Address Map (Sheet 2 of	3)
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Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA80	64 Kwords	500000h-50FFFFh		SA112	64 K words	700000h-70FFFFh
	SA81	64 Kwords	510000h-51FFFFh		SA113	64 K words	710000h-71FFFFh
	SA82	64 Kwords	520000h-52FFFFh		SA114	64 K words	720000h-72FFFFh
F	SA83	64 Kwords	530000h-53FFFFh		SA115	64 K words	730000h-73FFFFh
	SA84	64 Kwords	540000h-54FFFFh		SA116	64 K words	740000h-74FFFFh
F	SA85	64 Kwords	550000h-55FFFFh		SA117	64 K words	750000h-75FFFFh
	SA86	64 Kwords	560000h-56FFFFh		SA118	64 K words	760000h-76FFFFh
Bank 5	SA87	64 Kwords	570000h-57FFFFh	Bank 7	SA119	64 K words	770000h-77FFFFh
Ban	SA88	64 Kwords	580000h-58FFFFh	Ban	SA120	64 K words	780000h-78FFFFh
ľ	SA89	64 Kwords	590000h-59FFFFh		SA121	64 K words	790000h-79FFFFh
F	SA90	64 Kwords	5A0000h-5AFFFFh		SA122	64 K words	7A0000h-7AFFFFh
Ī	SA91	64 Kwords	5B0000h-5BFFFFh		SA123	64 K words	7B0000h–7BFFFFh
-	SA92	64 Kwords	5C0000h-5CFFFFh		SA124	64 K words	7C0000h-7CFFFFh
Ī	SA93	64 Kwords	5D0000h-5DFFFFh		SA125	64 K words	7D0000h-7DFFFFh
-	SA94	64 Kwords	5E0000h-5EFFFFh		SA126	64 K words	7E0000h-7EFFFh
-	SA95	64 Kwords	5F0000h-5FFFFFh		SA127	64 K words	7F0000h-7FFFFFh
	SA128	64 Kwords	800000h-80FFFFh		SA160	64 Kwords	A00000h-A0FFFFh
	SA129	64 Kwords	810000h-81FFFFh		SA161	64 Kwords	A10000h-A1FFFFh
-	SA130	64 Kwords	820000h-82FFFFh		SA162	64 Kwords	A20000h-A2FFFFh
	SA131	64 Kwords	830000h-83FFFFh		SA163	64 Kwords	A30000h–A3FFFFh
	SA132	64 Kwords	840000h-84FFFFh		SA164	64 Kwords	A40000h-A4FFFFh
ľ	SA133	64 Kwords	850000h-85FFFFh		SA165	64 Kwords	A50000h-A5FFFFh
ľ	SA134	64 Kwords	860000h-86FFFFh		SA166	64 Kwords	A60000h-A6FFFFh
к 8	SA135	64 Kwords	870000h-87FFFFh	6	SA167	64 Kwords	A70000h–A7FFFFh
Bank 8	SA136	64 Kwords	880000h-88FFFFh	Bank 10	SA168	64 Kwords	A80000h-A8FFFFh
	SA137	64 Kwords	890000h-89FFFFh		SA169	64 Kwords	A90000h-A9FFFFh
ľ	SA138	64 Kwords	8A0000h-8AFFFFh		SA170	64 Kwords	AA0000h-AAFFFFh
ľ	SA139	64 Kwords	8B0000h-8BFFFFh		SA171	64 Kwords	AB0000h-ABFFFFh
ľ	SA140	64 Kwords	8C0000h-8CFFFFh		SA172	64 Kwords	AC0000h-ACFFFh
ľ	SA141	64 Kwords	8D0000h-8DFFFFh		SA173	64 Kwords	AD0000h-ADFFFFh
-	SA142	64 Kwords	8E0000h-8EFFFFh		SA174	64 Kwords	AE0000h-AEFFFFh
-	SA143	64 Kwords	8F0000h-8FFFFFh		SA175	64 Kwords	AF0000h-AFFFFh
	SA144	64 Kwords	900000h-90FFFFh		SA176	64 Kwords	B00000h-B0FFFFh
-	SA145	64 Kwords	910000h-91FFFFh		SA177	64 Kwords	B10000h-B1FFFFh
-	SA146	64 Kwords	920000h-92FFFFh		SA178	64 Kwords	B20000h-B2FFFFh
-	SA147	64 Kwords	930000h-93FFFFh		SA179	64 Kwords	B30000h-B3FFFFh
-	SA148	64 Kwords	940000h-94FFFFh		SA180	64 Kwords	B40000h-B4FFFFh
-	SA149	64 Kwords	950000h-95FFFFh		SA181	64 Kwords	B50000h-B5FFFFh
-	SA150	64 Kwords	960000h-96FFFFh	1	SA182	64 Kwords	B60000h-B6FFFFh
6 X 0	SA151	64 Kwords	970000h-97FFFFh	E	SA183	64 Kwords	B70000h-B7FFFFh
Bank 9	SA152	64 Kwords	980000h–98FFFFh	Bank 11	SA184	64 Kwords	B80000h-B8FFFFh
-	SA153	64 Kwords	990000h-99FFFFh		SA185	64 Kwords	B90000h-B9FFFFh
ŀ	SA154	64 Kwords	9A0000h-9AFFFh	1	SA186	64 Kwords	BA0000h-BAFFFFh
-	SA155	64 Kwords	9B0000h-9BFFFFh	1	SA187	64 Kwords	BB0000h-BBFFFFh
-	SA156	64 Kwords	9C0000h-9CFFFFh	1	SA188	64 Kwords	BC0000h-BCFFFFh
ŀ	SA157	64 Kwords	9D0000h-9DFFFFh	1	SA189	64 Kwords	BD0000h-BDFFFFh
ŀ	SA158	64 Kwords	9E0000h-9EFFFFh	1	SA190	64 Kwords	BE0000h-BEFFFFh
-	SA159	64 Kwords	9F0000h-9FFFFFh	<b> </b>	SA191	64 Kwords	BF0000h-BFFFFFh



Bank	Sector	Sector Size	Address Range	Bank	Se
	SA192	64 Kwords	C00000h-C0FFFFh		SA
	SA193	64 Kwords	C10000h-C1FFFFh	-	SA
	SA194	64 Kwords	C20000h-C2FFFFh	-	SA
	SA195	64 Kwords	C30000h-C3FFFFh	-	SA
	SA196	64 Kwords	C40000h-C4FFFFh	-	SA
	SA197	64 Kwords	C50000h-C5FFFFh	-	SA
	SA198	64 Kwords	C60000h-C6FFFFh	-	SA
Bank 12	SA199	64 Kwords	C70000h-C7FFFFh	Bank 14	SA
Ban	SA200	64 Kwords	C80000h-C8FFFFh	Ban	SA
	SA201	64 Kwords	C90000h-C9FFFFh		SA
	SA202	64 Kwords	CA0000h-CAFFFFh		SA
	SA203	64 Kwords	CB0000h-CBFFFFh		SA
	SA204	64 Kwords	CC0000h-CCFFFFh		SA
	SA205	64 Kwords	CD0000h-CDFFFFh	-	SA
	SA206	64 Kwords	CE0000h-CEFFFFh	-	SA
	SA207	64 Kwords	CF0000h-CFFFFFh		SA
	SA208	64 Kwords	D00000h-D0FFFFh		SA
	SA209	64 Kwords	D10000h-D1FFFFh		SA
	SA210	64 Kwords	D20000h-D2FFFFh		SA
	SA211	64 Kwords	D30000h-D3FFFFh		SA
	SA212	64 Kwords	D40000h-D4FFFFh		SA
	SA213	64 Kwords	64 KwordsD00000h–D0FFFFh64 KwordsD10000h–D1FFFFh64 KwordsD20000h–D2FFFFh64 KwordsD30000h–D3FFFFh64 KwordsD40000h–D4FFFFh64 KwordsD50000h–D5FFFFh		SA
	SA214	64 Kwords	D60000h-D6FFFFh		SA
Bank 13	SA215	64 Kwords	D70000h-D7FFFFh	-	SA
Ban	SA216	64 Kwords	D80000h-D8FFFFh	15	SA
	SA217	64 Kwords	D90000h-D9FFFFh	Bank 15	SA
	SA218	64 Kwords	DA0000h-DAFFFFh	ä	SA
	SA219	64 Kwords	DB0000h-DBFFFFh		SA
	SA220	64 Kwords	DC0000h-DCFFFFh		SA
	SA221	64 Kwords	DD0000h-DDFFFFh		SA
	SA222	64 Kwords	DE0000h-DEFFFFh		SA
	SA223	64 Kwords	DF0000h-DFFFFFh		SA
					SA

Table 5.2 S29NS256P Sector & Memory Address Map (Sheet 3 of 3)

Bank	Sector	Sector Size	Address Range				
	SA224	64 K words	E00000h-E0FFFh				
	SA225	64 K words	E10000h-E1FFFFh				
	SA226	64 K words	E20000h-E2FFFFh				
	SA227	64 K words	E30000h-E3FFFFh				
	SA228	64 K words	E40000h-E4FFFFh				
	SA229	64 K words	E50000h-E5FFFFh				
-	SA230	64 K words	E60000h-E6FFFFh				
Bank 14	SA231	64 K words	E70000h-E7FFFFh				
Ban	SA232	64 K words	E80000h-E8FFFFh				
	SA233	64 K words	E90000h-E9FFFFh				
	SA234	64 K words	EA0000h-EAFFFh				
	SA235	64 K words	EB0000h-EBFFFFh				
	SA236	64 K words	EC0000h-ECFFFh				
	SA237	64 K words	ED0000h-EDFFFh				
	SA238	64 K words	EE0000h-EEFFFFh				
	SA239	64 K words	EF0000h-EFFFFh				
	SA240	64 K words	F00000h-F0FFFFh				
	SA241	64 K words	F10000h-F1FFFFh				
	SA242	64 K words	F20000h-F2FFFFh				
	SA243	64 K words	F30000h-F3FFFFh				
	SA244	64 K words	F40000h-F4FFFFh				
	SA245	64 K words	F50000h-F5FFFFh				
	SA246	64 K words	F60000h-F6FFFFh				
	SA247	64 K words	F70000h-F7FFFFh				
15	SA248	64 K words	F80000h-F8FFFFh				
Bank 15	SA249	64 K words	F90000h-F9FFFFh				
μ.	SA250	64 K words	FA0000h-FAFFFFh				
	SA251	64 K words	FB0000h-FBFFFFh				
	SA252	64 K words	FC0000h-FCFFFh				
	SA253	64 K words	FD0000h-FDFFFFh				
	SA254	64 K words	FE0000h-FEFFFFh				
	SA255	16 K words	FF0000h-FF3FFFh				
	SA256	16 K words	FF4000h-FF7FFFh				
	SA257	16 K words	FF8000h-FFBFFFh				
	SA258	16 K words	FFC000h-FFFFFFh				



Bank	Sector	Sector Size	Address Range	Bank	Sector	Sector Size	Address Range
	SA0	64 Kwords	000000h-00FFFFh		SA32	64 Kwords	200000h-20FFFFh
	SA1	64 Kwords	010000h-01FFFFh		SA33	64 Kwords	210000h-21FFFFh
	SA2	64 Kwords	020000h-02FFFFh		SA34	64 Kwords	220000h-22FFFFh
Bank 0	SA3	64 Kwords	030000h-03FFFFh	Bank 4	SA35	64 Kwords	230000h-23FFFFh
Bar	SA4	64 Kwords	040000h-04FFFFh	Bar	SA36	64 Kwords	240000h-24FFFFh
-	SA5	64 Kwords	050000h-05FFFFh		SA37	64 Kwords	250000h-25FFFFh
	SA6	64 Kwords	060000h-06FFFFh		SA38	64 Kwords	260000h-26FFFFh
·	SA7	64 Kwords	070000h-07FFFFh		SA39	64 Kwords	270000h-27FFFFh
	SA8	64 Kwords	080000h-08FFFFh		SA40	64 Kwords	280000h-28FFFFh
	SA9	64 Kwords	090000h-09FFFFh		SA41	64 Kwords	290000h-29FFFFh
-	SA10	64 Kwords	0A0000h-0AFFFFh		SA42	64 Kwords	2A0000h-2AFFFFh
ž	SA11	64 Kwords	0B0000h-0BFFFFh	k 5	SA43	64 Kwords	2B0000h-2BFFFFh
Bank 1	SA12	64 Kwords	0C0000h-0CFFFFh	Bank 5	SA44	64 Kwords	2C0000h-2CFFFFh
-	SA13	64 Kwords	0D0000h-0DFFFFh		SA45	64 Kwords	2D0000h-2DFFFFh
ŀ	SA14	64 Kwords	0E0000h-0EFFFFh		SA46	64 Kwords	2E0000h-2EFFFFh
-	SA15	64 Kwords	0F0000h-0FFFFFh		SA47	64 Kwords	2F0000h-2FFFFh
	SA16	64 Kwords	100000h-10FFFFh		SA48	64 Kwords	300000h-30FFFFh
	SA17	64 Kwords	110000h-11FFFFh		SA49	64 Kwords	310000h-31FFFFh
	SA18	64 Kwords	120000h-12FFFFh		SA50	64 Kwords	320000h-32FFFFh
ç Ş	SA19	64 Kwords	130000h-13FFFFh	6	SA51	64 Kwords	330000h-33FFFFh
Bank 2	SA20	64 Kwords	140000h–14FFFFh	Bank 6	SA52	64 Kwords	340000h–34FFFFh
	SA21	64 Kwords	150000h-15FFFFh	1 "	SA53	64 Kwords	350000h–35FFFFh
-	SA22	64 Kwords	160000h-16FFFFh		SA54	64 Kwords	360000h–36FFFFh
-	SA23	64 Kwords	170000h–17FFFFh		SA55	64 Kwords	370000h–37FFFFh
	SA24	64 Kwords	180000h-18FFFFh		SA56	64 Kwords	380000h–38FFFFh
-	SA25	64 Kwords	190000h–19FFFFh		SA57	64 Kwords	390000h–39FFFFh
	SA26	64 Kwords	1A0000h–1AFFFFh		SA58	64 Kwords	3A0000h–3AFFFFh
e	SA27	64 Kwords	1B0000h-1BFFFFh	- <u></u>	SA59	64 Kwords	3B0000h–3BFFFFh
Bank 3	SA28	64 Kwords	1C0000h–1CFFFFh	Bank 7	SA60	64 Kwords	3C0000h-3CFFFFh
ш	SA29	64 Kwords	1D0000h-1DFFFFh		SA61	64 Kwords	3D0000h-3DFFFFh
-	SA30	64 Kwords	1E0000h-1EFFFFh		SA62	64 Kwords	3E0000h-3EFFFFh
-	SA31	64 Kwords	1F0000h-1FFFFFh		SA63	64 Kwords	3F0000h-3FFFFh
	SA64	64 Kwords	400000h-40FFFFh		SA96	64 K words	600000h-60FFFFh
-	SA65	64 Kwords	410000h-41FFFh		SA90 SA97	64 K words	610000h-61FFFh
-	SA65	64 Kwords	420000h-42FFFFh		SA97 SA98	64 K words	620000h-62FFFFh
œ	SA60 SA67	64 Kwords	430000h-43FFFFh	4	SA98 SA99	64 K words	630000h-63FFFFh
Bank 8	SA67 SA68	64 Kwords	440000h-44FFFFh	Bank 12	SA99 SA100	64 K words	640000h-64FFFFh
œ		-		ä			
-	SA69	64 Kwords	450000h-45FFFFh		SA101	64 K words	650000h-65FFFh
-	SA70	64 Kwords	460000h-46FFFFh		SA102	64 K words	660000h-66FFFFh
	SA71	64 Kwords	470000h-47FFFh	┨┣────┥	SA103	64 K words	670000h-67FFFh
ŀ	SA72	64 Kwords	480000h-48FFFFh	4	SA104	64 K words	680000h-68FFFFh
ŀ	SA73	64 Kwords	490000h-49FFFh	4	SA105	64 K words	690000h-69FFFFh
6	SA74	64 Kwords	4A0000h-4AFFFh	3	SA106	64 K words	6A0000h-6AFFFh
Bank 9	SA75	64 Kwords	4B0000h-4BFFFFh	Bank 13	SA107	64 K words	6B0000h-6BFFFFh
ä	SA76	64 Kwords	4C0000h-4CFFFFh	Ba	SA108	64 K words	6C0000h-6CFFFh
ļ	SA77	64 Kwords	4D0000h-4DFFFFh	4	SA109	64 K words	6D0000h-6DFFFh
ļ	SA78	64 Kwords	4E0000h-4EFFFFh		SA110	64 K words	6E0000h-6EFFFFh
	SA79	64 Kwords	4F0000h-4FFFFFh		SA111	64 K words	6F0000h-6FFFFh



Bank	Sector	Sector Size	Address Range	Ba
	SA80	64 Kwords	500000h-50FFFFh	
	SA81	64 Kwords	510000h-51FFFFh	
_	SA82	64 Kwords	520000h-52FFFFh	
k 10	SA83	64 Kwords	530000h-53FFFFh	Bank 14
Bank 10	SA84	64 Kwords	540000h-54FFFFh	Ban
	SA85	64 Kwords	550000h-55FFFFh	
	SA86	64 Kwords	560000h-56FFFFh	
	SA87	64 Kwords	570000h-57FFFFh	
	SA88	64 Kwords	580000h-58FFFFh	
	SA89	64 Kwords	590000h-59FFFFh	
	SA90	64 Kwords	5A0000h-5AFFFFh	
Bank 11	SA91	64 Kwords	5B0000h-5BFFFFh	
Ban	SA92	64 Kwords	5C0000h-5CFFFFh	u T
	SA93	64 Kwords	5D0000h-5DFFFFh	Bank 15
	SA94	64 Kwords	5E0000h-5EFFFFh	à
	SA95	64 Kwords	5F0000h-5FFFFFh	

Bank	Sector	Sector Size	Address Range		
24	SA112	64 K words	700000h-70FFFFh		
	SA113	64 K words	710000h-71FFFFh		
	SA114	64 K words	720000h-72FFFFh		
k 14	SA115	64 K words	730000h-73FFFFh		
Bank 14	SA116	64 K words	740000h-74FFFFh		
	SA117	64 K words	750000h-75FFFFh		
	SA118	64 K words	760000h-76FFFFh		
	SA119	64 K words	770000h-77FFFFh		
	SA120	64 K words	780000h-78FFFFh		
	SA121	64 K words	790000h-79FFFFh		
	SA122	64 K words	7A0000h-7AFFFFh		
	SA123	64 K words	7B0000h-7BFFFFh		
15	SA124	64 K words	7C0000h-7CFFFFh		
Bank 15	SA125	64 K words	7D0000h-7DFFFFh		
ä	SA126	64 K words	7E0000h-7EFFFFh		
	SA127	16 K words	7F0000h-7F3FFFh		
	SA128	16 K words	7F4000h-7F7FFFh		
	SA129	16 K words	7F8000h-7FBFFFh		
	SA130	16 K words	7FC000h-7FFFFFh		



### 6. Device Operations

This section describes the read, program, erase, simultaneous read/write operations, handshaking, and reset features of the Flash devices.

Operations are initiated by writing specific commands or a sequence with specific address and data patterns into the command registers (see Tables 11.1 and 11.2). The command register itself does not occupy any addressable memory location; rather, it is composed of latches that store the commands, along with the address and data information needed to execute the command. The contents of the register serve as input to the internal state machine and the state machine outputs dictate the function of the device. Writing incorrect address and data values or writing them in an improper sequence may place the device in an unknown state, in which case the system must write the reset command to return the device to the reading array data mode.

### 6.1 Device Operation Table

The device must be setup appropriately for each operation. Table 6.1 describes the required state of each control pin for any particular operation.

Operation	CE#	OE#	WE#	CLK	AVD#	Amax– A16	A/DQ15– A/DQ0	RDY	RESET#
Asynchronous Read – Addresses Latched	L	L	Н	х		Addr In	I/O	н	н
Asynchronous Write	L	н		х	_ <b>_</b>	Addr In	I/O	н	н
Standby (CE#)	Н	Х	Х	х	х	Х	HIGH Z	HIGH Z	Н
Hardware Reset	х	х	х	х	х	х	HIGH Z	HIGH Z	
Burst Read Operations									
Latch Starting Burst Address by CLK	L	Н	Н		L	Addr In	Addr In	х	н
Advance Burst read to next address	L	L	Н	_	н	х	I/O	н	н
Terminate current Burst read cycle	Н	Х	Н	х	х	Х	HIGH Z	HIGH Z	н
Terminate current Burst read cycle via RESET#	х	х	Н	х	х	х	HIGH Z	HIGH Z	L
Terminate current Burst read cycle and start new Burst read cycle	L	х	н			Addr In	Addr In	х	н

Table 0.1 Device Operations	Table 6	.1 Device	• Operations
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L = Logic 0, H = Logic 1, X = can be either  $V_{IL}$  or  $V_{IH}$ , = rising edge, = high to low, = toggle.

## Notes

1. Address is latched on the rising edge of clock.

2. CLK must stay low or high after CE# goes low when device in Asynchronous Read mode.

### 6.2 Asynchronous Read

All memories require access time to output array data. In an asynchronous read operation, data is read from one memory location at a time. Addresses are presented to the device in random order, and the propagation delay through the device causes the data on its outputs to arrive asynchronously with the address on its inputs.

To read data from the memory array, the system must first assert a valid address while driving AVD# and CE# to V<sub>IL</sub>. WE# must remain at V<sub>IH</sub>. The rising edge of AVD# latches the address. The OE# signal must be driven to V<sub>IL</sub>, once AVD# has been driven to V<sub>IH</sub>.

The data is output on A/DQ15 – A/DQ0 pins after the access time ( $t_{OE}$ ) has elapsed from the falling edge of OE#.



## 6.3 Synchronous (Burst) Read Operation

The device is capable of continuous sequential burst operation and linear burst operation of a preset length. When the device first powers up, it is enabled for Asynchronous read and can be automatically enabled for burst mode and the address is latched on the first rising edge of CLK input, while AVD# is held low for one clock cycle.

Prior to activating the clock signal, the system should determine how many wait states are desired for the initial word (t<sub>IACC</sub>) of each burst access, what mode of burst operation is desired and how the RDY signal transitions with valid data. The system would then write the configuration register command sequence.

At startup the system writes the *Set Configuration Register* command sequence to optimize the system performance.

The data is output  $t_{IACC}$  after the **rising edge** of the first CLK. Subsequent words are output  $t_{BACC}$  after the rising edge of each successive clock cycle, which automatically increments the internal address counter. Note that data is output only at the rising edge of the clock. RDY indicates the initial latency.

Note that the device has a fixed internal address boundary that occurs every 128 words. No boundary crossing latency is required when the device operates with wait states set from 2 to 9.

### 6.3.1 Latency Tables for Variable Wait State

Tables 6.2 - 6.9 show the latency for variable wait state in a normal Burst operation.

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	1 ws	D8
2		D2	D3	D4	D5	D6	D7	1 ws	1 ws	D8
3	9 ws	D3	D4	D5	D6	D7	1 ws	1 ws	1 ws	D8
4	9 WS	D4	D5	D6	D7	1 ws	1 ws	1 ws	1 ws	D8
5		D5	D6	D7	1 ws	D8				
6		D6	D7	1 ws	D8					
7		D7	1 ws	D8						

Table 6.2 Address Latency for 9 Wait States

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	1 ws	D8	D9
3	8 ws	D3	D4	D5	D6	D7	1 ws	1 ws	D8	D9
4	o ws	D4	D5	D6	D7	1 ws	1 ws	1 ws	D8	D9
5		D5	D6	D7	1 ws	1 ws	1 ws	1 ws	D8	D9
6		D6	D7	1 ws	D8	D9				
7		D7	1 ws	D8	D9					

 Table 6.3
 Address Latency for 8 Wait States

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3	7 ws	D3	D4	D5	D6	D7	1 ws	D8	D9	D10
4	7 WS	D4	D5	D6	D7	1 ws	1 ws	D8	D9	D10
5		D5	D6	D7	1 ws	1 ws	1 ws	D8	D9	D10
6		D6	D7	1 ws	1 ws	1 ws	1 ws	D8	D9	D10
7		D7	1 ws	D8	D9	D10				

#### Table 6.4 Address Latency for 7 Wait States

### Table 6.5 Address Latency for 6 Wait States

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3		D3	D4	D5	D6	D7	D8	D9	D10	D11
4	6 ws	D4	D5	D6	D7	1 ws	D8	D9	D10	D11
5		D5	D6	D7	1 ws	1 ws	D8	D9	D10	D11
6		D6	D7	1 ws	1 ws	1 ws	D8	D9	D10	D11
7		D7	1 ws	1 ws	1 ws	1 ws	D8	D9	D10	D11

### Table 6.6 Address Latency for 5 Wait States

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3	5 ws	D3	D4	D5	D6	D7	D8	D9	D10	D11
4	5 WS	D4	D5	D6	D7	D8	D9	D10	D11	D12
5		D5	D6	D7	1 ws	D8	D9	D10	D11	D12
6		D6	D7	1 ws	1 ws	D8	D9	D10	D11	D12
7		D7	1 ws	1 ws	1 ws	D8	D9	D10	D11	D12

 Table 6.7
 Address Latency for 4 Wait States

Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3	4 ws	D3	D4	D5	D6	D7	D8	D9	D10	D11
4	4 WS	D4	D5	D6	D7	D8	D9	D10	D11	D12
5		D5	D6	D7	D8	D9	D10	D11	D12	D13
6		D6	D7	1 ws	D8	D9	D10	D11	D12	D13
7		D7	1 ws	1 ws	D8	D9	D10	D11	D12	D13



Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3	- 3 ws	D3	D4	D5	D6	D7	D8	D9	D10	D11
4	5 WS	D4	D5	D6	D7	D8	D9	D10	D11	D12
5		D5	D6	D7	D8	D9	D10	D11	D12	D13
6		D6	D7	D8	D9	D10	D11	D12	D13	D14
7	1	D7	1 ws	D8	D9	D10	D11	D12	D13	D14

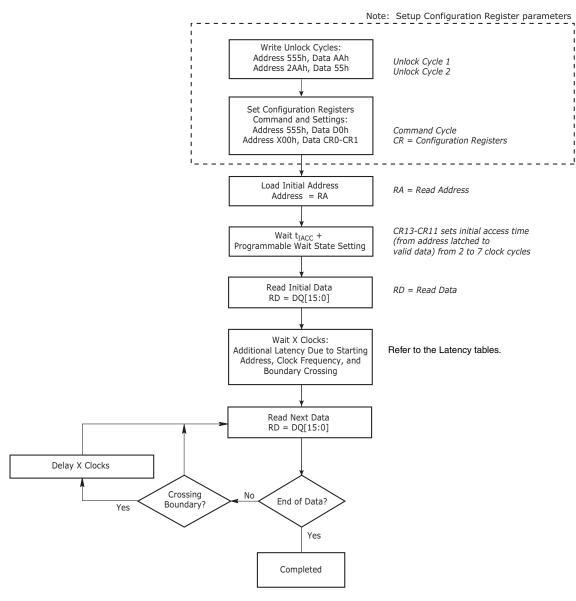
### Table 6.8 Address Latency for 3 Wait States

Table 6.9 Address Latency for 2 Wait Stat	es
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Word	Initial Wait									
0		D0	D1	D2	D3	D4	D5	D6	D7	D8
1		D1	D2	D3	D4	D5	D6	D7	D8	D9
2		D2	D3	D4	D5	D6	D7	D8	D9	D10
3	2 ws	D3	D4	D5	D6	D7	D8	D9	D10	D11
4	2 w5	D4	D5	D6	D7	D8	D9	D10	D11	D12
5		D5	D6	D7	D8	D9	D10	D11	D12	D13
6		D6	D7	D8	D9	D10	D11	D12	D13	D14
7		D7	D8	D9	D10	D11	D12	D13	D14	D15



#### Figure 6.1 Synchronous Read Flow Chart



### 6.3.2 Continuous Burst Read Mode

In the continuous burst read mode, the device outputs sequential burst data from the starting address given and then wraps around to address 00000h when it reaches the highest addressable memory location. The burst read mode continues until the system drives CE# high, or RESET=  $V_{IL}$ . Continuous burst mode can also be aborted by asserting AVD# low and providing a new address to the device.

If the address being read crosses a 128-word line boundary within the same bank, but not into a program or erase suspended sector, as mentioned above, additional latency cycles are required as reflected by the configuration register table (Table 6.11) and Tables 6.2 - 6.9.

If the address crosses a bank boundary while the subsequent bank is programming or erasing, the device provides read status information and the clock is ignored. Upon completion of status read or program or erase operation, the host can restart a burst read operation using a new address and AVD# pulse.



### 6.3.3 8-Word, 16-Word, and 32-Word Linear Burst Read with Wrap Around

In a linear burst read operation, a fixed number of words (8, 16, or 32 words) are read from consecutive addresses that are determined by the group within which the starting address falls. The groups are sized according to the number of words read in a single burst sequence for a given mode (see Table 6.10).

For example, if the starting address in the 8-word mode is 3Ch, the address range to be read is 38-3Fh, and the burst sequence is 3C-3D-3E-3F-38-39-3A-3Bh. Thus, the device outputs all words in that burst address group until all word are read, regardless of where the starting address occurs in the address group, and then terminates the burst read.

In a similar fashion, the 16-word and 32-word Linear Wrap modes begin their burst sequence on the starting address provided to the device, then wrap back to the first address in the selected address group.

Note that in this mode the address pointer does not cross the boundary that occurs every 128 words; thus, no additional wait states are inserted due to boundary crossing.

Mode	Group Size	Group Address Ranges
8-word	8 words	0 – 7h, 8 – Fh, 10 – 17h,
16-word	16 words	0 – Fh, 10 – 1Fh, 20 – 2Fh,
32-word	32 words	00 – 1Fh, 20 – 3Fh, 40 – 5Fh,

#### Table 6.10 Burst Address Groups

### 6.3.4 8-Word, 16-Word, and 32-Word Linear Burst without Wrap Around

If wrap around is not enabled for linear burst read operations, the 8-word, 16-word, or 32-word burst executes up to the maximum memory address of the selected number of words. The burst stops after 8, 16, or 32 addresses and does not wrap around to the first address of the selected group.

For example, if the starting address in the 8-word mode is 3Ch, the address range to be read is 3C-43h, and the burst sequence is 3C-3D-3E-3F-40-41-42-43h if wrap around is not enabled. The next address to be read requires a new address and AVD# pulse. Note that in this burst read mode, the address pointer may cross the boundary that occurs every 128 words, which incurs the additional boundary crossing wait state.

### 6.3.5 Configuration Registers

This device uses two 16-bit configuration registers to set various operational parameters. Upon power-up or hardware reset, the device is capable of the asynchronous read mode and synchronous read, and the configuration register settings are in their default state. The host system should determine the proper settings for the entire configuration register, and then execute the Set Configuration Register command sequence before attempting burst operations. The Configuration Register can also be read using a command sequence (see Table 11.1). The following list describes the register settings.

CR Bit	Function	Settings (Binary)
CR0.15	Reserved (Not used)	0 = Reserved (Default) 1 = Reserved
CR0.14	Reserved (Not used)	0 = Reserved (Default) 1 = Reserved

#### Table 6.11 Configuration Register



Table 6.11	Configuration	Register
------------	---------------	----------

CR Bit	Function			S	ettings (Binar	ry)		
CR1.0		0000			2nd			
CHI.U		0001			3rd			
CR0.13		0010	_	initial data is valid on the	4th	rising	AVD# transition	
CH0.13		0011	=		5th	CLK edge	to V <sub>IH</sub>	
CR0.12		0100			6th			
CH0.12		0101			7th			
	Programmable	0110	_		D	eserved		
	Wait State (Note 1)	0111	_			eserved		
		1000	_	initial data is	8th	rising	AVD# transition	
		1001	=	valid on the	9th	CLK edge	to V <sub>IH</sub>	
CR0.11		:						
		1101	=	initial data is valid on the	13th	rising CLK edge	AVD# transition to V <sub>IH</sub> (Default)	
		1110	_		D	accruced		
		1111	1111 = Reserved					
CR0.10	RDY Polarity		0 = RDY signal is active low 1 = RDY signal is active high (Default)					
CR0.9	Reserved (Not used)	0 = Reserve 1 = Reserve		fault)				
CR0.8	RDY			e clock cycle before data th data (Default)				
CR0.7	Reserved (Not used)	0 = Reserve 1 = Reserve		fault)				
CR0.6	Reserved (Not used)	0 = Reserve 1 = Reserve		fault)				
CR0.5	Reserved (Not used)	0 = Reserve 1 = Reserve		fault)				
CR1.4	Output Drive Strength	0 = Full Dri 1 = Half Dri		urrent Driver Strength (Defa	ault)			
CR0.4	RDY Function	0 = RDY (D 1 = Reserve						
CR0.3	Burst Wrap Around	0 = No Wra 1 = Wrap A	•	ınd Burst Burst (Default)				
CR0.2		000 = Cont	inuous	(Default)				
0HU.2	_	010 = 8-Wc	ord Lin	ear Burst				
CR0.1	Burst Length	011 = 16-W	/ord Li	near Burst				
CR0.0	_0g	100 = 32-W	/ord Li	near Burst				
		(All other bi	t settir	igs are reserved)				

Notes

1. The addresses are latched by rising edge of CLK.

2. CR1.0 to CR1.3 and CR1.5 to CR1.15 = 1 (Default).

3. A software reset command is required after read command.

4. CR0.3 is ignored if in continuous read mode (no wrap around).

### 6.4 Autoselect

The Autoselect is used for manufacturer ID, Device identification, and sector protection information. This mode is primarily intended for programming equipment to automatically match a device with its corresponding programming algorithm. The Autoselect codes can also be accessed in the system. When verifying sector protection, the sector address must appear on the appropriate highest order address bits (see Table 6.12). The remaining address bits are don't care. The most significant four bits of the address during the third write cycle select the bank from which the Autoselect codes are read by the host. All other banks can be accessed normally for data read without exiting the Autoselect mode.



- To access the Autoselect codes, the host system must issue the Autoselect command.
- The Autoselect command sequence may be written to an address within a bank that is either in the read or erase-suspend-read mode.
- The Autoselect command may not be written while the device is actively programming or erasing. Autoselect does not support simultaneous operations or burst mode.
- The system must write the reset command to return to the read mode (or erase-suspend-read mode if the bank was previously in Erase Suspend).

See Table 11.1 for command sequence details.

Description	Address	Read Data	
Manufacturer ID Byte 00	(BA) + 00h	0001h	
Device ID, Byte 01	(BA) + 01h	307Eh(NS512P) 317Eh(NS256P) 327Eh(NS128P)	
Sector Lock/Unlock Byte 02	(SA) + 02h	0001h = Locked, 0000h = Unlocked	
Indicator Bits Byte 07	(BA) + 07h	DQ15 – DQ8 = reserved DQ7 – Factory Lock Bit; 1 = Locked, 0 = Not Locked DQ6 – Customer Lock Bit; 1 = Locked, 0 = Not Locked DQ5 – Handshake Bit; 1 = Reserved, 0 = Standard Handshake DQ4 and DQ3 – WP# Protection Boot Code; 01 = WP# Protects Top Boot Sectors, DQ2 – DQ0 = reserved	
Device ID, Byte 0E	(BA) + 0Eh	303Fh (NS512P) 3141h (NS256P) 3243h (NS128P)	
Device ID, Byte 0F	(BA) + 0Fh	3000h (NS512P) 3100h (NS256P) 3200h (NS128P)	

#### Table 6.12 Autoselect Addresses

#### Software Functions and Sample Code

#### Table 6.13 Autoselect Entry

(LLD Function = IId\_AutoselectEntryCmd)

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	BA+AAAh	BA+555h	0x00AAh
Unlock Cycle 2	Write	BA+555h	BA+2AAh	0x0055h
Autoselect Command	Write	BA+AAAh	BA+555h	0x0090h

#### Table 6.14 Autoselect Exit

(LLD Function = Ild\_AutoselectExitCmd)

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	base + xxxxh	base + xxxxh	0x00F0h

Notes

1. Any offset within the device works.

2. BA = Bank Address. The bank address is required.

3. base = base address.

The following is a C source code example of using the autoselect function to read the manufacturer ID. Refer to the *Spansion Low Level Driver User's Guide* (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.



```
/* Here is an example of Autoselect mode (getting manufacturer ID) */
/* Define UINT16 example: typedef unsigned short UINT16; */
UINT16 manuf_id;
/* Auto Select Entry */
*( (UINT16 *)bank_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
*( (UINT16 *)bank_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *)bank_addr + 0x555 ) = 0x0090; /* write autoselect command */
/* multiple reads can be performed after entry */
manuf_id = *( (UINT16 *)bank_addr + 0x000 ); /* read manuf. id */
/* Autoselect exit */
*( (UINT16 *)base_addr + 0x000 ) = 0x00F0; /* exit autoselect (write reset command) */
```

### 6.5 Program/Erase Operations

These devices are capable of several modes of programming and or erase operations which are described in detail in the following sections. However, prior to any programming and or erase operation, devices can be setup appropriately as outlined in the configuration register (Table 6.11).

For any program and or erase operations, including writing command sequences, the system must drive AVD# and CE# to  $V_{IL}$ , and OE# to  $V_{IH}$  when providing an address to the device, and drive WE# and CE# to  $V_{IL}$ , and OE# to  $V_{IH}$  when writing commands or programming data.

All addresses are latched on the rising edge of AVD# or falling edge of WE#, and all data is latched on the first rising edge of WE#.

#### Note the following:

- When the Embedded Program/Erase algorithm is complete, the device returns to the read mode.
- The system can determine the status of the Program/Erase operation. Refer to the Write Operation Status section for further information.
- While 1 can be programmed to 0, a 0 cannot be programmed to a 1. Any such attempt is ignored as only an erase operation can covert a 0 to a 1.
- Any commands written to the device during the Embedded Program/Erase Algorithm are ignored except the Program/Erase Suspend command.
- Secured Silicon Sector, Autoselect, and CFI functions are unavailable when a program operation is in progress.
- A hardware reset or power removal immediately terminates the Program/Erase operation and the Program/ Erase command sequence should be reinitiated once the device has returned to the read mode, to ensure data integrity.
- Programming is allowed in any sequence and across sector boundaries only for single word programming operation. See Write Buffer Programming when using the write buffer.

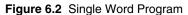
Note: The system may also lock or unlock any sector while the erase operation is suspended.

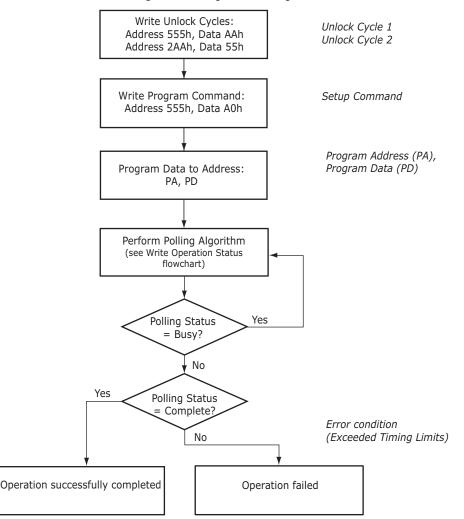
### 6.5.1 Single Word Programming

Single word programming mode is the simplest method of programming. In this mode, four Flash command write cycles are used to program an individual Flash address. While the single word programming method is supported by all Spansion devices, in general it is not recommended for devices that support Write Buffer Programming. See Table 11.1 for the required bus cycles and Figure 6.2 for the flowchart.



When the Embedded Program algorithm is complete, the device then returns to the read mode and addresses are no longer latched. The system can determine the status of the program operation by using DQ7 or DQ6. Refer to the Write Operation Status section for information on these status bits.





### Software Functions and Sample Code

Table 6.15 Single Word Program (LLD Function = Ild\_ProgramCmd)

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	Base + AAAh	Base + 555h	00AAh
Unlock Cycle 2	Write	Base + 554h	Base + 2AAh	0055h
Program Setup	Write	Base + AAAh	Base + 555h	00A0h
Program	Write	Word Address	Word Address	Data Word

Note

Base = Base Address.

The following is a C source code example of using the single word program function. Refer to the *Spansion Low Level Driver User's Guide* (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.



/* Example: Program Command */			
*( (UINT16 *)base_addr + 0x555 )	= 0x00AA;	/* write unlock cycle 1	*/
*( (UINT16 *)base_addr + 0x2AA )	= 0x0055;	/* write unlock cycle 2	*/
*( (UINT16 *)base_addr + 0x555 )	= 0x00A0;	/* write program setup command	*/
*( (UINT16 *)pa )	= data;	/* write data to be programmed	*/
/* Poll for program completion */			

### 6.5.2 Write Buffer Programming

Write Buffer Programming allows the system to write a maximum of 32 words in one programming operation. This results in a faster effective word programming time than the standard *word* programming algorithms. The Write Buffer Programming command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the Write Buffer Load command written at the Sector Address in which programming occurs. At this point, the system writes the number of *word locations minus 1* that is loaded into the page buffer at the Sector Address in which programming occurs. This tells the device how many write buffer addresses will be loaded with data and therefore when to expect the *Program Buffer to Flash* confirm command. The number of locations to program cannot exceed the size of the write buffer or the operation aborts. (Note: the size of the write buffer is dependent upon which data are being loaded. Also note that the number loaded = the number of locations to program minus 1. For example, if the system programs 6 address locations, then 05h should be written to the device.)

The system then writes the starting address/data combination. This starting address is the first address/data pair to be programmed, and selects the *write-buffer-page* address. All subsequent address/data pairs must be in sequential order.

The *write-buffer* addresses must be in the same sector for all address/data pairs loaded into the write buffer. It is to be noted that Write Buffer Programming cannot be performed across multiple sectors. If the system attempts to load programming data outside of the selected *write-buffer* addresses, the operation aborts after the Write to Buffer command is executed. Also, the starting address must be the least significant address and must be incremental and that the write buffer data cannot be in different sectors.

After writing the Starting Address/Data pair, the system then writes the remaining address/data pairs into the write buffer. Write buffer locations must be loaded in sequential order starting with the lowest address in the page. Note that if the number of address/data pairs do not match the word count, the program buffer to flash command is ignored.

Note that if a Write Buffer address location is loaded multiple times, the *address/data pair* counter decrements for every data load operation. Also, the last data loaded at a location before the *Program Buffer to Flash* confirm command is programmed into the device. It is the software's responsibility to comprehend ramifications of loading a write-buffer location more than once. The counter decrements for each data load operation, NOT for each unique write-buffer-address location.

Once the specified number of write buffer locations have been loaded, the system must then write the *Program Buffer to Flash* command at the Sector Address. Any other address/data write combinations abort the Write Buffer Programming operation. The device then *goes busy*. The Data Bar polling techniques should be used while monitoring the last address location loaded into the write buffer. This eliminates the need to store an address in memory because the system can load the last address location, issue the program confirm command at the last loaded address location, and then data bar poll at that same address. DQ7, DQ6, DQ5, DQ2, and DQ1 should be monitored to determine the device status during Write Buffer Programming.

The write-buffer *embedded* programming operation can be suspended using the standard suspend/resume commands. Upon successful completion of the Write Buffer Programming operation, the device returns to READ mode.

The Write Buffer Programming Sequence is ABORTED in the following ways:

- Load a value that is greater than the buffer size during the Number of Locations to Program step (DQ7 is not valid in this condition).
- Write to an address in a sector different than the one specified during the Write-Buffer-Load command.
- Write an Address/Data pair to a different write-buffer-page than the one selected by the Starting Address during the write buffer data loading stage of the operation.
- Write data other than the Confirm Command after the specified number of data load cycles.



### Software Functions and Sample Code

#### Table 6.16 Write Buffer Program

(LLD Functions Used = IId\_WriteToBufferCmd, IId\_ProgramBufferToFlashCmd)

Cycle	Description	Operation	Byte Address	Word Address	Data				
1	Unlock	Write	Base + AAAh Base + 555h		00AAh				
2	Unlock	Write	Base + 554h Base + 2AAh		0055h				
3	Write Buffer Load Command	Write	Program Address		0025h				
4	Write Word Count	Write	Program Address		Word Count (N–1)h				
	Number of words (N) loaded into the write buffer can be from 1 to 32 words.								
5 to 36	Load Buffer Word N	Write	Program Add	Program Address, Word N					
Last	Write Buffer to Flash	Write	Sector Address		0029h				

Notes

1. Base = Base Address.

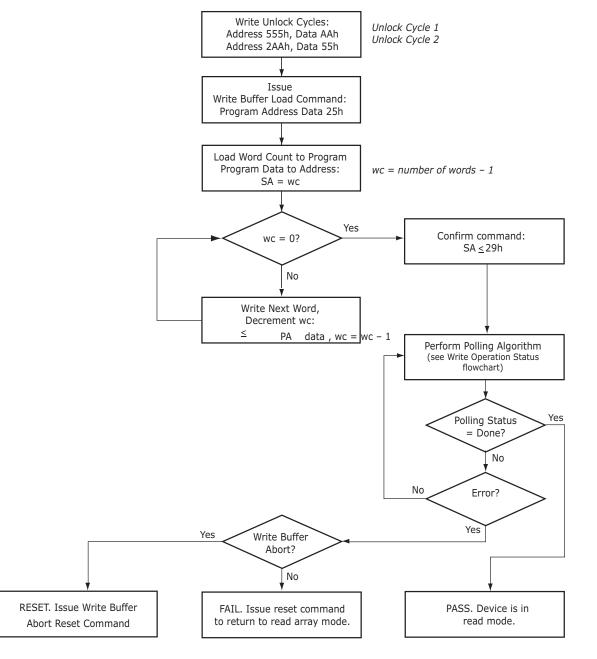
 Last = Last cycle of write buffer program operation; depending on number of words written, the total number of cycles may be from 6 to 37.

3. For maximum efficiency, it is recommended that the write buffer be loaded with the highest number of words (N words) possible. The following is a C source code example of using the write buffer program function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory

software development guidelines.

```
/* Example: Write Buffer Programming Command */
/* NOTES: Write buffer programming limited to 16 words. */
/* All addresses to be written to the flash in */
/* one operation must be within the same write buffer. */
/* A write buffer begins at addresses evenly divisible */
/* by 0x20.
UINT16 i; */
UINT16 *src = source_of_data; /* address of source data */
UINT16 *dst = destination_of_data; /* flash destination address */
UINT16 wc = words_to_program -1; /* word count (minus 1) */
*( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
*( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *)dst ) = 0x0025; /* write write buffer load command */
*( (UINT16 *)dst ) = wc; /* write word count (minus 1) */
for (i=0;i<=wc;i++)</pre>
{
*dst++ = *src++; /* ALL dst MUST BE in same Write Buffer */
}
*( (UINT16 *)sector_address ) = 0x0029; /* write confirm command */
/* poll for completion */
/* Example: Write Buffer Abort Reset */
*( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
*( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *)base_addr + 0x555 ) = 0x00F0; /* write buffer abort reset */
```



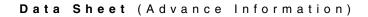


#### Figure 6.3 Write Buffer Programming Operation

### 6.5.3 Sector Erase

The sector erase function erases one or more sectors in the memory array. (See Table 11.1 and Figure 6.4.) The device does not require the system to preprogram prior to erase. The Embedded Erase algorithm automatically programs and verifies the entire memory for an all zero data pattern prior to electrical erase. After a successful sector erase, all locations within the erased sector contain FFFFh. The system is not required to provide any controls or timings during these operations.

After the command sequence is written, a sector erase time-out of no less than  $t_{SEA}$  occurs. During the time-out period, additional sector addresses and sector erase commands may be written. Loading the sector erase buffer may be done in any sequence, and the number of sectors may be from one sector to all sectors. The time between these additional cycles must be less than  $t_{SEA}$ . Any sector erase address and command following the exceeded time-out ( $t_{SEA}$ ) may or may not be accepted. Any command other than Sector Erase or Erase Suspend during the time-out period resets that bank to the read mode. The system can monitor DQ3





to determine if the sector erase timer has timed out (See the section, *DQ3: Sector Erase Timeout State Indicator.*) The time-out begins from the rising edge of the final WE# pulse in the command sequence.

When the Embedded Erase algorithm is complete, the bank returns to reading array data and addresses are no longer latched. Note that while the Embedded Erase operation is in progress, the system can read data from the non-erasing banks. The system can determine the status of the erase operation by reading DQ7 or DQ6/DQ2 in the erasing bank. Refer to *Write Operation Status* for information on these status bits.

Once the sector erase operation has begun, only the Erase Suspend command is valid. All other commands are ignored. However, note that a hardware reset immediately terminates the erase operation. If that occurs, the sector erase command sequence should be reinitiated once that bank has returned to reading array data, to ensure data integrity.

Figure 6.4 illustrates the algorithm for the erase operation. Refer to *Program/Erase Operations* for parameters and timing diagrams.

### Software Functions and Sample Code

/

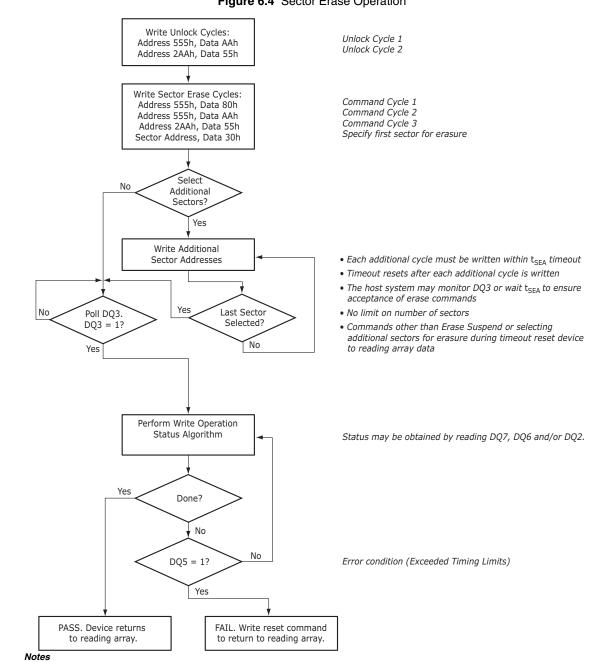
Cycle	Description	Operation	Byte Address	Word Address	Data				
1	1 Unlock		Base + AAAh	Base + 555h	00AAh				
2	Unlock	Write	Base + 554h	Base + 2AAh	0055h				
3 Setup Command		Write	Base + AAAh	Base + 555h	0080h				
4	Unlock	Write	Base + AAAh	Base + 555h	00AAh				
5	Unlock	Write	Base + 554h	Base + 2AAh	0055h				
6	Sector Erase Command	Write	Sector Address	Sector Address	0030h				
	Unlimited additional sectors may be selected for erase; command(s) must be written within t <sub>SEA</sub> .								

Table 6.17Sector Erase(LLD Function = IId\_SectorEraseCmd)

The following is a C source code example of using the sector erase function. Refer to the *Spansion Low Level Driver User's Guide* (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.

/* E>	kample: S	Sector Erase	Command *	/						
* (	(UINT16	*)base_addr	+ 0x555 )	=	0x00AA;	/*	write	unlock cycle 1	*/	
* (	(UINT16	*)base_addr	+ 0x2AA )	=	0x0055;	/*	write	unlock cycle 2	*/	
* (	(UINT16	*)base_addr	+ 0x555 )	=	0x0080;	/*	write	setup command	*/	
* (	(UINT16	*)base_addr	+ 0x555 )	=	0x00AA;	/*	write	additional unlock cycle 1	*/	
* (	(UINT16	*)base_addr	+ 0x2AA )	=	0x0055;	/*	write	additional unlock cycle 2	*/	
* (	(UINT16	*)sector_add	lress )	=	0x0030;	/*	write	sector erase command	*/	





#### Figure 6.4 Sector Erase Operation

1. See Table 11.1 for erase command sequence.

2. See DQ3: Sector Erase Timeout State Indicator for information on the sector erase timeout.

#### 6.5.4 Chip Erase Command Sequence

Chip erase is a six-bus cycle operation as indicated by Table 11.1. These commands invoke the Embedded Erase algorithm, which does not require the system to preprogram prior to erase. The Embedded Erase algorithm automatically preprograms and verifies the entire memory for an all zero data pattern prior to electrical erase. After a successful chip erase, all locations of the chip contain FFFFh. The system is not required to provide any controls or timings during these operations. Table 11.1 shows the address and data requirements for the chip erase command sequence.

When the Embedded Erase algorithm is complete, that bank returns to the read mode and addresses are no longer latched. The system can determine the status of the erase operation by using DQ7 or DQ6/DQ2. Refer to the Write Operation Status section for information on these status bits.



Any commands written during the chip erase operation are ignored. However, note that a hardware reset immediately terminates the erase operation. If that occurs, the chip erase command sequence should be reinitiated once that bank has returned to reading array data, to ensure data integrity.

#### Software Functions and Sample Code

# Table 6.18 Chip Erase (LLD Function = IId\_ChipEraseCmd)

Cycle	Description	Operation	Byte Address	Word Address	Data
1	Unlock	Write	Base + AAAh	Base + 555h	00AAh
2	Unlock	Write	Base + 554h	Base + 2AAh	0055h
3	Setup Command	Write	Base + AAAh	Base + 555h	0080h
4	Unlock	Write	Base + AAAh	Base + 555h	00AAh
5	Unlock	Write	Base + 554h	Base + 2AAh	0055h
6	Chip Erase Command	Write	Base + AAAh	Base + 555h	0010h

The following is a C source code example of using the chip erase function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.comm) for general information on Spansion Flash memory software development guidelines.

/\* Example: Chip Erase Command \*/

/* No	te: Canr	not be suspend	.ed */			
* (	(UINT16	*)base_addr +	0x555) =	0x00AA;	/* write unlock cycle 1	*/
* (	(UINT16	*)base_addr +	0x2AA ) =	0x0055;	/* write unlock cycle 2	*/
* (	(UINT16	*)base_addr +	0x555) =	0x0080;	/* write setup command	*/
* (	(UINT16	*)base_addr +	0x555) =	0x00AA;	/* write additional unlock cycle 1 $$	*/
* (	(UINT16	*)base_addr +	0x2AA ) =	0x0055;	$/^{\star}$ write additional unlock cycle 2	*/
* (	(UINT16	*)base_addr +	$0 \times 000 $ ) =	0x0010;	/* write chip erase command	*/

### 6.5.5 Erase Suspend/Erase Resume Commands

When the Erase Suspend command is written during the sector erase time-out, the device immediately terminates the time-out period and suspends the erase operation. The Erase Suspend command allows the system to interrupt a sector erase operation and then read data from, or program data to, any sector not selected for erasure. The bank address is required when writing this command. This command is valid only during the sector erase operation, including the minimum t<sub>SEA</sub> time-out period during the sector erase command sequence. The Erase Suspend command is ignored if written during the chip erase operation.

When the Erase Suspend command is written after the  $t_{SEA}$  time-out period has expired and during the sector erase operation, the device requires a maximum of  $t_{ESL}$  (erase suspend latency) to suspend the erase operation.

After the erase operation has been suspended, the bank enters the erase-suspend-read mode. The system can read data from or program data to any sector not selected for erasure. (The device *erase suspends* all sectors selected for erasure.) Reading at any address within erase-suspended sectors produces status information on DQ7-DQ0. The system can use DQ7, or DQ6, and DQ2 together, to determine if a sector is actively erasing or is erase-suspended. Refer to Table 6.27 for information on these status bits.

After an erase-suspended program operation is complete, the bank returns to the erase-suspend-read mode. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation.

In the erase-suspend-read mode, the system can also issue the Autoselect command sequence. Refer to the *Write Buffer Programming* section and the *Autoselect* section for details.

To resume the sector erase operation, the system must write the Erase Resume command. The bank address of the erase-suspended bank is required when writing this command. Further writes of the Resume command are ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

**Note:** While an erase operation can be suspended and resumed multiple times, a minimum delay of t<sub>ERS</sub> (Erase Resume to Suspend) is required from resume to the next suspend.



#### Software Functions and Sample Code

#### Table 6.19 Erase Suspend

(LLD Function = Ild\_EraseSuspendCmd)

Cycle	Operation	Byte Address	Word Address	Data	
1	Write	Bank Address	Bank Address	00B0h	

The following is a C source code example of using the erase suspend function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

/\* Example: Erase suspend command \*/
 \*( (UINT16 \*)bank\_addr + 0x000 ) = 0x00B0; /\* write suspend command \*/

#### Table 6.20 Erase Resume

(LLD Function = IId\_EraseResumeCmd)

Cycle	Operation	Byte Address	Word Address	Data
1	Write	Bank Address	Bank Address	0030h

The following is a C source code example of using the erase resume function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

/\* Example: Erase resume command \*/

\*( (UINT16 \*)bank\_addr + 0x000 ) = 0x0030; /\* write resume command \*/

/\* The flash needs adequate time in the resume state \*/

### 6.5.6 Program Suspend/Program Resume Commands

The Program Suspend command allows the system to interrupt an embedded programming operation or a *Write to Buffer* programming operation so that data can read from any non-suspended sector. When the Program Suspend command is written during a programming process, the device halts the programming operation within t<sub>PSL</sub> (program suspend latency) and updates the status bits. Addresses are *don't-cares* when writing the Program Suspend command.

After the programming operation has been suspended, the system can read array data from any nonsuspended sector. The Program Suspend command may also be issued during a programming operation while an erase is suspended. In this case, data may be read from any addresses not in Erase Suspend or Program Suspend. If a read is needed from the Secured Silicon Sector area, then user must use the proper command sequences to enter and exit this region.

The system may also write the Autoselect command sequence when the device is in Program Suspend mode. The device allows reading Autoselect codes in the suspended sectors, since the codes are not stored in the memory array. When the device exits the Autoselect mode, the device reverts to Program Suspend mode, and is ready for another valid operation. See the *Autoselect* section for more information.

After the Program Resume command is written, the device reverts to programming. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See the *Write Operation Status* section for more information.

The system must write the Program Resume command (address bits are *don't care*) to exit the Program Suspend mode and continue the programming operation. Further writes of the Program Resume command are ignored. Another Program Suspend command can be written after the device has resumed programming.

**Note:** While a program operation can be suspended and resumed multiple times, a minimum delay of t<sub>PRS</sub> (Program Resume to Suspend) is required from resume to the next suspend.

### Software Functions and Sample Code

 Table 6.21
 Program Suspend

 (LLD Function = IId\_ProgramSuspendCmd)

ſ	Cycle	Operation	Byte Address	Word Address	Data
ſ	1	Write	Bank Address	Bank Address	00B0h



The following is a C source code example of using the program suspend function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Program suspend command */
 *( (UINT16 *)base_addr + 0x000 ) = 0x00B0; /* write suspend command */
```

### Table 6.22 Program Resume

(LLD Function = IId\_ProgramResumeCmd)

ĺ	Cycle	Operation	Byte Address	Word Address	Data	
	1	Write	Bank Address	Bank Address	0030h	

The following is a C source code example of using the program resume function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Program resume command */
 *( (UINT16 *)base_addr + 0x000 ) = 0x0030; /* write resume command */
```

### 6.5.7 Accelerated Program/Sector Erase

Accelerated single word programming, write buffer programming and sector erase, operations are enabled through the  $V_{PP}$  function. This method is faster than the standard chip program and erase command sequences.

The accelerated chip program and erase functions must not be used more than 100 times per sector. In addition, accelerated chip program and erase should be performed at room temperature  $(30^{\circ}C \pm 10^{\circ}C)$ .

If the system asserts  $V_{HH}$  on this input, the device automatically enters the accelerated mode and uses the higher voltage on the input to reduce the time required for program and erase operations. The system can then use the Write Buffer Load command sequence provided by the Unlock Bypass mode. Note that if a *Write-to-Buffer-Abort Reset* is required while in Unlock Bypass mode, the full 3-cycle RESET command sequence must be used to reset the device. Removing  $V_{HH}$  from the  $V_{PP}$  input, upon completion of the embedded program or erase operation, returns the device to normal operation.

- Sectors must be unlocked prior to raising V<sub>PP</sub> to V<sub>HH</sub>.
- The V<sub>PP</sub> pin must not be at V<sub>HH</sub> for operations other than accelerated programming and accelerated sector erase, or device damage may result.
- The V<sub>PP</sub> pin must not be left floating or unconnected; inconsistent behavior of the device may result.
- V<sub>PP</sub> locks all sector if set to V<sub>IL</sub>; V<sub>PP</sub> should be set to V<sub>IH</sub> for all other conditions.

### 6.5.8 Unlock Bypass

The unlock bypass feature allows the system to primarily program to a bank faster than using the standard program command sequence. The unlock bypass command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the unlock bypass command, 20h. The device then enters the unlock bypass mode. A two-cycle unlock bypass program command sequence is all that is required to program in this mode. The first cycle in this sequence contains the unlock bypass program command, A0h; the second cycle contains the program address and data. Additional data is programmed in the same manner. This mode dispenses with the initial two unlock cycles required in the standard program command sequence, resulting in faster total programming time. The host system may also initiate the chip erase and sector erase sequences in the unlock bypass mode. The erase command sequences are four cycles in length instead of six cycles. Table 11.1 shows the requirements for the unlock bypass command sequences.

During the unlock bypass mode, only the Read, Unlock Bypass Program, Unlock Bypass Sector Erase, Unlock Bypass Chip Erase, and Unlock Bypass Reset commands are valid. To exit the unlock bypass mode, the system must issue the two-cycle unlock bypass reset command sequence. The first cycle must contain



the bank address and the data 90h. The second cycle need only contain the data 00h. The bank then returns to the read mode.

The device offers accelerated program operations through the V<sub>PP</sub> input. When the system asserts V<sub>HH</sub> on this input, the device automatically enters the Unlock Bypass mode. The system may then write the two-cycle Unlock Bypass program command sequence. The device uses the higher voltage on the V<sub>PP</sub> input to accelerate the operation.

Refer to the Erase/Program Timing section for parameters, and Figures 10.12 and 10.13 for timing diagrams

### Software Functions and Sample Code

The following are C source code examples of using the unlock bypass entry, program, and exit functions. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

Table 6.23	Unlock Bypass Entry
(LLD Function =	<pre>IId_UnlockBypassEntryCmd)</pre>

Cycle	Description	Operation	Byte Address	Word Address	Data
1	Unlock	Write	Base + AAAh	Base + 555h	00AAh
2	Unlock	Write	Base + 554h	Base + 2AAh	0055h
3	Entry Command	Write	Base + AAAh	Base + 555h	0020h

/\* Example: Unlock Bypass Entry Command \*/

Endanpie: Onitoen Dypapp Enery conduct	110a /		
*( (UINT16 *)bank_addr + 0x555 ) =	0x00AA; /* write unlock	cycle 1	*/
*( (UINT16 *)bank_addr + 0x2AA ) =	0x0055; /* write unlock	cycle 2	*/
*( (UINT16 *)bank_addr + 0x555 ) =	0x0020; /* write unlock	bypass command	*/
/* At this point, programming only	takes two write cycles.	*/	
/* Once you enter Unlock Bypass Mod	e, do a series of like	*/	
/* operations (programming or sector	r erase) and then exit	*/	
/* Unlock Bypass Mode before beginn	ing a different type of	*/	
/* operations.		*/	

# Table 6.24Unlock Bypass Program(LLD Function = Ild\_UnlockBypassProgramCmd)

Cycle	Description	Operation	Byte Address	Word Address	Data
1	Program Setup Command	Write	Base + xxxh	Base +xxxh	00A0h
2	Program Command	Write	Program Address	Program Address	Program Data

/\* Example: Unlock Bypass Program Command \*/

/\* Do while in Unlock Bypass Entry Mode! \*/

\*( (UINT16 \*)bank\_addr + 0x555 ) = 0x00A0; /\* write program setup command \*/

\*( (UINT16 \*)pa ) = data; /\* write data to be programmed

/\* Poll until done or error. \*/

/\* If done and more to program, \*/

/\* do above two cycles again. \*/

# Table 6.25 Unlock Bypass Reset (LLD Function = Ild\_UnlockBypassResetCmd)

Cycle	Description	Operation	Byte Address	Word Address	Data
1	Reset Cycle 1	Write	Base + xxxh	Base +xxxh	0090h
2	Reset Cycle 2	Write	Base + xxxh	Base +xxxh	0000h

/\* Example: Unlock Bypass Exit Command \*/

- \*( (UINT16 \*)base\_addr + 0x000 ) = 0x0090;
- \*( (UINT16 \*)base\_addr + 0x000 ) = 0x0000;

\* /



### 6.5.9 Write Operation Status

The device provides several bits to determine the status of a program or erase operation. The following subsections describe the function of DQ1, DQ2, DQ3, DQ5, DQ6, and DQ7.

#### DQ7: Data# Polling

The Data# Polling bit, DQ7, indicates to the host system whether an Embedded Program or Erase algorithm is in progress or completed, or whether a bank is in Erase Suspend. Data# Polling is valid after the rising edge of the final WE# pulse in the command sequence. Note that the Data# Polling is valid only for the last word being programmed in the write-buffer-page during Write Buffer Programming. Reading Data# Polling status on any word other than the last word to be programmed in the write-buffer-page returns false status information. Similarly, attempting to program *1* over a *0* does not return valid Date# information.

During the Embedded Program algorithm, the device outputs on DQ7 the complement of the datum programmed to DQ7. This DQ7 status also applies to programming during Erase Suspend. The system must provide the program address to read valid status information on DQ7. If a program address falls within a protected sector, Data# polling on DQ7 is active for approximately t<sub>PSP</sub>, then that bank returns to the read mode.

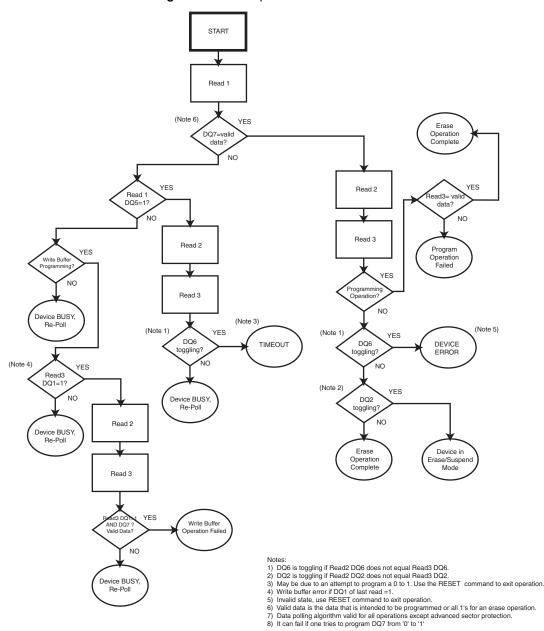
During the Embedded Erase Algorithm, Data# polling produces a 0 on DQ7. When the Embedded Erase algorithm is complete, or if the bank enters the Erase Suspend mode, Data# Polling produces a 1 on DQ7. The system must provide an address within any of the sectors selected for erasure to read valid status information on DQ7.

After an erase command sequence is written, if all sectors selected for erasing are protected, Data# Polling on DQ7 is active for approximately t<sub>ASP</sub>, then the bank returns to the read mode. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected. However, if the system reads DQ7 at an address within a protected sector, the status may not be valid.

Just prior to the completion of an Embedded Program or Erase operation, DQ7 may change asynchronously with DQ6-DQ1 while Output Enable (OE#) is asserted low. That is, the device may change from providing status information to valid data on DQ7. Even if the device has completed the program or erase operation and DQ7 has valid data, the data outputs on DQ6-DQ1 may be still invalid. Valid data on DQ7-D01 appears on successive read cycles.

See the following for more information: Table 6.27, *Write Operation Status*, shows the outputs for Data# Polling on DQ7. Table 6.5, *Write Operation Status Flowchart*, shows the Data# Polling algorithm; and Figure 10.15, *Data# Polling Timings (During Embedded Algorithm)*, shows the Data# Polling timing diagram.

Figure 6.5 Write Operation Status Flowchart



### DQ6: Toggle Bit I

Toggle Bit I on DQ6 indicates whether an Embedded Program or Erase algorithm is in progress or complete, or whether the device has entered the Erase Suspend mode. Toggle Bit I may be read at any address in the same bank, and is valid after the rising edge of the final WE# pulse in the command sequence (prior to the program or erase operation), and during the sector erase time-out.

During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause DQ6 to toggle. When the operation is complete, DQ6 stops toggling.

After an erase command sequence is written, if all sectors selected for erasing are protected, DQ6 toggles for approximately  $t_{ASP}$  [all sectors protected toggle time], then returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.



The system can use DQ6 and DQ2 together to determine whether a sector is actively erasing or is erasesuspended. When the device is actively erasing (that is, the Embedded Erase algorithm is in progress), DQ6 toggles. When the device enters the Erase Suspend mode, DQ6 stops toggling. However, the system must also use DQ2 to determine which sectors are erasing or erase-suspended. Alternatively, the system can use DQ7 (see the subsection on DQ7: Data# Polling).

If a program address falls within a protected sector, DQ6 toggles for approximately t<sub>PSP</sub> after the program command sequence is written, then returns to reading array data.

DQ6 also toggles during the erase-suspend-program mode, and stops toggling once the Embedded Program Algorithm is complete.

See the following for additional information: Figure 6.5, *Write Operation Status Flowchart*; Figure 10.16, *Toggle Bit Timings (During Embedded Algorithm)*, and Tables 6.26 and 6.27.

Toggle Bit I on DQ6 requires either OE# or CE# to be de-asserted and reasserted to show the change in state

#### DQ2: Toggle Bit II

The *Toggle Bit II* on DQ2, when used with DQ6, indicates whether a particular sector is actively erasing (that is, the Embedded Erase algorithm is in progress), or whether that sector is erase-suspended. Toggle Bit II is valid after the rising edge of the final WE# pulse in the command sequence. DQ2 toggles when the system reads at addresses within those sectors that have been selected for erasure. But DQ2 cannot distinguish whether the sector is actively erasing or is erase-suspended. DQ6, by comparison, indicates whether the device is actively erasing, or is in Erase Suspend, but cannot distinguish which sectors are selected for erasure. Thus, both status bits are required for sector and mode information. Refer to Table 6.26 to compare outputs for DQ2 and DQ6. See the following for additional information: Figure 6.5, the *DQ6: Toggle Bit I* section, and Figures 10.15 – 10.18.

Table 6.26 DQ6 and DQ2 Indication
-----------------------------------

If device is	and the system reads	then DQ6	and DQ2
programming,	any address at the bank being programmed	toggles,	does not toggle.
	at an address within a sector selected for erasure,	toggles,	also toggles.
actively erasing,	at an address within sectors <i>not</i> selected for erasure,	toggles,	does not toggle.
	at an address within a sector selected for erasure,	does not toggle,	toggles.
erase suspended,	at an address within sectors <i>not</i> selected for erasure,	returns array data,	returns array data. The system can read from any sector not selected for erasure.
programming in erase suspend	any address at the bank being programmed	toggles,	is not applicable.

### Reading Toggle Bits DQ6/DQ2

Whenever the system initially begins reading toggle bit status, it must read DQ7 – DQ0 at least twice in a row to determine whether a toggle bit is toggling. Typically, the system notes and stores the value of the toggle bit after the first read. After the second read, the system compares the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erases operation. The system can read array data on DQ7 – DQ0 on the following read cycle. However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ5 is high (see the section on DQ5). If it is, the system should then determine again whether the toggle bit is no longer toggling, since the toggle bit may have stopped toggling just as DQ5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erases operation. If it is still toggling and DQ5 has not gone high. The system may continue to monitor the toggle bit and DQ5 through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation. Refer to Figure 6.5 for more details.

**Note:** When verifying the status of a write operation (embedded program/erase) of a memory bank, DQ6 and DQ2 toggle between high and low states in a series of consecutive and contiguous status read cycles. In order for this toggling behavior to be properly observed, the consecutive status bit reads must not be interleaved with read accesses to other memory banks. If it is not possible to temporarily prevent reads to



other memory banks, then it is recommended to use the DQ7 status bit as the alternative method of determining the active or inactive status of the write operation.

#### **DQ5: Exceeded Timing Limits**

DQ5 indicates whether the program or erase time has exceeded a specified internal pulse count limit. Under these conditions DQ5 produces a 1, indicating that the program or erase cycle was not successfully completed. The device may output a 1 on DQ5 if the system tries to program a 1 to a location that was previously programmed to 0. Only an erase operation can change a 0 back to a 1. Under this condition, the device halts the operation, and when the timing limit has been exceeded, DQ5 produces a 1. Under both these conditions, the system must write the reset command to return to the read mode (or to the erase-suspend-read mode if a bank was previously in the erase-suspend-program mode).

#### **DQ3: Sector Erase Timeout State Indicator**

After writing a sector erase command sequence, the system may read DQ3 to determine whether or not erasure has begun. (The sector erase timer does not apply to the chip erase command.) If additional sectors are selected for erasure, the entire time-out also applies after each additional sector erase command. When the time-out period is complete, DQ3 switches from a *0* to a *1*. If the time between additional sector erase commands from the system can be assumed to be less than  $t_{SEA}$ , the system need not monitor DQ3. See the Sector Erase Command Sequence, for more details.

After the sector erase command is written, the system should read the status of DQ7 (Data# Polling) or DQ6 (Toggle Bit I) to ensure that the device has accepted the command sequence, and then read DQ3. If DQ3 is *1*, the Embedded Erase algorithm has begun; all further commands (except Erase Suspend) are ignored until the erase operation is complete. If DQ3 is *0*, the device accepts additional sector erase commands. To ensure the command has been accepted, the system software should check the status of DQ3 prior to and following each sub-sequent sector erase command. If DQ3 is high on the second status check, the last command might not have been accepted. Table 6.27 shows the status of DQ3 relative to the other status bits.

### DQ1: Write to Buffer Abort

DQ1 indicates whether a Write to Buffer operation was aborted. Under these conditions DQ1 produces a 1. The system must issue the Write to Buffer Abort Reset command sequence to return the device to reading array data. See Write Buffer Programming Operation for more details.

	Status		DQ7 <mark>(2)</mark>	DQ6	DQ5 <mark>(1)</mark>	DQ3	DQ2 (2)	DQ1 (4)
Standard	Embedded Program Algorithm	1	DQ7#	Toggle	0	N/A	No toggle	0
Mode	Embedded Erase Algorithm		0	Toggle	0	1	Toggle	N/A
Program Suspend	Reading within Prog Suspended Sector	jram	INVALID (Not Allowed)	INVALID (Not Allowed)	INVALID (Not Allowed)	INVALID (Not Allowed)	INVALID (Not Allowed)	INVALID (Not Allowed)
Mode (3)	Reading within Non- Suspended Sector	-Program	Data	Data	Data	Data	Data	Data
Erase	Erase-Suspend-	Erase Suspended Sector	1	No toggle	0	N/A	Toggle	N/A
Suspend Mode	Read	Non-Erase Suspended Sector	Data	Data	Data	Data	Data	Data
	Erase-Suspend-Pro	gram	DQ7#	Toggle	0	N/A	N/A	N/A
Write to	BUSY State		DQ7#	Toggle	0	N/A	N/A	0
Buffer	Exceeded Timing Li	mits	DQ7#	Toggle	1	N/A	N/A	0
(5)	ABORT State		DQ7#	Toggle	0	N/A	N/A	1

#### Table 6.27 Write Operation Status

Notes

1. DQ5 switches to 1 when an Embedded Program or Embedded Erase operation has exceeded the maximum timing limits. Refer to the section on DQ5 for more information.

2. DQ7 and DQ2 require a valid address when reading status information. Refer to the appropriate subsection for further details.

3. Data are invalid for addresses in a Program Suspended sector.

4. DQ1 indicates the Write to Buffer ABORT status during Write Buffer Programming operations.

5. The data-bar polling algorithm should be used for Write Buffer Programming operations. Note that DQ7# during Write Buffer Programming indicates the data-bar for DQ7 data for the LAST LOADED WRITE-BUFFER ADDRESS location.



### 6.6 Simultaneous Read/Write

The simultaneous read/write feature allows the host system to read data from one bank of memory while programming or erasing another bank of memory. An erase operation may also be suspended to read from or program another location within the same bank (except the sector being erased). Figure 10.21, *Back-to-Back Read/Write Cycle Timings*, shows how read and write cycles may be initiated for simultaneous operation with zero latency. Refer to the *DC Characteristics* table for read-while-program and read-while-erase current specification.

### 6.7 Writing Commands/Command Sequences

When the device is in Asynchronous read, only Asynchronous write operations are allowed. During an asynchronous write operation, the system must drive CE# and WE# to  $V_{IL}$  and OE# to  $V_{IH}$  when providing an address, command, and data. Addresses are latched on the rising edge of AVD#, while data is latched on the rising edge of WE#. An erase operation can erase one sector, multiple sectors, or the entire device. Table 5.1 – Table 5.3 indicate the address space that each sector occupies. The device address space is divided into sixteen banks: for NS512P, all 16 banks contain 64-Kword sectors while for NS256P and NS128P, Banks 0 through 14 contain only 64 Kword sectors, Bank 15 contains 16-Kword boot sectors in addition to 64 Kword sectors. A *bank address* is the set of address bits required to uniquely select a bank. Similarly, a *sector address* is the active current specification for the write mode. *AC Characteristics-Synchronous* and *AC Characteristics-Asynchronous* contain timing specification tables and timing diagrams for write operations.

### 6.8 Handshaking

The handshaking feature allows the host system to detect when data is ready to be read by simply monitoring the RDY pin which is a dedicated output and is controlled by CE#.

### 6.9 Hardware Reset

The RESET# input provides a hardware method of resetting the device to reading array data. When RESET# is driven low for at least a period of t<sub>RP</sub>, the device immediately terminates any operation in progress, tristates all outputs, resets the configuration register, and ignores all read/write commands for the duration of the RESET# pulse. The device also resets the internal state machine to reading array data.

To ensure data integrity the operation that was interrupted should be reinitiated once the device is ready to accept another command sequence.

When RESET# is held at  $V_{SS}$ , the device draws CMOS standby current ( $I_{CC4}$ ). If RESET# is held at  $V_{IL}$ , but not at  $V_{SS}$ , the standby current is greater.

RESET# may be tied to the system reset circuitry which enables the system to read the boot-up firmware from the Flash memory upon a system reset.

See Figures 10.5 and 10.11 for timing diagrams.

### 6.10 Software Reset

Software reset is part of the command set (see Table 11.1) that also returns the device to array read mode and must be used for the following conditions:

- 1. to exit Autoselect mode
- when DQ5 goes high during write status operation that indicates program or erase cycle was not successfully completed
- 3. exit sector lock/unlock operation.
- 4. to return to erase-suspend-read mode if the device was previously in Erase Suspend mode.
- 5. after any aborted operations
- 6. exiting read configuration registration Mode



#### Software Functions and Sample Code

#### Table 6.28 Reset

(LLD Function = IId\_ResetCmd)

Cycle	Operation	Byte Address	Word Address	Data
Reset Command	Write	Base + xxxh	Base + xxxh	00F0h

Note

Base = Base Address.

The following is a C source code example of using the reset function. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Reset (software reset of Flash state machine) */
```

```
*( (UINT16 *)base_addr + 0x000 ) = 0x00F0;
```

The following are additional points to consider when using the reset command:

- This command resets the banks to the read and address bits are ignored.
- Reset commands are ignored once erasure has begun until the operation is complete.
- Once programming begins, the device ignores reset commands until the operation is complete
- The reset command may be written between the cycles in a program command sequence before programming begins (prior to the third cycle). This resets the bank to which the system was writing to the read mode.
- If the program command sequence is written to a bank that is in the Erase Suspend mode, writing the reset command returns that bank to the erase-suspend-read mode.
- The reset command may be also written during an Autoselect command sequence.
- If a bank has entered the Autoselect mode while in the Erase Suspend mode, writing the reset command returns that bank to the erase-suspend-read mode.
- If DQ1 goes high during a Write Buffer Programming operation, the system must write the Write to Buffer Abort Reset command sequence to RESET the device to reading array data. The standard RESET command does not work during this condition.
- To exit the unlock bypass mode, the system must issue a two-cycle unlock bypass reset command sequence [see command table for details].

### 6.11 Programmable Output Slew Rate Control

This feature allows the user to change the output slew rate during a read operation by setting the configuration register bit CR1.4. It allows 2 programmable slew rates. This feature is for users who do not want to run the part at its maximum speed and could live with a slower output slew rate thereby reducing noise variations at the output.

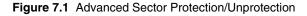
Table 6.29	Programmable	Output Slew Rat	е
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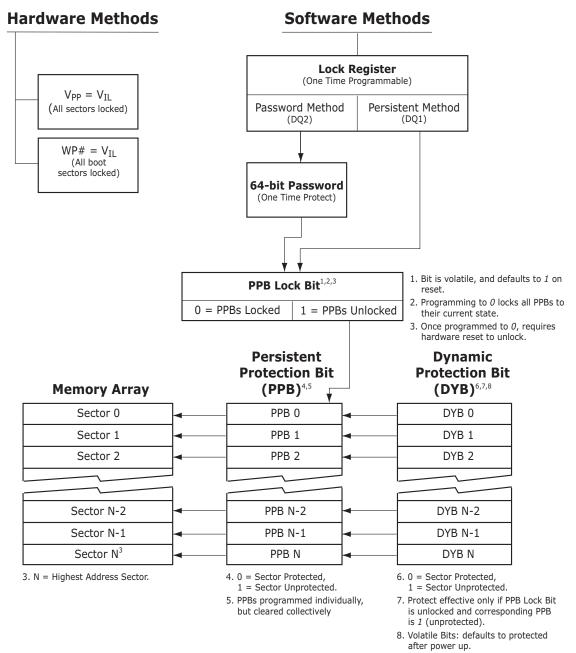
Mode	Description	I <sub>OL</sub> & I <sub>OH</sub>
1	Full Drive (Default)	100 µA
2	Half Drive	50 µA



# 7. Advanced Sector Protection/Unprotection

The Advanced Sector Protection/Unprotection feature disables or enables programming or erase operations in any or all sectors and can be implemented through software and/or hardware methods, which are independent of each other. This section describes the various methods of protecting data stored in the memory array. An overview of these methods in shown in Figure 7.1.





# 7.1 Lock Register

The Lock Register consists of 5 bits. The Secured Silicon Sector Protection Bit is DQ0, Persistent Protection Mode Lock Bit is DQ1, Password Protection Mode Lock Bit is DQ2, Persistent Sector Protection OTP bit is DQ3 and Volatile Sector Protection Boot bit is DQ4. If DQ0 is *0*, it means that the Customer Secured Silicon area is locked and if DQ0 is *1*, it means that it is unlocked. When DQ2 is set to *1* and DQ1 is set to *0*, the



device can only be used in the Persistent Protection Mode. When the device is set to Password Protection Mode, DQ1 is required to be set to *1* and DQ2 is required to be set to *0*. DQ3 is programmed in the Spansion factory. When the device is programmed to disable all PPB erase command, DQ3 outputs a *0*, when the lock register bits are read. Similarly, if the device is programmed to enable all PPB erase command, DQ3 outputs a *1* when the lock register bits are read. Likewise the DQ4 bit is also programmed in the Spansion Factory. DQ4 is the bit which indicates whether Volatile Sector Protection Bit (DYB) is protected or not after boot up. When the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a *0* when the lock register bits are read. Similarly, when the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a *0* when the lock register bits are read. Similarly, when the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a *0* when the lock register bits are read. Similarly, when the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a *0* when the lock register bits are read. Similarly, when the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a *1*. Each of these bits in the lock register are non-volatile. DQ15 – DQ5 are reserved and are *1*s.

LOCK REGIS	ler
	1

DQ15-5	DQ4	DQ3	DQ2	DQ1	DQ0
1s	DYB Lock Boot Bit 0 = DYB bits power up protected (Default) 1 = DYB bits power up unprotected	PPB One Time Programmable Bit 0 = All PPB Erase Command disabled 1 = All PPB Erase Command enabled	Password Protection Mode Lock Bit	Persistent Protection Mode Lock Bit	Secured Silicon Sector Protection Bit

For programming lock register bits refer to Table 11.2.

#### Notes

- 1. If the password mode is chosen, the password must be programmed and verified before setting the corresponding lock register bit.
- 2. It is recommended that a sector protection method to be chosen by programming DQ1 or DQ2 prior to shipment
- 3. After the Lock Register Bits Command Set Entry command sequence is written, reads and writes for Bank 0 are disabled, while reads from other banks are allowed until exiting this mode.
- 4. If both lock bits are selected to be programmed (to zeros) at the same time, the operation aborts.
- 5. Once the Password Mode Lock Bit is programmed, the Persistent Mode Lock Bit is permanently disabled, and no changes to the protection scheme are allowed. Similarly, if the Persistent Mode Lock Bit is programmed, the Password Mode is permanently disabled.
- 6. During erase/program suspend, ASP entry commands are not allowed.
- 7. Data Polling can be done immediately after the lock register programming command sequence (no delay required). Note that status polling can be done only in bank 0.
- 8. Reads from other banks (simultaneous operation) are not allowed during lock register programming. This restriction applies to both synchronous and asynchronous read operations.

After selecting a sector protection method, each sector can operate in any of the following three states:

- 1. *Constantly locked.* The selected sectors are protected and can not be reprogrammed unless PPB lock bit is cleared via a password, hardware reset, or power cycle.
- 2. *Dynamically locked.* The selected sectors are protected and can be altered via software commands.
- 3. Unlocked. The sectors are unprotected and can be erased and/or programmed.

These states are controlled by the bit types described in Sections 7.2 - 7.6.

### 7.2 Persistent Protection Bits

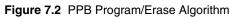
The Persistent Protection Bits are unique and nonvolatile for each sector and have the same endurances as the Flash memory. Preprogramming and verification prior to erasure are handled by the device, and therefore do not require system monitoring.

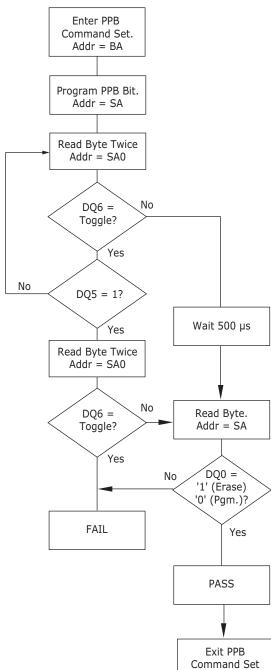


#### Notes

- 1. Each PPB is individually programmed and all are erased in parallel.
- 2. While programming PPB for a sector, array data can be read from any other bank, except Bank 0 (used for Data# Polling) and the bank in which sector PPB is being programmed.
- 3. Entry command disables reads and writes for the bank selected.
- 4. Reads within that bank return the PPB status for that sector.
- 5. Reads from other banks are allowed while writes are not allowed.
- 6. All Reads must be performed using the Asynchronous mode.
- 7. The specific sector address (Amax A14) are written at the same time as the program command.
- 8. If the PPB Lock Bit is set, the PPB Program or erase command does not execute and time out without programming or erasing the PPB.
- 9. There are no means for individually erasing a specific PPB and no specific sector address is required for this operation.
- 10. PPB exit command must be issued after the execution which resets the device to read mode and re-enables reads and writes for Bank 0
- 11. The programming state of the PPB for a given sector can be verified by writing a PPB Status Read Command to the device as described by the flow chart shown in Figure 7.2.
- 12. During PPB program/erase data polling can be done synchronously.
- 13. If customers attempt to program or erase a protected sector, the device ignores the command and returns to read mode.







### 7.3 Dynamic Protection Bits

Dynamic Protection Bits are volatile and unique for each sector and can be individually modified. DYBs only control the protection scheme for unprotected sectors that have their PPBs cleared (erased to 1). By issuing the DYB Set or Clear command sequences, the DYBs are set (programmed to 0) or cleared (erased to 1), thus placing each sector in the protected or unprotected state respectively. This feature allows software to easily protect sectors against inadvertent changes yet does not prevent the easy removal of protection when changes are needed.



#### Notes

- 1. The DYBs can be set (programmed to 0) or cleared (erased to 1) as often as needed.
- 2. When the parts are first shipped, the DYBs are set and programmed to 0 upon power up or reset.
- 3. The default state of DYB is protected after power up and all sectors can be modified depending on the status of PPB bit for that sector, (erased to 1). Then the sectors can be modified depending upon the PPB state of that sector (see Table 7.1).
- 4. It is possible to have sectors that are persistently locked with sectors that are left in the dynamic state.
- 5. The DYB Set or Clear commands for the dynamic sectors signify protected or unprotectedstate of the sectors respectively. However, if there is a need to change the status of the persistently locked sectors, a few more steps are required. First, the PPB Lock Bit must be cleared by either putting the device through a power cycle, or hardware reset. The PPBs can then be changed to reflect the desired settings. Setting the PPB Lock Bit once again locks the PPBs, and the device operates normally again.
- To achieve the best protection, it is recommended to execute the PPB Lock Bit Set command early in the boot code and protect the boot code by holding WP# = V<sub>IL</sub>.
- 7. Data polling is not available for DYB program/erase.
- 8. DYB read data can be done synchronously.
- 9. If customers attempt to program or erase a protected sector, the device ignores the command and returns to read mode.

### 7.4 Persistent Protection Bit Lock Bit

The Persistent Protection Bit Lock Bit is a global volatile bit for all sectors. When set (programmed to *0*), it locks all PPBs and when cleared (programmed to *1*), allows the PPBs to be changed. There is only one PPB Lock Bit per device.

Notes

- 1. If the password mode is chosen, then the password must be programmed and verified before setting the corresponding lock register bit.
- 2. No software command sequence unlocks this bit unless the device is in the password protection mode; only a hardware reset or a power up clears this bit.
- 3. The PPB Lock Bit must be set (programmed to *0*) only after all PPBs are configured to the desired settings.

### 7.5 Password Protection Method

The Password Protection Method allows an even higher level of security than the Persistent Sector Protection Mode by requiring a 64 bit password for unlocking the device PPB Lock Bit. In addition to this password requirement, after power up and reset, the PPB Lock Bit is set *0* to maintain the password mode of operation. Successful execution of the Password Unlock command by entering the entire password clears the PPB Lock Bit, allowing for sector PPBs modifications.

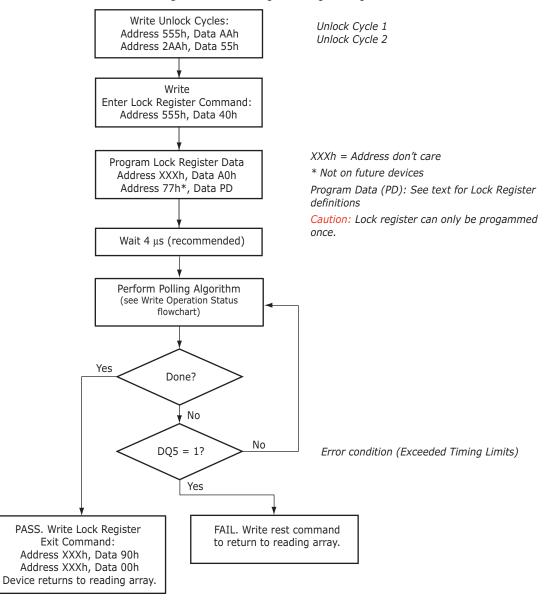
#### Notes

- 1. There is no special addressing order required for programming the password. Once the Password is written and verified, the Password Mode Locking Bit must be set in order to prevent access.
- 2. The Password Program Command is only capable of programming *0*s. Programming a *1* after a cell is programmed as a *0* results in a time out with the cell as a *0*.
- 3. The password is all 1s when shipped from the factory.
- 4. All 64-bit password combinations are valid as a password.
- 5. There is no means to verify what the password is after it is set.
- 6. The Password Mode Lock Bit, once set, prevents reading the 64-bit password on the data bus and further password programming.



- 7. The Password Mode Lock Bit is not erasable.
- 8. The lower two address bits (A1 A0) are valid during the Password Read, Password Program, and Password Unlock.
- 9. The exact password must be entered in order for the unlocking function to occur.
- 10. The Password Unlock command cannot be issued any faster than 1 µs at a time to prevent a hacker from running through all the 64-bit combinations in an attempt to correctly match a password.
- 11. Approximately 1 µs is required for unlocking the device after the valid 64-bit password is given to the device.
- 12. Password verification is only allowed during the password programming operation.
- 13. All further commands to the password region are disabled and all operations are ignored.
- 14. If the password is lost after setting the Password Mode Lock Bit, there is no way to clear the PPB Lock Bit.
- 15. Entry command sequence must be issued prior to any of any operation and it disables reads and writes for Bank 0. Reads and writes for other banks excluding Bank 0 are allowed.
- 16. If the user attempts to program or erase a protected sector, the device ignores the command and returns to read mode.
- 17. A program or erase command to a protected sector enables status polling and returns to read mode without having modified the contents of the protected sector.
- 18. The programming of the DYB, PPB, and PPB Lock for a given sector can be verified by writing individual status read commands DYB Status, PPB Status, and PPB Lock Status to the device.





### Figure 7.3 Lock Register Program Algorithm

# 7.6 Advanced Sector Protection Software Examples

Table 7.1	Sector Protection Schemes
14010 111	

Unique Device PPB Lo 0 = locked 1 = unlocked			Sector DYB 0 = protected 1 = unprotected	Sector Protection Status
Any Sector	0	0	x	Protected through PPB
Any Sector	0	0	x	Protected through PPB
Any Sector	0	1	1	Unprotected
Any Sector	0	1	0	Protected through DYB
Any Sector	1	0	x	Protected through PPB
Any Sector	1	0	x	Protected through PPB
Any Sector	1	1	0	Protected through DYB
Any Sector	1	1	1	Unprotected



Table 7.1 contains all possible combinations of the DYB, PPB, and PPB Lock Bit relating to the status of the sector.

### 7.7 Hardware Data Protection Methods

The device offers two main types of data protection at the sector level via hardware control:

- When WP# is at V<sub>IL</sub>, the highest two sectors are locked (device specific).
- When  $V_{PP}$  is at  $V_{IL}$ , all sectors are locked.

There are additional methods by which intended or accidental erasure of any sectors can be prevented via hardware means. The following subsections describes these methods:

#### WP# Method

The Write Protect feature provides a hardware method of protecting the highest two sectors (NS256P and NS128P). This function is provided by the WP# pin and overrides the previously discussed Sector Protection/ Unprotection method.

If the system asserts  $V_{IL}$  on the WP# pin, the device disables program and erase functions in the highest two sectors (NS256P and NS128P) as well as Secured Silicon Area.

If the system asserts  $V_{IH}$  on the WP# pin, the device reverts to whether the boot sectors were last set to be protected or unprotected. That is, sector protection or unprotection for these sectors depends on whether they were last protected or unprotected.

Note that the WP# pin must not be left floating or unconnected as inconsistent behavior of the device may result.

The WP# pin must be held stable during a command sequence execution

### V<sub>PP</sub> Method

This method is similar to above, except it protects all sectors (including the Secured Silicon Area). Once  $V_{PP}$  input is set to  $V_{IL}$ , all program and erase functions are disabled and hence all sectors are protected.

### Low V<sub>CC</sub> Write Inhibit

When  $V_{CC}$  is less than  $V_{LKO}$ , the device does not accept any write cycles. This protects data during  $V_{CC}$  power up and power down.

The command register and all internal program/erase circuits are disabled, and the device resets to reading array data. Subsequent writes are ignored until  $V_{CC}$  is greater than  $V_{LKO}$ . The system must provide the proper signals to the control inputs to prevent unintentional writes when  $V_{CC}$  is greater than  $V_{LKO}$ .

### Write Pulse Glitch Protection

Noise pulses of less than 3 ns (typical) on OE#, CE# or WE# do not initiate a write cycle.

### **Power-Up Write Inhibit**

If WE# = CE# = RESET# =  $V_{IL}$  and OE# =  $V_{IH}$  during power up, the device does not accept commands on the rising edge of WE#. The internal state machine is automatically reset to the read mode on power up.



# 8. Power Conservation Modes

### 8.1 Standby Mode

When the system is not reading or writing to the device, it can place the device in the standby mode. In this mode, current consumption is greatly reduced, and the outputs are placed in the high impedance state, independent of the OE# input. The device enters the CMOS standby mode when the CE# and RESET# inputs are both held at  $V_{CC} \pm 0.2$  V. The device requires standard access time ( $t_{CE}$ ) for read access, before it is ready to read data. If the device is deselected during erasure or programming, the device draws active current until the operation is completed.  $I_{CC3}$  in the *DC Characteristics* section represents the standby current specification

### 8.2 Automatic Sleep Mode

The automatic sleep mode minimizes Flash device energy consumption while in asynchronous mode. the device automatically enables this mode when addresses remain stable for  $t_{ACC}$  + 20 ns. The automatic sleep mode is independent of the CE#, WE#, and OE# control signals. Standard address access timings provide new data when addresses are changed. While in sleep mode, output data is latched and always available to the system. While in synchronous mode, the automatic sleep mode is disabled. Note that a new burst operation is required to provide new data. I<sub>CC6</sub> in the *DC Characteristics* section represents the automatic sleep mode current specification.

### 8.3 Hardware RESET# Input Operation

The RESET# input provides a hardware method of resetting the device to reading array data. When RESET# is driven low for at least a period of  $t_{RP}$ , the device immediately terminates any operation in progress, tristates all outputs, resets the configuration register, and ignores all read/write commands for the duration of the RESET# pulse. The device also resets the internal state machine to reading array data. The operation that was interrupted should be reinitiated once the device is ready to accept another command sequence to ensure data integrity.

When RESET# is held at V<sub>SS</sub>  $\pm$  0.2 V, the device draws CMOS standby current (I<sub>CC4</sub>). If RESET# is held at V<sub>IL</sub> but not within V<sub>SS</sub>  $\pm$  0.2 V, the standby current is greater.

RESET# may be tied to the system reset circuitry and thus, a system reset also resets the Flash memory, enabling the system to read the boot-up firmware from the Flash memory.

### 8.4 Output Disable (OE#)

When the OE# input is at  $V_{\text{IH}},$  output from the device is disabled. The outputs are placed in the high impedance state.



# 9. Secured Silicon Sector Flash Memory Region

The Secured Silicon Sector provides an extra Flash memory region that enables permanent part identification through an Electronic Serial Number (ESN). The Secured Silicon Sector is 256 words in length that consists of 128 words for factory data and 128 words for customer-secured areas. All Secured Silicon reads outside of the 256-word address range returns invalid data. The Factory Indicator Bit, DQ7, (at Autoselect address 03h) is used to indicate whether or not the Factory Secured Silicon Sector is locked when shipped from the factory. The Customer Indicator Bit (DQ6) is used to indicate whether or not the Customer Secured Silicon Sector is locked when shipped from the factory.

Please note the following general conditions:

- While Secured Silicon Sector access is enabled, simultaneous operations are allowed except for Bank 0.
- On power-up, or following a hardware reset, the device reverts to sending commands to the normal address space.
- Reads can be performed in the Asynchronous or Synchronous mode.
- Burst mode reads within Secured Silicon Sector wrap from address FFh back to address 00h.
- Reads outside of sector 0 return memory array data.
- Continuous burst read past the maximum address is undefined.
- Sector 0 is remapped from memory array to Secured Silicon Sector array.
- Once the Secured Silicon Sector Entry Command is issued, the Secured Silicon Sector Exit command must be issued to exit Secured Silicon Sector Mode.
- The Secured Silicon Sector is not accessible when the device is executing an Embedded Program or Embedded Erase algorithm.

Table 9.1	Secured	Silicon	SectorSecure	Sector	Addresses
-----------	---------	---------	--------------	--------	-----------

	Sector	Sector Size	Address Range
ſ	Customer	128 words	000080h-0000FFh
	Factory	128 words	000000h-00007Fh

## 9.1 Factory Secured Silicon Sector

The Factory Secured Silicon Sector is always protected when shipped from the factory and has the Factory Indicator Bit (DQ7) permanently set to a 1. This prevents cloning of a factory locked part and ensures the security of the ESN and customer code once the product is shipped to the field.

These devices are available pre programmed with one of the following:

- A random, 8 Word secure ESN only within the Factory Secured Silicon Sector
- Customer code within the Customer Secured Silicon Sector through the Spansion<sup>TM</sup> programming service.
- Both a random, secure ESN and customer code through the Spansion programming service.

Customers may opt to have their code programmed through the Spansion programming services. Spansion programs the customer's code, with or without the random ESN. The devices are then shipped from the Spansion factory with the Factory Secured Silicon Sector and Customer Secured Silicon Sector permanently locked. Contact your local representative for details on using Spansion programming services.

### 9.2 Customer Secured Silicon Sector

The Customer Secured Silicon Sector is typically shipped unprotected (DQ6 set to *0*), allowing customers to utilize that sector in any manner they choose. If the security feature is not required, the Customer Secured Silicon Sector can be treated as an additional Flash memory space.

Please note the following:

Once the Customer Secured Silicon Sector area is protected, the Customer Indicator Bit is permanently set to 1.



- The Customer Secured Silicon Sector can be read any number of times, but can be programmed and locked only once. The Customer Secured Silicon Sector lock must be used with caution as once locked, there is no procedure available for unlocking the Customer Secured Silicon Sector area and none of the bits in the Customer Secured Silicon Sector memory space can be modified in any way.
- The accelerated programming (V<sub>PP</sub>) and unlock bypass functions are not available when programming the Customer Secured Silicon Sector, but reading in Banks 1 through 15 is available.
- Once the Customer Secured Silicon Sector is locked and verified, the system must write the Exit Secured Silicon Sector Region command sequence which return the device to the memory array at sector 0.

### 9.3 Secured Silicon Sector Entry and Exit Command Sequences

The system can access the Secured Silicon Sector region by issuing the three-cycle Enter Secured Silicon Sector command sequence. The device continues to access the Secured Silicon Sector region until the system issues the four-cycle Exit Secured Silicon Sector command sequence.

See Command Definition Table [Secured Silicon Sector Command Table, Appendix Table 11.1 for address and data requirements for both command sequences.

The Secured Silicon Sector Entry Command allows the following commands to be executed

- Read customer and factory Secured Silicon areas
- Program the customer Secured Silicon Sector

After the system has written the Enter Secured Silicon Sector command sequence, it may read the Secured Silicon Sector by using the addresses normally occupied by sector SA0 within the memory array. This mode of operation continues until the system issues the Exit Secured Silicon Sector command sequence, or until power is removed from the device.

#### Software Functions and Sample Code

The following are C functions and source code examples of using the Secured Silicon Sector Entry, Program, and exit commands. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	Base + AAAh	Base + 555h	00AAh
Unlock Cycle 2	Write	Base + 554h	Base + 2AAh	0055h
Entry Cycle	Write	Base + AAAh	Base + 555h	0088h

Table 9.2 Secured Silicon Sector Entry (LLD Function = IId\_SecSiSectorEntryCmd)

Note

Base = Base Address.

```
/* Example: Secured Silicon Sector Entry Command */
 *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
 *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
 *( (UINT16 *)base_addr + 0x555 ) = 0x0088; /* write Secured Silicon Sector Entry
Cmd */
```

Table 9.3	Secured	Silicon	Sector	Program	(LLD	Function =	= IId_	_ProgramCmd)
-----------	---------	---------	--------	---------	------	------------	--------	--------------

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	Base + AAAh	Base + 555h	00AAh
Unlock Cycle 2	Write	Base + 554h	Base + 2AAh	0055h
Program Setup	Write	Base + AAAh	Base + 555h	00A0h
Program	Write	Word Address	Word Address	Data Word

Note

Base = Base Address.



/\* Once in the Secured Silicon Sector mode, you program \*/

/\* words using the programming algorithm.

 Table 9.4
 Secured Silicon Sector Exit (LLD Function = IId\_SecSiSectorExitCmd)

\*/

Cycle	Operation	Byte Address	Word Address	Data
Unlock Cycle 1	Write	Base + AAAh	Base + 555h	00AAh
Unlock Cycle 2	Write	Base + 554h	Base + 2AAh	0055h
Exit Cycle 3	Write	Base + AAAh	Base + 555h	0090h
Exit Cycle 4	Write	Any address	Any address	0000h

#### Note

Base = Base Address.

```
/* Example: Secured Silicon Sector Exit Command */
```

```
*( (UINT16 *)base_addr + 0x555 ) = 0x00AA;  /* write unlock cycle 1 */
*( (UINT16 *)base_addr + 0x2AA ) = 0x0055;  /* write unlock cycle 2 */
*( (UINT16 *)base_addr + 0x555 ) = 0x0090;  /* write Secured Silicon Sector Exit
cycle 3 */
```

\*( (UINT16 \*)base\_addr + 0x000 ) = 0x0000;  $\ /*$  write Secured Silicon Sector Exit cycle 4 \*/



# **10. Electrical Specifications**

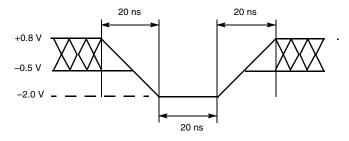
### 10.1 Absolute Maximum Ratings

Storage Temperature Plastic Packages	-65°C to +150°C
Ambient Temperature with Power Applied	-65°C to +125°C
Voltage with Respect to Ground: All Inputs and I/Os except as noted below (1)	-0.5 V to + 2.5 V
V <sub>CC</sub> (1)	-0.5 V to +2.5 V
V <sub>PP</sub> (2)	-0.5 V to +9.5 V
Output Short Circuit Current (3)	100 mA

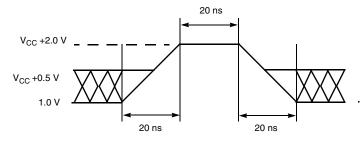
#### Notes

- Minimum DC voltage on input or I/Os is -0.5 V. During voltage transitions, inputs or I/Os may undershoot V<sub>SS</sub> to -2.0 V for periods of up to 20 ns. See Figure 10.1. Maximum DC voltage on input or I/Os is V<sub>CC</sub> + 0.5 V. During voltage transitions outputs may overshoot to V<sub>CC</sub> + 2.0 V for periods up to 20 ns. See Figure 10.2.
- Minimum DC input voltage on pin V<sub>PP</sub> is -0.5V. During voltage transitions, V<sub>PP</sub> may overshoot V<sub>SS</sub> to -2.0 V for periods of up to 20 ns. See Figure 10.1. Maximum DC voltage on pin V<sub>PP</sub> is +9.5 V, which may overshoot to 10.5 V for periods up to 20 ns.
- 3. No more than one output may be shorted to ground at a time. Duration of the short circuit should not be greater than one second.
- 4. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 10.1 Maximum Negative Overshoot Waveform



#### Figure 10.2 Maximum Positive Overshoot Waveform



## 10.2 Operating Ranges

Wireless (I) Devices				
Ambient Temperature (T <sub>A</sub> )	−25°C to +85°C			
Supply Voltages				
V <sub>CC</sub> Supply Voltages +1.70 V to +1.95 V				

#### Note

Operating ranges define those limits between which the functionality of the device is guaranteed.



### **10.3 DC Characteristics**

### 10.3.1 CMOS Compatible

### Table 10.1 DC Characteristics—CMOS Compatible

Parameter	Description	Test Condition	Test Conditions (1)		Тур	Max	Unit
ILI	Input Load Current	$V_{IN} = V_{SS}$ to $V_{CC}$ , $V_{CC} = V_{CC}$	<sub>CC</sub> max			±1	μA
I <sub>LO</sub>	Output Leakage Current	$V_{OUT} = V_{SS}$ to $V_{CC}$ , $V_{CC} = V_{CC}$ max				±1	μA
		$CE# = V_{IL}, OE# = V_{IH},$	108 Mhz		33	44	mA
		WE# = V <sub>IH</sub> , burst length =	83 Mhz		26	36	mA
		8	66 Mhz		24	33	mA
		CE# = V <sub>IL</sub> , OE# = V <sub>IH</sub> ,	108 Mhz		30	40	mA
		WE# = V <sub>IH</sub> , burst length =	83 Mhz		26	38	mA
1	V <sub>CC</sub> Active burst Read Current	16	66 Mhz		24	35	mA
I <sub>CCB</sub>	V <sub>CC</sub> Active buist fread Outfent	$CE# = V_{IL}, OE# = V_{IH},$	108 Mhz		25	33	mA
		WE# = V <sub>IH</sub> , burst length =	83 Mhz		28	40	mA
		32	66 Mhz		26	37	mA
		$\begin{array}{l} CE\#=V_{IL},OE\#=V_{IH},\\ WE\#=V_{IH},burstlength=\\ Continuous \end{array}$	108 Mhz		32	44	mA
			83 Mhz		30	42	mA
			66 Mhz		28	39	m/
I <sub>CC1</sub> V <sub>CC</sub> Active Asynchronous Read Current (2)		$CE\# = V_{IL}, OE\# = V_{IH},$ WE# = V_{IH}	10 MHz		40	80	m
			5 MHz		20	40	m
			1 MHz		10	20	mA
lass	V <sub>CC</sub> Active Write Current (3)	$CE \# = V_{IL},  OE \# = V_{IH},$	V <sub>PP</sub>		1	5	μA
I <sub>CC2</sub>		$V_{PP} = VI_{H}$	V <sub>CC</sub>		<20	<40	m
I <sub>CC3</sub>	V <sub>CC</sub> Standby Current (4)	CE# = RESET# =	V <sub>PP</sub>		1	5	μA
1003		$V_{CC} \pm 0.2 V$	V <sub>CC</sub>		20	70	μA
I <sub>CC4</sub>	V <sub>CC</sub> Reset Current	$RESET\# = V_{IL}, CLK = V_{IL}$			150	250	μA
$I_{CC5}$	V <sub>CC</sub> Active Current (Read While Write)	$CE \texttt{\#} = V_{IL},  OE \texttt{\#} = V_{IH},  V_{PP}$	= V <sub>IH</sub> , (7)		50	60	m/
I <sub>CC6</sub>	V <sub>CC</sub> Sleep Current	$CE\# = V_{IL}, OE\# = V_{IH}$			5	40	μA
I	Accelerated Program Current	$CE\# = V_{IL}, OE\# = V_{IH}$	V <sub>PP</sub>		<7	<10	mA
I <sub>PPW</sub>	(5)	V <sub>PP</sub> = 9.5 V	V <sub>CC</sub>		<15	<20	m/
VIL	Input Low Voltage			-0.2		0.4	V
$V_{\rm IH}$	Input High Voltage			V <sub>CC</sub> – 0.4		V <sub>CC</sub> + 0.4	
V <sub>OL</sub>	Output Low Voltage	$I_{OL}$ = 100 µA, $V_{CC}$ = $V_{CC}$ min = $V_{CC}$				0.1	V
V <sub>OH</sub>	Output High Voltage	$I_{OH} = -100 \ \mu A, \ V_{CC} = V_{CC}$		V <sub>CC</sub> – 0.1			v
V <sub>HH</sub>	Voltage for Accelerated Program			8.5		9.5	V
V <sub>LKO</sub>	Low V <sub>CC</sub> Lock-out Voltage					1.4	V

Notes

1. Maximum  $I_{CC}$  specifications are tested with  $V_{CC} = V_{CC}max$ .

2. The I\_{CC} current listed is typically less than 2 mA/MHz, with OE# at V\_{IH}.

*3. I<sub>CC</sub>* active while Embedded Erase or Embedded Program is in progress.

4. Device enters automatic sleep mode when addresses are stable for  $t_{ACC}$  + 20 ns. Typical sleep mode current is equal to  $I_{CC3}$ .

5. Total current during accelerated programming is the sum of  $V_{PP}$  and  $V_{CC}$  currents.

6.  $V_{CCQ} = V_{CC}$  during all ICC measurements.

7. Clock frequency 66 Mhz and in Continuous Mode.

8. For  $I_{CC6}$ , when  $V_{IH} = V_{IO}$ ,  $V_{IL} = V_{SS}$ .



### **10.4 Test Conditions**

Figure 10.3 Test Setup

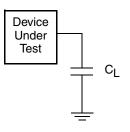


Table 10.2 Test Specifications

Test Condition	All Speed Options	Unit
Output Load Capacitance, CL, (including jig capacitance)	30	pF
Input Rise and Fall Times	1.0 – 1.50	ns
Input Pulse Levels	0.0 – V <sub>CC</sub>	V
Input timing measurement reference levels	V <sub>CC</sub> /2	V
Output timing measurement reference levels	V <sub>CCQ</sub> /2	V

### 10.5 Key to Switching Waveforms

Waveform	Inputs	Outputs			
	Steady				
	Changing from H to L				
	Changing from L to H				
XXXXX	Don't Care, Any Change Permitted Changing, State Unknown				
	Does Not Apply	Center Line is High Impedance State (High Z)			

## 10.6 Switching Waveforms



All Inputs and Outputs  $V_{CC}$  Input  $V_{CC/2}$  Measurement Level  $\rightarrow$   $V_{CCQ/2}$  Output

Table 10.3	V <sub>CC</sub> Power-Up with No Ramp Rate Restriction	

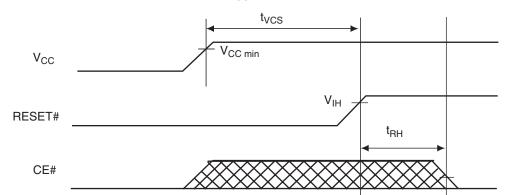
Parameter	Description	Test Setup	Time	Unit
t <sub>VCS</sub>	V <sub>CC</sub> Setup Time	Min	30	μs
t <sub>RH</sub>	Time between RESET# (high) and CE# (low)	Min	200	ns

Note

 $V_{CC}$  and  $V_{CCQ}$  must be ramped simultaneously for proper power-up.



### Figure 10.5 V<sub>CC</sub> Power-Up Diagram

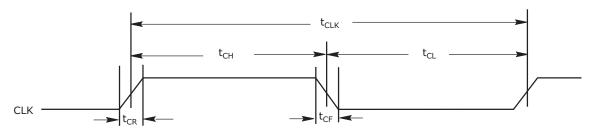


# 10.7 CLK Characterization

Parameter	Description		66 MHz	83 MHz	108 MHz	Unit	
		Max	66	83	108	MHz	
f <sub>CLK</sub>	CLK Frequency	Min	60 KHz in 8 word Burst, 120 KHz in 16 word Burst, 250 KHz in 32 word Burst, 1 MHz in Continuous Mode				
t <sub>CLK</sub>	CLK Period	Min	15.1	12.5	9.26	ns	
+ /+	CLK Low/High Time	Min	0.40 t <sub>CLK</sub> ns				
t <sub>CL</sub> /t <sub>CH</sub>	CLK LOW/High Time	Max	0.60 t <sub>CLK</sub>				
t <sub>CR</sub>	CLK Rise Time	Max	3.0	2.5	1.5	nc	
t <sub>CF</sub>	CLK Fall Time	iviax	Max 3.0	2.0	1.5	ns	

#### Table 10.4 CLK Characterization

#### Figure 10.6 CLK Characterization



# **10.8 AC Characteristics**

# 10.8.1 Synchronous/Burst Read

#### Table 10.5 Synchronous/Burst Read

Para	meter	Description		66 MHz	83 MHz	108 MHz	Unit	
JEDEC	Standard	Description			os Minz		onit	
	tIACC	Synchronous Access Time	Max	80		ns		
	t <sub>BACC</sub>	Burst Access Time Valid Clock to Output Delay	Max	11.2	9	7.6	ns	
	t <sub>ACS</sub>	Address Setup Time to CLK (1)	Min		4		ns	
	t <sub>ACH</sub>	Address Hold Time from CLK (1)	Min	6	5	5	ns	
	t <sub>BDH</sub>	Data Hold Time	Min	3	3	2	ns	
	t <sub>RDY</sub>	Chip Enable to RDY Active	Max		10		ns	



#### Table 10.5 Synchronous/Burst Read

Para	meter	Description		66 MHz	83 MHz	108 MHz	Unit
JEDEC	Standard	Description			оз імп2		Unit
	t <sub>OE</sub>	Output Enable to RDY Low	Max	9	9	9	ns
	t <sub>CEZ</sub>	Chip Enable to High Z	Max	10	10	10	ns
	t <sub>OEZ</sub>	Output Enable to High Z	Max	10	10	10	ns
	t <sub>CES</sub>	CE# Setup Time to CLK	Min		4		ns
	t <sub>RACC</sub>	Ready Access Time from CLK	Max	11.2	9	7.5	ns
	t <sub>CAS</sub>	CE# Setup Time to AVD#	Min		0		ns
	t <sub>AVDS</sub>	AVD# Low to CLK Setup Time	Min		5		ns
	t <sub>AVDH</sub>	AVD# Hold Time to CLK	Min	3			ns
	t <sub>AVD0</sub>	AVD# High to OE# Low	Min	0		ns	
	t <sub>AVD</sub>	AVD# Pulse	Min		6		ns

#### Notes

1. Addresses are latched on the rising edge of CLK

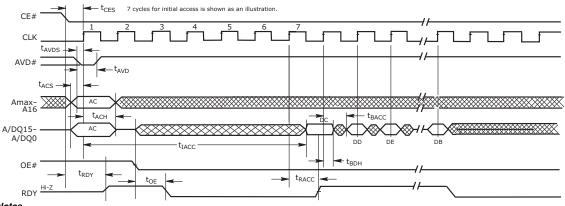
2. Synchronous Access Time is calculated using the formula (#of WS - 1)\*(clock period) + (t<sub>BACC</sub> or Clock to Out)

3. Not 100% tested for t<sub>CEZ</sub>, t<sub>OEZ</sub>.

Table 10.6	Synchronous	Wait State	Requirements
	Oynoniouo	wan oluio	ricquireriterite

Max Frequency	Wait State Requirement
Frequency $\leq$ 14 MHz	2
$14 < Frequency \le 27MHz$	3
27 MHz < Frequency $\leq$ 40 MHz	4
40 MHz < Frequency $\leq$ 54 MHz	5
54 MHz < Frequency ≤ 66 MHz	6
66 MHz < Frequency ≤ 80 MHz	7
80 MHz < Frequency ≤ 95 MHz	8
95 MHz < Frequency $\leq$ 108 MHz	9

Figure 10.7 8-Word Linear Synchronous Single Data Rate Burst with Wrap Around

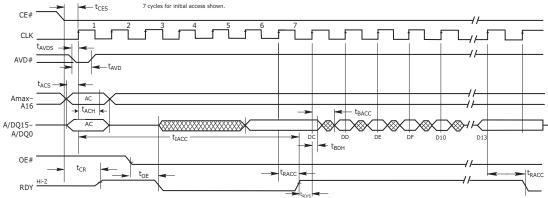


Notes

- 1. Figure shows for illustration the total number of wait states set to seven cycles.
- 2. The device is configured synchronous single data rate mode and RDY active with data.
- 3. CE# (High) drives the RDY to Hi-Z while OE# (High) drives the A/DQ15 A/DQ0 pins to Hi-Z



Figure 10.8 8-Word Linear Single Data Read Synchronous Burst without Wrap Around



#### Notes

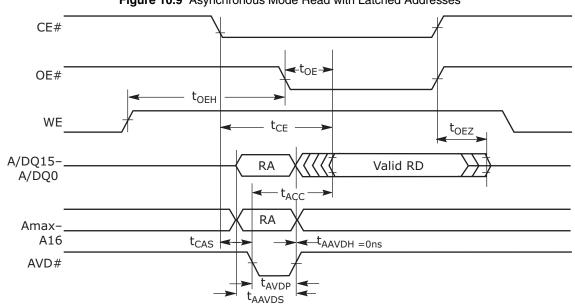
- 1. Figure shows for illustration the total number of wait states set to seven cycles.
- 2. The device is configured synchronous single data rate mode and RDY active with data.
- 3. CE# (High) drives the RDY to Hi-Z while OE# (High) drives the A/DQ15 A/DQ0 pins to HI-Z

### 10.8.2 Asynchronous Mode Read

#### Table 10.7 Asynchronous Mode Read

Para	ameter		escription		66 MHz	83 MHz	108 MHz	Unit
JEDEC	Standard		escription					Unit
	t <sub>CE</sub>	Access Time from CE# Low Typ			83			ns
	t <sub>ACC</sub>	Asynchronous Access Time Max				80		ns
	t <sub>AVDP</sub>	AVD# Low Time Mir			n 7.5			ns
	t <sub>AAVDS</sub>	Address Setup Time to Rising Edge of AVD#				ns		
	t <sub>AAVDH</sub>	Address Hold Time from Rising Edge of AVD#		Min	3.5			ns
	t <sub>OE</sub>	Output Enable to Output Valid		Max	9	9	9	ns
		Output Enable Hold Time	Read	Min		0		ns
T	t <sub>OEH</sub>		Toggle and Data# Polling	Min	10	10	10	ns
	t <sub>OEZ</sub>	Output Enable to High Z Ma		Max	10	10	10	ns
	t <sub>CAS</sub>	CE# Setup Time to AVD#		Min		0		ns





#### Figure 10.9 Asynchronous Mode Read with Latched Addresses



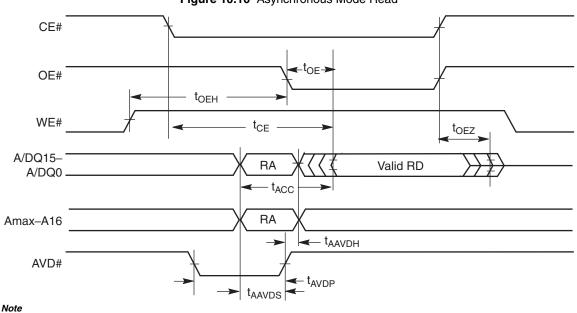


Figure 10.10 Asynchronous Mode Read

### 10.8.3 Hardware Reset (RESET#)

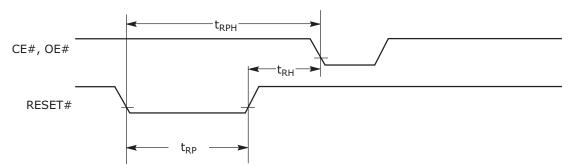
### Table 10.8 Warm Reset

Parameter		Description		All Speed Options	Unit
JEDEC	Std	Description			
	t <sub>RP</sub>	RESET# Pulse Width	Min	50	ns
	t <sub>RH</sub>	Reset High Time Before Read	Min	200	ns
	t <sub>RPH</sub>	RESET# Low to CE# Low	Min	10	μs

RA = Read Address, RD = Read Data.



### Figure 10.11 Reset Timings



# 10.8.4 Erase/Program Timing

Para	meter	Description			66	83	108	Unit
JEDEC	Standard	Description			MHz	MHz	MHz	Unit
t <sub>AVAV</sub>	t <sub>WC</sub>	Write Cycle Time (1)		Min		60		ns
		Address Setup Time (2)	Synchronous	Min		4		ns
t <sub>AVWL</sub>	t <sub>AS</sub>		Asynchronous	IVIIII		4		
+	+	Address Hold Time (2)	Synchronous	Min		3.5		ns
t <sub>WLAX</sub>	t <sub>AH</sub>		Asynchronous	IVIIII		3.5		
	t <sub>AVDP</sub>	AVD# Low Time		Min		6		ns
t <sub>DVWH</sub>	t <sub>DS</sub>	Data Setup Time		Min		20		ns
t <sub>WHDX</sub>	t <sub>DH</sub>	Data Hold Time		Min		0		ns
t <sub>GHWL</sub>	t <sub>GHWL</sub>	Read Recovery Time Before Write		Min		0		ns
	t <sub>CAS</sub>	CE# Setup Time to AVD#		Min		0		ns
t <sub>WHEH</sub>	t <sub>CH</sub>	CE# Hold Time		Min	0		ns	
t <sub>WLWH</sub>	t <sub>WP</sub>	Write Pulse Width		Min	25		ns	
t <sub>WHWL</sub>	t <sub>WPH</sub>	Write Pulse Width High		Min	20		ns	
	t <sub>SR/W</sub>	Latency Between Read and Write Operations		Min		0		ns
	t <sub>VID</sub>	V <sub>PP</sub> Rise and Fall Time		Min		500		ns
	t <sub>VIDS</sub>	V <sub>PP</sub> Setup Time (During Accelerated Program	nming)	Min		1		μs
t <sub>ELWL</sub>	t <sub>CS</sub>	CE# Setup Time to WE#		Min		4		ns
	t <sub>AVSW</sub>	AVD# Setup Time to WE#		Min		6		ns
	t <sub>AVHW</sub>	AVD# Hold Time to WE#		Min		4		ns
	t <sub>SEA</sub>	Sector Erase Accept Time out		Min		50		μs
	t <sub>ESL</sub>	Erase Suspend Latency		Min		20		μs
	t <sub>PSL</sub>	Program Suspend Latency		Min		20		μs
	t <sub>ASP</sub>	Toggle Time During Erase within a Protected Sector		Тур		280		μs
	t <sub>PSP</sub>	Toggle Time During Programming Within a Pr	rotected Sector	Тур		1		μs
	t <sub>ERS</sub>	Erase Resume to Erase Suspend		Min		30		μs
	t <sub>PRS</sub>	Program Resume to Program Suspend		Min		30		μs

### Table 10.9 Erase/Program Timing

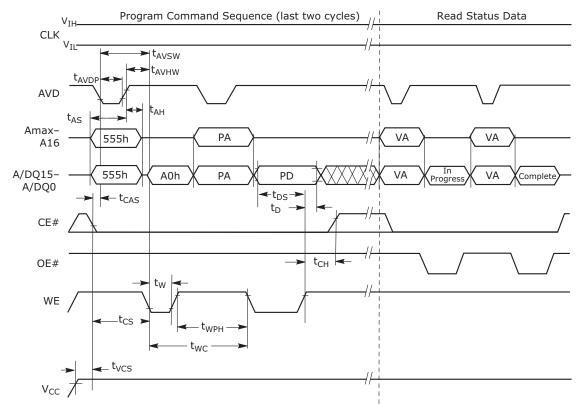
Notes

1. Not 100% tested.

2. In asynchronous operation timing, addresses are latched on the rising edge of AVD#.

3. See the Erase and Programming Performance section for more information. Does not include the preprogramming time.



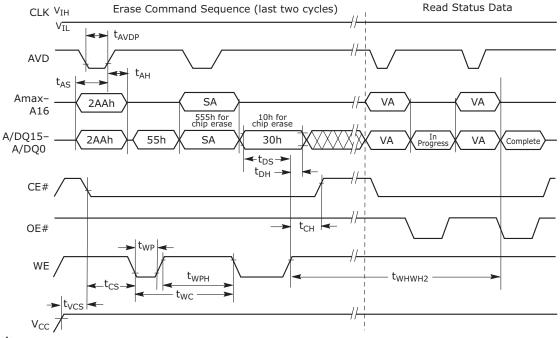


#### Figure 10.12 Asynchronous Program Operation Timings

#### Notes

- 1. PA = Program Address, PD = Program Data, VA = Valid Address for reading status bits.
- 2. In progress and complete refer to status of program operation.
- 3. CLK can be either V<sub>IL</sub> or V<sub>IH</sub>.

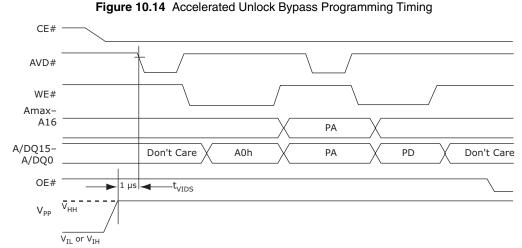






SA is the sector address for Sector Erase.





#### Note

Use setup and hold times from conventional program operation.

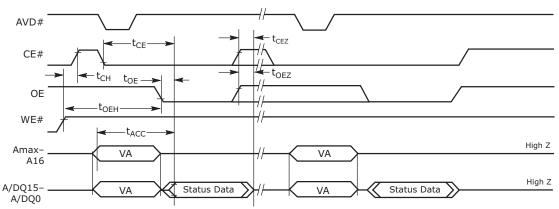


Figure 10.15 Data# Polling Timings (During Embedded Algorithm)

#### Notes

1. Status reads in figure are shown as asynchronous.

2. VA = Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, and Data# Polling outputs true data.

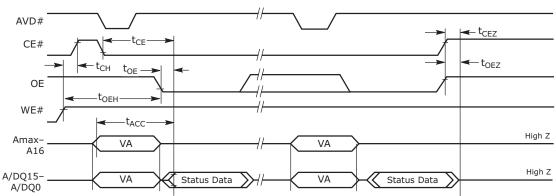


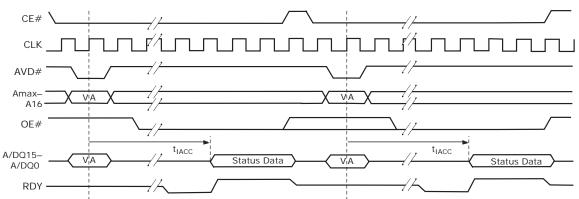
Figure 10.16 Toggle Bit Timings (During Embedded Algorithm)

#### Notes

- 1. Status reads in figure are shown as asynchronous.
- 2. VA = Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, the toggle bits stop toggling.







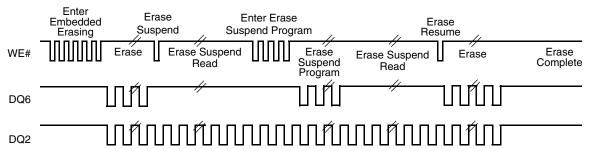
#### Notes

1. The timings are similar to synchronous read timings.

2. VA = Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, the toggle bits stop toggling.

3. RDY is active with data (D8 = 0 in the Configuration Register). When D8 = 1 in the Configuration Register, RDY is active one clock cycle before data.



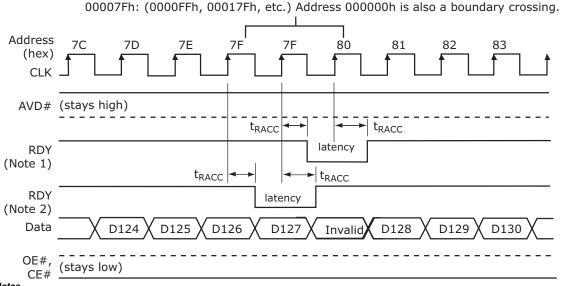


#### Note

DQ2 toggles only when read at an address within an erase-suspended sector. The system may use OE# or CE# to toggle DQ2 and DQ6.

### Figure 10.19 Latency with Boundary Crossing

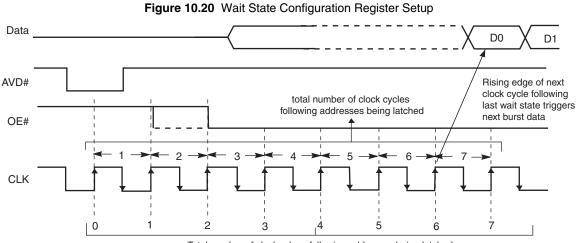
Address boundary occurs every 128 words, beginning at address



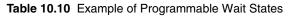
#### Notes

- 1. RDY active with data (CR0.8 = 0 in the Configuration Register).
- 2. RDY active one clock cycle before data (CR0.8 = 1 in the Configuration Register).
- 3. Figure shows the device not crossing a bank in the process of performing an erase or program.





Total number of clock edges following addresses being latched

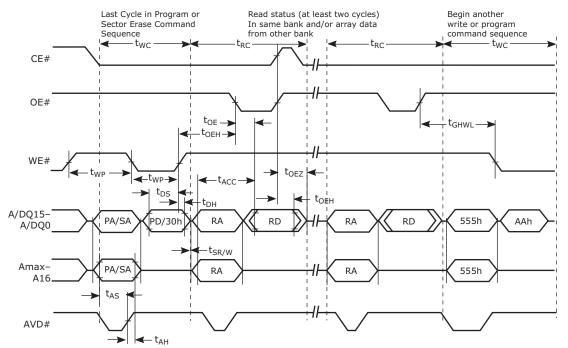


CR1.0	Programmable Wait State (See Note)	0000			2nd					
CR0.13		0001	1	initial data is	3rd	riaina				
CR0.12		0010	=	valid on the	4th	rising CLK edge	after addresses are latched			
		0011			5th					
		0100			6th					
		0101	1		7th					
		0110	=	Reserved						
		0111	=	neselveu						
		1000	=	initial data is valid on the	8th	rising	after addresses are			
CR0.11		1001	-		9th	CLK edge	latched			
		:								
		1101	=	initial data is valid on the	13th	rising CLK edge	AVD# transition to V <sub>IH</sub> (Default)			
		:								
			_		Reserved					
		1111	=							

Note

The addresses are latched by rising edge of CLK.





### Figure 10.21 Back-to-Back Read/Write Cycle Timings

#### Note

Breakpoints in waveforms indicate that system may alternately read array data from the non-busy bank while checking the status of the program or erase operation in the busy bank. The system should read status twice to ensure valid information.



## **10.9** Erase and Programming Performance

### Table 10.11 Erase and Programming Performance

Pa	rameter		Тур <mark>(1)</mark>	Max (2)	Unit	Comments
	64 Kword	V <sub>CC</sub>	0.8	3.5		
	16 Kword	V <sub>CC</sub>	0.15	2.0		Excludes 00h
Sector Erase Time	64 Kword	V <sub>PP</sub>	0.8	3.5		programming prior to erasure (3)
	16 Kword	V <sub>PP</sub>	0.15	2.0		
	64 Kword	V <sub>CC</sub>	0.90	5.00	s	
	16 Kword	V <sub>CC</sub>	0.45	1.85		Includes 00h
Sector Erase Time	64 Kword	V <sub>PP</sub>	0.70	3.75		programming prior to erasure (3)
	16 Kword	V <sub>PP</sub>	0.35	1.40		
	•		77 (NS128P)	154 (NS128P)		
Chip Erase Time		V <sub>CC</sub>	154 (NS256P)	308 (NS256P)	s	
			306 (NS512P)	612 (NS512P)		
Word Programming Ti			40	400		Excludes system level
word Frogramming T	me	V <sub>PP</sub>	24	240	μs	overhead (4)
Effective Word Program	mming Time	V <sub>CC</sub>	9.4	94		
utilizing Program Write	e Buffer	V <sub>PP</sub>	6	60		
Total 32-Word Buffer F	uffer Programming V <sub>C</sub>		300	3000	μs	
Time		V <sub>PP</sub>	192	1920		
			78.6 (NS128P)	157.3 (NS128P)		
		V <sub>CC</sub>	157.3 (NS256P)	314.6 (NS256P)		
Chip Programming Time (using 32			314.6 (NS512P)	629.2 (NS512P)		Excludes system level
word buffer)			51 (NS128P)	102 (NS128P)	s	overhead (4)
		V <sub>PP</sub>	101 (NS256P)	202 (NS256P)		
			202 (NS512P)	404 (NS512P)		
Erase Suspend/Erase	Resume	Min		20	μs	
Program Suspend/Pro	gram Resume	Min		20	μs	

#### Notes

1. Typical program and erase times assume the following conditions: 25°C, 1.8 V V<sub>CC</sub>, 10,000 cycles using checkerboard patterns.

2. Under worst case conditions of 90°C,  $V_{CC}$  = 1.70 V, 100,000 cycles.

3. In the pre-programming step of the Embedded Erase algorithm, all words are programmed to 00h before erasure.

4. System-level overhead is the time required to execute the two- or four-bus-cycle sequence for the program command. See Table 11.1, Memory Array Commands on page 78 and Table 11.2, Sector Protection Commands on page 80for further information on command definitions.



# 11. Appendix

This section contains information relating to software control or interfacing with the Flash device. For additional information and assistance regarding software, see www.spansion.com.

			Bus Cycles (1, 2, 3, 4, 5, 6)											
Command Sequence		Cycles	First		Sec	ond	Th	ird	Fourth		Fifth		Siz	xth
(Notes)			Addr	Data (19)	Addr	Data (19)	Addr	Data (19)	Addr	Data (19)	Addr	Data (19)	Addr	Data (19)
Asynchronous F	Read (7)	1	RA	RD										
Reset (8)		1	XXX	F0										
	Manufacturer ID	4	555	AA	2AA	55	(BA) 555	90	(BA) X00	0001				
	Device ID (10)	6	555	AA	2AA	55	(BA) 555	90	(BA) X01	3x7E	(BA)X 0E	(10)	(BA) X0F	(10)
Autoselect (9)	Indicator Bits	4	555	AA	2AA	55	(BA) 555	90	(BA) X07	(12)				
	Sector Unlock/Lock Verify (11)	4	555	AA	2AA	55	(SA) 555	90	(SA) X02	0000/ 0001				
	Revision ID	4	555	AA	2AA	55	(BA) 555	90	(BA) X03					
Single Word Pro	gram	4	555	AA	2AA	55	555	A0	PA	Data				
Write to Buffer (17)		6	555	AA	2AA	55	SA	25	SA	WC	PA	PD	WBL	PD
Write Buffer to F	lash	1	SA	29										
Write to Buffer A	bort Reset (10)	3	555	AA	2AA	55	555	F0						
Chip Erase		6	555	AA	2AA	55	555	80	555	AA	2AA	55	555	10
Sector Erase		6	555	AA	2AA	55	555	80	555	AA	2AA	55	SA	30
Program/Erase	Suspend (15)	1	BA	B0										
Program/Erase	Resume (16)	1	BA	30										
Set Configuration	n Register (21, 22, 24)	5	555	AA	2AA	55	555	D0	X00	CR0	X01	CR1		
Read Configura	tion Register	4	555	AA	2AA	55	555	C6	X0 (0 or 1)	CR (0 or 1)				
CFI Query (17)		1	(BA) 55	98										
	Unlock Bypass Entry (18)	3	555	AA	2AA	55	555	20						
Unlock Bypass	Unlock Bypass Program (13), (14)	2	хх	A0	PA	PD								
	Unlock Bypass Sector Erase (13), (14)	2	хх	80	SA	30								
Mode (23)	Unlock Bypass Erase (13), (14)	2	хх	80	ххх	10								
	Unlock Bypass CFI (13), (14)	1	хх	98										
	Unlock Bypass Reset	2	XX	90	XXX	00								

### Table 11.1 Memory Array Commands

Legend

X = Don't care.

RA = Read Address.

RD = Read Data.

PA = Program Address. Addresses latch on the rising edge of the AVD# pulse or active edge of CLK, whichever occurs first.

PD = Program Data. Data latches on the rising edge of WE# or CE# pulse, whichever occurs first.

SA = Sector Address. NS128P = A22 - A14; NS256P = A23 - A14.



*BA* = Bank Address. *NS128P* = *A22* – *A20*, and *A19*; *NS064P* = *A21*, *A20* – *A18*; *NS256P* = *A23* – *A20*.*CR* = Configuration Register data bits *D15* – *D0*.

WBL = Write Buffer Location. Address must be within the same write buffer page as PA.

WC = Word Count. Number of write buffer locations to load minus 1.

#### Notes

- 1. See Table 6.1 for description of bus operations.
- 2. All values are in hexadecimal.
- 3. Except for the following, all bus cycles are write cycle: read cycle, fourth through sixth cycles of the Autoselect commands, fourth cycle of the configuration register verify and password verify commands, and any cycle reading at RD(0) and RD(1).
- 4. Data bits DQ15 DQ8 are don't care in command sequences, except for RD, PD, WD, PWD, and PWD3 PWD0.
- 5. Unless otherwise noted, address bits Amax A14 are don't cares.
- 6. Writing incorrect address and data values or writing them in the improper sequence may place the device in an unknown state. The system must write the reset command to return the device to reading array data.
- 7. No unlock or command cycles required when bank is reading array data.
- 8. The Reset command is required to return to reading array data (or to the erase-suspend-read mode if previously in Erase Suspend) when a bank is in the autoselect mode, or if DQ5 goes high (while the bank is providing status information) or performing sector lock/unlock.
- 9. The fourth cycle of the autoselect address is a read cycle. The system must provide the bank address.
- 10. (BA) + 0Eh ----> For NS128 = 43h, NS256 = 41h, NS512 = 3Fh (BA) + 0Fh ----> For NS128/256/512 = 00h
- 11. The data is 0000h for an unlocked sector and 0001h for a locked sector
- 12. See Table 6.12, Autoselect Addresses on page 34.
- 13. The Unlock Bypass command sequence is required prior to this command sequence.
- 14. The Unlock Bypass Reset command is required to return to reading array data when the bank is in the unlock bypass mode.
- 15. The system may read and program in non-erasing sectors, or enter the autoselect mode, when in the Erase Suspend mode. The Program/Erase Suspend command is valid only during a program/ erase operation, and requires the bank address.
- 16. The Program/Erase Resume command is valid only during the Program/Erase Suspend mode, and requires the bank address.
- 17. The total number of cycles in the command sequence is determined by the number of words written to the write buffer. The maximum number of cycles in the command sequence is 37.
- 18. Write Buffer Programming can be initiated after Unlock Bypass Entry.
- 19. Data is always output at the rising edge of clock.
- 20. Do not enter wrong address or data cycles.
- 21. Do not use 0x30 for CR data (otherwise in the erase suspend --> CR read or set sequence, the device will go into erase resume instead of CR read or set).
- 22. Software reset is needed after CR read (otherwise the device is still in CR read mode).
- 23. When device is in Unlock Bypass mode, do not enter another command before Unlock Bypass reset command is issued).
- 24. Configuration Registers can not be programmed out of order. CR0 must be programmed prior to CR01 otherwise the configuration registers retain their previous settings.



						Sector P					5.6							
	Command Sequence (Notes)		Command Sequence		First		Se	Bus Cycles 1, 2, 3, 4, 5, 6           Second         Third         Fourth         Fifth         Sixth         S									Sev	Seventh
			Addr	Data (10)	Addr	Data (10)	Addr	Data (10)	Addr	Data (10)	Addr	Data (10)	Addr	Data (10)	Addr	Data (10)		
	Entry (5)	3	555	AA	2AA	55	555	88		. ,		. ,		. ,		. ,		
Secured Silicon	Program	4	555	AA	2AA	55	555	A0	PA	PD								
Silic	Read	1	00	data														
0,	Exit (7)	4	555	AA	2AA	55	555	90	XX	00								
L.	Register Command Set Entry (5)	3	555	AA	2AA	55	555	40										
Lock Register	Register Bits Program (6)	2	XX	A0	00	data												
L L	Register Bits Read	1	00	data														
	Register Command Set Exit (7)	2	XX	90	XX	00												
	Protection Command Set Entry	3	555	AA	2AA	55	555	60										
ord	Program (9)	2	xx	A0	00/ 01/ 02/03	PWD0/ 1/ 2/3/												
Password	Read Password (10)	4	00	PWD 0	01	PWD1	02	PWD 2	03	PWD 3								
	Unlock (9)	7	00	25	00	03	00	PWD 0	01	PWD 1	02	PWD 2	03	PWD 3	00	29		
	Protection Command Set Exit	2	XX	90	XX	00												
	Non-Volatile Sector Protection Command Set Entry (5)	3	555	AA	2AA	55	(BA) 555	C0										
	Program	2	хх	A0	(BA) SA	00												
РРВ	All Erase (8)	2	XX	80	SA0	30												
	Status Read	1	(BA) SA	RD(0)														
	Non-Volatile Sector Protection Command Set Exit (7)	2	хх	90	хх	00												
Bit	Global Volatile Sector Protection Freeze Command Set Entry (5)	3	555	AA	2AA	55	555	50										
PPB Lock Bit	Set	2	XX	A0	XX	00												
B L	Status Read	1	XX	RD(0)														
ł	Global Volatile Sector Protection Freeze Command Set Exit (7)	2	xx	90	xx	00												
	Volatile Sector Protection Command Set Entry (5)	3	555	AA	2AA	55	(BA) 555	E0										
	Set	2	хх	A0	(BA) SA	00												
DYB	Clear	2	xx	A0	(BA) SA	01												
	Status Read	1	(BA) SA	RD(0)														
	Volatile Sector Protection Command Set Exit (7)	2	xx	90	xx	00												
	Program	2	555	A0	PA	Data												
ated	Sector Erase	2	555	80	SA	30												
Accelerated	Asynchronous Read	1	RA	RD														
Acc	Write to Buffer	4	SA	25	SA	WC	PA	PD	WBL	PD						<u> </u>		
	Program Buffer to Flash	1	SA	29														

### Table 11.2 Sector Protection Commands

Legend

X = Don't care



- RA = Read Address.
- RD = Read Data.
- PA = Program Address. Addresses latch on the rising edge of the AVD# pulse or active edge of CLK, whichever occurs first.
- PD = Program Data. Data latches on the rising edge of WE# or CE# pulse, whichever occurs first.
- SA = Sector Address. NS128P = A22 A14, NS256P = A23 A14.
- BA = Bank Address. NS128P = A22 A20, and A19; NS256P = A23 A20.
- CR = Configuration Register data bits D15 D0.
- PWD3 PWD0 = Password Data. PD3 PD0 present four 16 bit combinations that represent the 64-bit Password
- PWA = Password Address. Address bits A1 and A0 are used to select each 16-bit portion of the 64-bit entity.
- PWD = Password Data.
- RD(0) = DQ0 protection indicator bit. If protected, DQ0 = 0, if unprotected, DQ0 = 1.
- WBL = Write Buffer Location. Address must be within the same write buffer page as PA.
- WC = Word Count. Number of write buffer locations to load minus 1.

#### Notes

- 1. See Table 6.1 for description of bus operations.
- 2. All values are in hexadecimal.
- 3. Except for the following, all bus cycles are write cycle: read cycle, fourth through sixth cycles of the Autoselect commands, fourth cycle of the configuration register verify and password verify commands, and any cycle reading at RD(0) and RD(1).
- 4. Data bits DQ15 DQ8 are don't care in command sequences, except for RD, PD, WD, PWD, and PWD3 PWD0.
- 5. Unless otherwise noted, address bits Amax A14 are don't cares.
- 6. Writing incorrect address and data values or writing them in the improper sequence may place the device in an unknown state. The system must write the reset command to return the device to reading array data.
- 7. No unlock or command cycles required when bank is reading array data.
- 8. The data is 0000h for an unlocked sector and 0001h for a locked sector.
- 9. The Exit command must be issued to reset the device into read mode, otherwise the device hangs.

10. Data is always output at the rising edge of clock.

### 11.1 Common Flash Memory Interface

The Common Flash Interface (CFI) specification outlines device and host system software interrogation handshake, which allows specific vendor-specified soft-ware algorithms to be used for entire families of devices. Software support can then be device-independent, JEDEC ID-independent, and forward-compatible and backward-compatible for the specified flash device families. Flash vendors can standardize their existing interfaces for long-term compatibility.

This device enters the CFI Query mode when the system writes the CFI Query command, 98h, to address (BA)55h any time the device is ready to read array data. The system can read CFI information at the addresses given in Tables 11.3 - 11.6) within that bank. All reads outside of the CFI address range, within the bank, returns non-valid data. Reads from other banks are allowed, writes are not. To terminate reading CFI data, the system must write the reset command.

The following is a C source code example of using the CFI Entry and Exit functions. Refer to the *Spansion Low Level Driver User's Guide* (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: CFI Entry command */
 *( (UINT16 *)bank_addr + 0x0055 = 0x0098; /* write CFI entry command */
/* Example: CFI Exit command */
 *( (UINT16 *)bank_addr + 0x000 ) = 0x00F0; /* write cfi exit command */
```

For further information, please refer to the CFI Specification (see JEDEC publications JEP137-A and JESD68.01and CFI Publication 100). Please contact your sales office for copies of these documents.



Addresses	Data	Description
10h 11h 12h	0051h 0052h 0059h	Query Unique ASCII string <i>QRY</i>
13h 14h	0002h 0000h	Primary OEM Command Set
15h 16h	0040h 0000h	Address for Primary Extended Table
17h 18h	0000h 0000h	Alternate OEM Command Set (00h = none exists)
19h 1Ah	0000h 0000h	Address for Alternate OEM Extended Table (00h = none exists)

### Table 11.3 CFI Query Identification String

### Table 11.4 System Interface String

Addresses	Data	Description
1Bh	0017h	V <sub>CC</sub> Min. (write/erase) D7 – D4: volt, D3 – D0: 100 millivolt
1Ch	0019h	V <sub>CC</sub> Max. (write/erase) D7 – D4: volt, D3 – D0: 100 millivolt
1Dh	0000h	V <sub>PP</sub> Min. voltage (00h = no V <sub>PP</sub> pin present)
1Eh	0000h	V <sub>PP</sub> Max. voltage (00h = no V <sub>PP</sub> pin present)
1Fh	0005h	Typical Program Time per single word write $2^N \mu s$ (for example, 30 $\mu s$ )
20h	0009h	Typical Program Time using buffer $2^{N} \mu s$ (for example, 300us) (00h = not supported)
21h	000Ah	Typical time for sector erase 2 <sup>N</sup> ms
22h	0000h	Typical time for full chip erase 2 <sup>N</sup> ms (00h = not supported)
23h	0003h	Max. Program Time per single word [2 <sup>N</sup> times typical value]
24h	0002h	Max. Program Time using buffer [2 <sup>N</sup> times typical value]
25h	0002h	Max. time for sector erase [2 <sup>N</sup> times typical value]
26h	0000h	Max. time for full chip erase [2 <sup>N</sup> times typical value] (00h = not supported)

### Table 11.5 Device Geometry Definition (Sheet 1 of 2)

Addresses	Data	Description
27h	0018h (NS128P) 0019h (NS256P) 001Ah (NS512P)	Device Size = 2 <sup>N</sup> byte
28h 29h	0001h 0000h	Flash Device Interface 0h=x8; 1h=x16; 2h=x8/x16; 3h=x32 [lower byte] [upper byte] (00h = not supported)
2Ah 2Bh	0006h 0000h	Max. number of bytes in multi-byte buffer write = 2 <sup>N</sup> [lower byte] [upper byte] (00h = not supported)
2Ch	0002h (NS128P) 0002h (NS256P) 0001h (NS512P)	Number of Erase Block Regions within device 01h = Uniform Sector; 02h = Boot + Uniform; 03h = Boot + Uniform + Boot
2Dh	007Eh (NS128P) 00FEh (NS256P) 01FFh (NS512P)	Erase Block Region 1 Information (Large Sector Section) [lower byte] – Number of sectors. 00h=1 sector; 01h=2 sectors 03h=4 sectors
2Eh	0000h	[upper byte]
2Fh	0000h	[lower byte] – Equation =>(n = Density in Bytes of any 1 sector/256)h [upper byte]
30h	0002h	
31h	0003h (NS128P) 0003h (NS256P) 0000h (NS512P)	Erase Block Region 2 Information (Small Sector Section)
32h	0000h	
33h	0080h (NS128P) 0080h (NS256P) 0000h (NS512P)	[upper byte] [lower byte] – Equation =>(n = Density in Bytes of any 1 sector/256)h
34h	0000h	[upper byte]



Addresses	Data	Description
35h 36h 37h 38h	0000h 0000h 0000h 0000h	Erase Block Region 3 Information [lower byte] – Number of sectors. 00h=1 sector; 01h=2 sectors 03h=4 sectors [upper byte] [lower byte] – Equation =>(n = Density in Bytes of any 1 sector/256)h [upper byte]
39h 3Ah 3Bh 3Ch	0000h 0000h 0000h 0000h	Erase Block Region 4 Information

### Table 11.5 Device Geometry Definition (Sheet 2 of 2)

### Table 11.6 Primary Vendor-Specific Extended Query (Sheet 1 of 2)

Addresses	Data	Description
40h 41h 42h	0050h 0052h 0049h	Query-unique ASCII string <i>PRI</i>
43h	0031h	Major CFI version number, ASCII
44h	0034h	Minor CFI version number, ASCII
45h	0014h	Address Sensitive Unlock (Bits $1 - 0$ ) 00b = Required, $01b = Not RequiredSilicon Technology (Bits 5 - 2) 0011b = 130 nm; 0100b = 110 nm; 0101b = 90 nm001010b = 000Ah$
46h	0002h	Erase Suspend 0 = Not Supported, 1 = To Read Only, 2 = To Read & Write
47h	0001h	Sector Protection per Group 0 = Not Supported, X = Number of sectors in per group
48h	0000h	Sector Temporary Unprotect 00 = Not Supported, 01 = Supported
49h	0008h	Sector Protect/Unprotect scheme 08h = Advanced Sector Protection; 07h = New Sector Protection Scheme
4Ah	0078h (NS128P) 00F0h (NS256P) 01E0h (NS512P)	Simultaneous Operation Number of Sectors in all banks except bank0
4Bh	0001h	Burst Mode Type 00 = Not Supported, 01 = Supported
4Ch	0000h	Not supported
4Dh	0085h	V <sub>PP</sub> (Acceleration) Supply Minimum 00h = Not Supported, D7 – D4: Volt, D3 – D0: 100 mV
4Eh	0095h	V <sub>PP</sub> (Acceleration) Supply Maximum 00h = Not Supported, D7 – D4: Volt, D3 – D0: 100 mV
4Fh	0003h (NS128P) 0003h (NS256P) 0005h (NS512P)	Write Protect Function 00h = No Boot, 01h = Dual Boot, 02h = Bottom Boot, 03h = Top Boot, 04h = Uniform Bottom, 05h = Uniform Top, 06h = All Sectors
50h	0001h	Program Suspend. 00h = not supported
51h	0001h	Unlock Bypass 00 = Not Supported, 01=Supported
52h	0008h	Secured Silicon Sector (Customer OTP Area) Size 2 <sup>N</sup> bytes
53h	0014h	Hardware Reset Low Time-out during an embedded algorithm to read mode Maximum $2^N$ ns (for example, 10 $\mu s$ => n=14)
54h	0014h	Hardware Reset Low Time-out not during an embedded algorithm to read mode Maximum $2^N$ ns (for example, 10 µs => n=14)
55h	0005h	Erase Suspend Time-out Maximum $2^N  \mu s$
56h	0005h	Program Suspend Time-out Maximum $2^N  \mu s$
57h	0010h	Bank Organization: X = Number of banks
58h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 0 Region Information. X = Number of sectors in bank



Addresses	Data	Description
59h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 1 Region Information. X = Number of sectors in bank
5Ah	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 2 Region Information. X = Number of sectors in bank
5Bh	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 3 Region Information. X = Number of sectors in bank
5Ch	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 4 Region Information. X = Number of sectors in bank
5Dh	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 5 Region Information. X = Number of sectors in bank
5Eh	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 6 Region Information. X = Number of sectors in bank
5Fh	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 7 Region Information. X = Number of sectors in bank
60h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 8 Region Information. X = Number of sectors in bank
61h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 9 Region Information. X = Number of sectors in bank
62h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 10 Region Information. X = Number of sectors in bank
63h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 11 Region Information. X = Number of sectors in bank
64h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 12 Region Information. X = Number of sectors in bank
65h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 13 Region Information. X = Number of sectors in bank
66h	0008h (NS128P) 0010h (NS256P) 0020h (NS512P)	Bank 14 Region Information. X = Number of sectors in bank
67h	000Bh (NS128P) 0013h (NS256P) 0020h (NS512P)	Bank 15 Region Information. X = Number of sectors in bank

### Table 11.6 Primary Vendor-Specific Extended Query (Sheet 2 of 2)



# 12. Revision History

Section	Description
Revision A (June 29, 2006)	
	Initial release
Revision A1 (February 20, 2007)	
	The tAVDS specification is changed from 4 ns to 5 ns
	The wait state for 83 MHz is changed to 8
	ICC3(Max) is changed to 70 $\mu A$ and ICC6(Max) is changed to 40 $\mu A$
	VIL (Min) is changed to -0.2 V
	tOE (Max) in both Asynchronous & Synchronous modes is changed to 9 ns across all frequencies
	tCEZ (Max) is changed to 10 ns across all frequencies
Global	tOEZ (Max) in both Asynchronous & Synchronous modes is changed to 10 ns across all frequencies
	tACH(Min) is changed to 6 ns (66 MHz) and 5 ns (83 MHz and 108 MHz)
	tRDY(Max) is changed to 10 ns
	tRACC(Max) is changed to 7.6 ns for 108 MHz
	tOEH(Min) in Asynchronous mode is changed to 10 ns for 108 MHz
	Erase and Programing Performance table is updated
	tCE in Asynchronous mode is changed to 83ns



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